Lista de Hojas de características:

QUADRUPLE 2-INPUT POSITIVE-NAND GATES

SDLS025 – DECEMBER 1983 – REVISED MARCH 1988

- **Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs**
- **Dependable Texas Instruments Quality and Reliability**

description

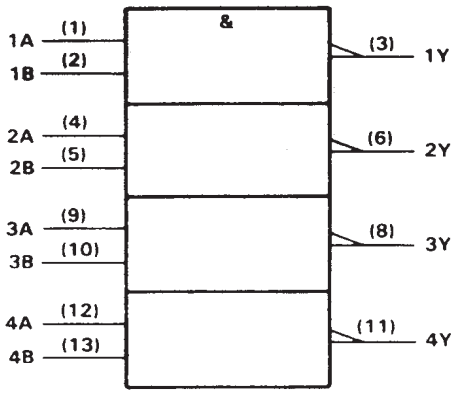
These devices contain four independent 2-input-NAND gates.

The SN5400, SN54LS00, and SN54S00 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN7400, SN74LS00, and SN74S00 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

INPUTS		OUTPUT
A	B	Y
H	H	L
L	X	H
X	L	H

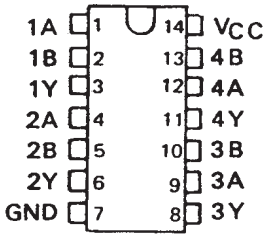
logic symbol†



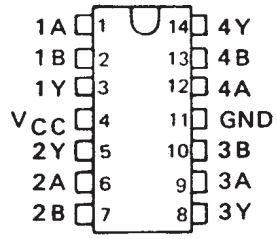
†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, and N packages.

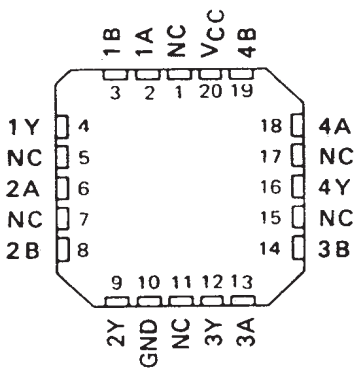
SN5400 . . . J PACKAGE
SN54LS00, SN54S00 . . . J OR W PACKAGE
SN7400 . . . N PACKAGE
SN74LS00, SN74S00 . . . D OR N PACKAGE
(TOP VIEW)



SN5400 . . . W PACKAGE
(TOP VIEW)

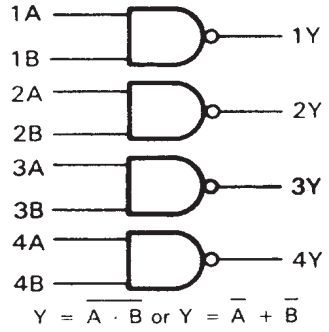


SN54LS00, SN54S00 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

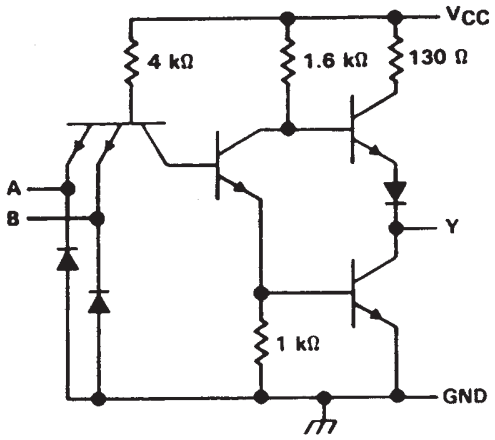
logic diagram (positive logic)



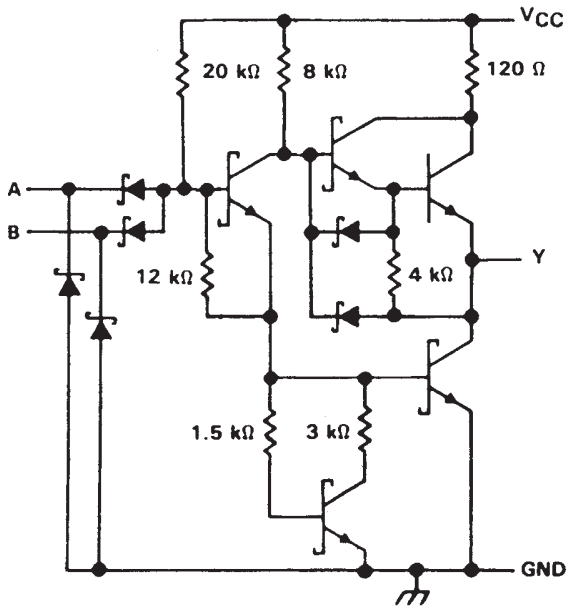
$Y = \overline{A \cdot B}$ or $Y = \overline{A} + \overline{B}$

schematics (each gate)

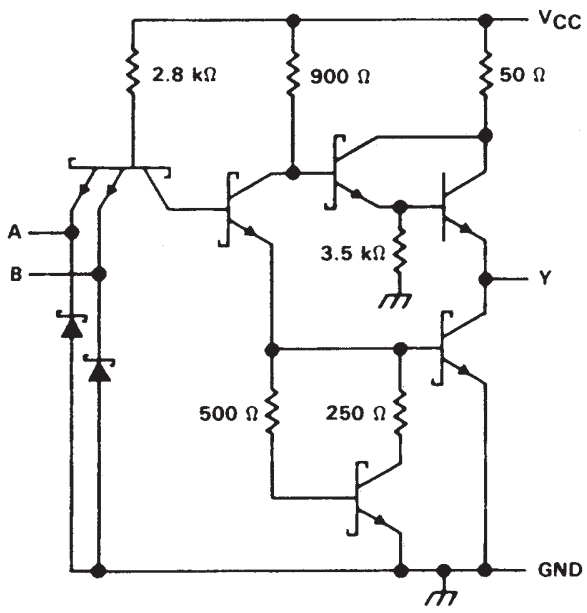
'00



'LS00



'S00



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)		7 V
Input voltage:	'00, 'S00	5.5 V
	'LS00	7 V
Operating free-air temperature range:	SN54'	−55°C to 125°C
	SN74'	0°C to 70°C
Storage temperature range		−65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5400			SN7400			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			– 0.4			– 0.4	mA
I_{OL}	Low-level output current			16			16	mA
T_A	Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN5400			SN7400			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = – 12 mA			– 1.5			– 1.5	V
V_{OH}	V_{CC} = MIN, V_{IL} = 0.8 V, I_{OH} = – 0.4 mA	2.4	3.4		2.4	3.4		V
V_{OL}	V_{CC} = MIN, V_{IH} = 2 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
I_{IL}	V_{CC} = MAX, V_I = 0.4 V			– 1.6			– 1.6	mA
I_{OS}§	V_{CC} = MAX	– 20		– 55	– 18		– 55	mA
I_{CCH}	V_{CC} = MAX, V_I = 0 V		4	8		4	8	mA
I_{CCL}	V_{CC} = MAX, V_I = 4.5 V		12	22		12	22	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 400 Ω, C_L = 15 pF		11	22	ns
t_{PHL}					7	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

	SN54LS00			SN74LS00			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH} High-level input voltage	2			2			V
V_{IL} Low-level input voltage			0.7			0.8	V
I_{OH} High-level output current			– 0.4			– 0.4	mA
I_{OL} Low-level output current			4			8	mA
T_A Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN54LS00			SN74LS00			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = – 18 mA			– 1.5			– 1.5	V
V_{OH}	V_{CC} = MIN, V_{IL} = MAX, I_{OH} = – 0.4 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN, V_{IH} = 2 V, I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
	V_{CC} = MIN, V_{IH} = 2 V, I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = MAX, V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.7 V			20			20	μA
I_{IL}	V_{CC} = MAX, V_I = 0.4 V			– 0.4			– 0.4	mA
I_{OS}§	V_{CC} = MAX	– 20		– 100	– 20		– 100	mA
I_{CCH}	V_{CC} = MAX, V_I = 0 V		0.8	1.6		0.8	1.6	mA
I_{CCL}	V_{CC} = MAX, V_I = 4.5 V		2.4	4.4		2.4	4.4	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 2 kΩ, C_L = 15 pF		9	15	ns
t_{PHL}					10	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

	SN54S00			SN74S00			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH} High-level input voltage	2			2			V
V_{IL} Low-level input voltage			0.8			0.8	V
I_{OH} High-level output current			−1			−1	mA
I_{OL} Low-level output current			20			20	mA
T_A Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN54S00			SN74S00			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = −18 mA			−1.2			−1.2	V
V_{OH}	V_{CC} = MIN, V_{IL} = 0.8 V, I_{OH} = −1 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN, V_{IH} = 2 V, I_{OL} = 20 mA			0.5			0.5	V
I_I	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.7 V			50			50	μA
I_{IL}	V_{CC} = MAX, V_I = 0.5 V			−2			−2	mA
I_{OS}§	V_{CC} = MAX	−40		−100	−40		−100	mA
I_{CCH}	V_{CC} = MAX, V_I = 0 V		10	16		10	16	mA
I_{CCL}	V_{CC} = MAX, V_I = 4.5 V		20	36		20	36	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 280 Ω, C_L = 15 pF		3	4.5	ns
t_{PHL}					3	5	ns
t_{PLH}			R_L = 280 Ω, C_L = 50 pF		4.5		ns
t_{PHL}					5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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FAIRCHILD SEMICONDUCTOR™

August 1986
Revised March 2000

DM74LS04
Hex Inverting Gates

General Description

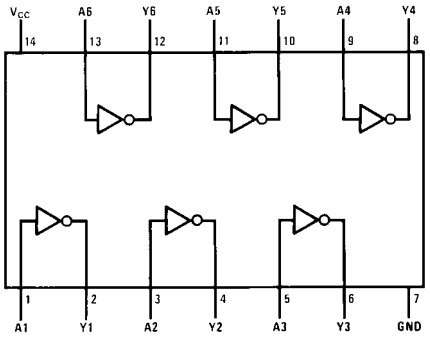
This device contains six independent gates each of which performs the logic INVERT function.

Ordering Code:

Order Number	Package Number	Package Description
DM74LS04M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
DM74LS04SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74LS04N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table

$Y = \overline{A}$

Input	Output
A	Y
L	H
H	L

H = HIGH Logic Level
L = LOW Logic Level

Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.4	mA
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max, V_{IL} = Max	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IH} = Min		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.36	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−20		−100	mA
I_{CCH}	Supply Current with Outputs HIGH	V_{CC} = Max		1.2	2.4	mA
I_{CCL}	Supply Current with Outputs LOW	V_{CC} = Max		3.6	6.6	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

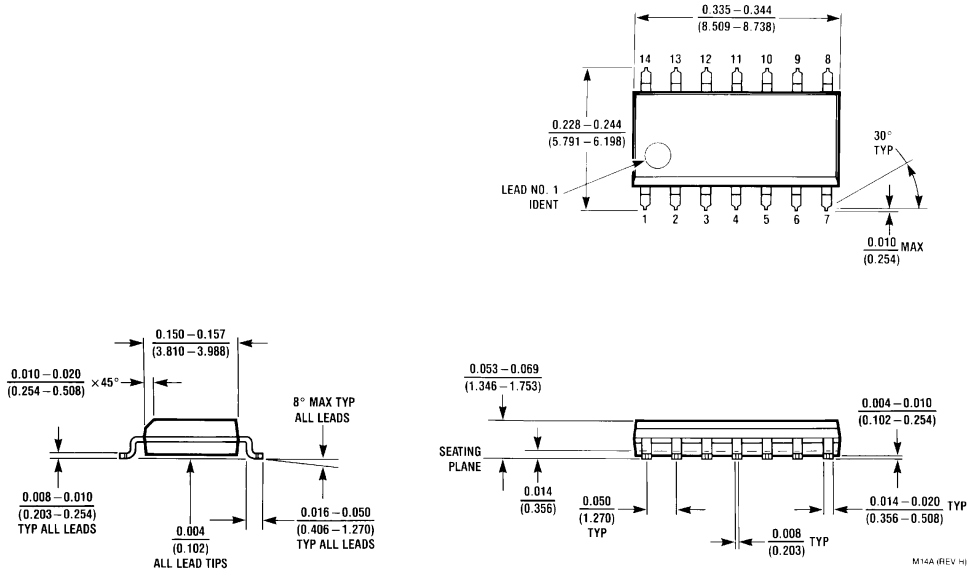
Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

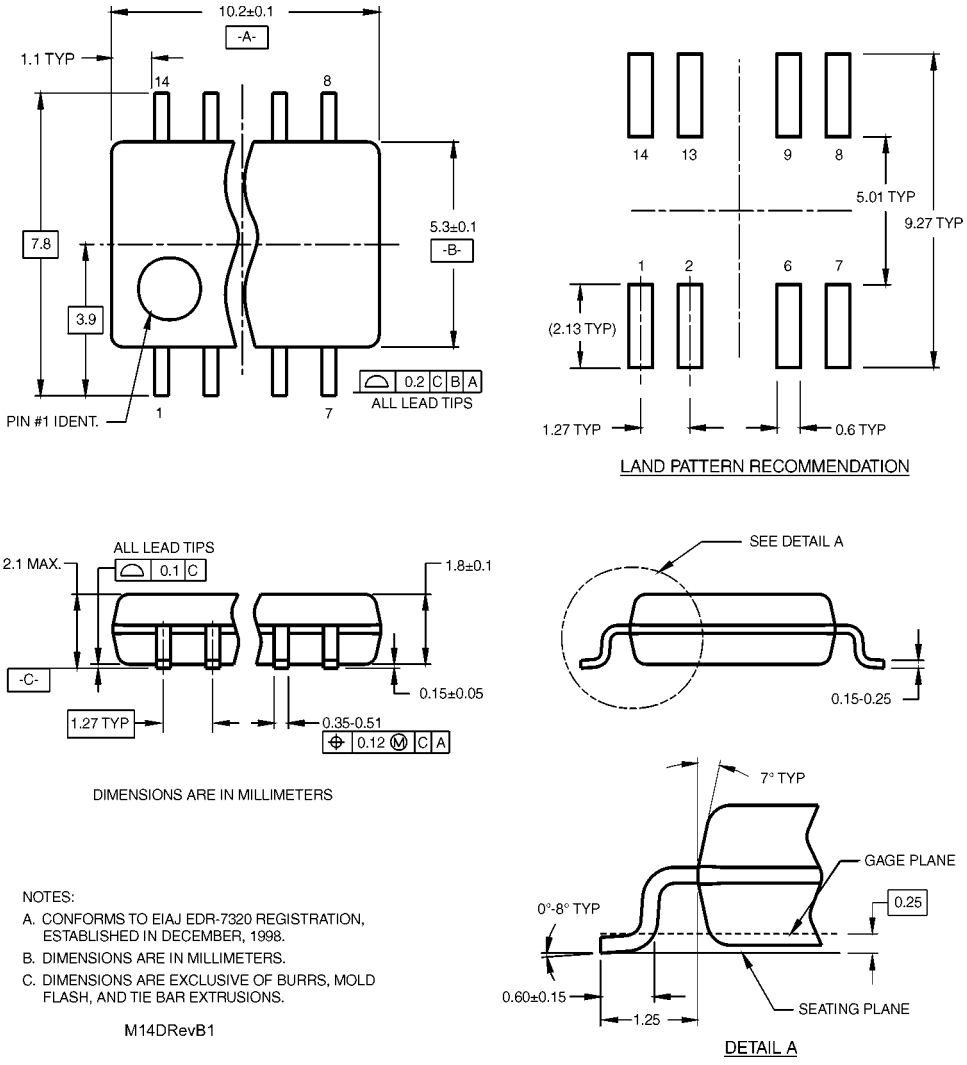
Symbol	Parameter	R_L = 2 kΩ				Units
		C_L = 15 pF		C_L = 50 pF		
		Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	3	10	4	15	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	3	10	4	15	ns

Physical Dimensions inches (millimeters) unless otherwise noted



14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



NOTES:

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.

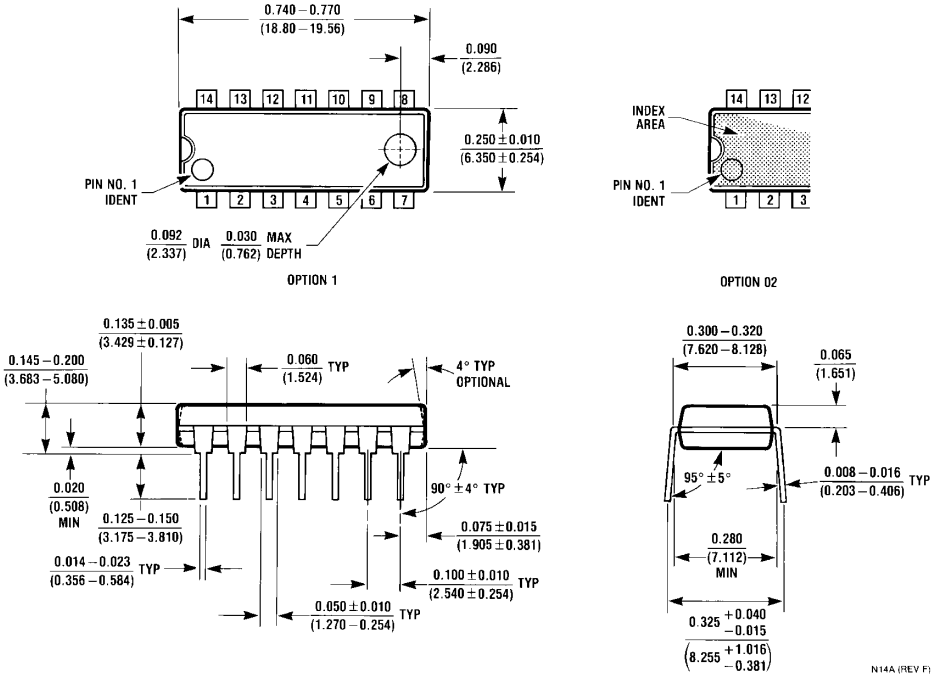
B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DRevB1

14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

- **Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs**
- **Dependable Texas Instruments Quality and Reliability**

description

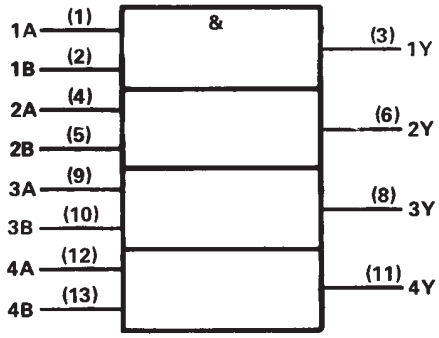
These devices contain four independent 2-input AND gates.

The SN5408, SN54LS08, and SN54S08 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN7408, SN74LS08 and SN74S08 are characterized for operation from 0° to 70°C.

FUNCTION TABLE (each gate)

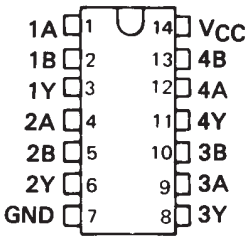
INPUTS		OUTPUT
A	B	Y
H	H	H
L	X	L
X	L	L

logic symbol†

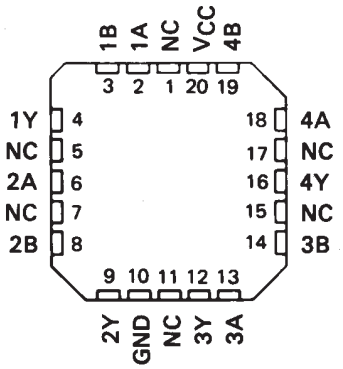


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

SN5408, SN54LS08, SN54S08 . . . J OR W PACKAGE
SN7408 . . . J OR N PACKAGE
SN74LS08, SN74S08 . . . D, J OR N PACKAGE
(TOP VIEW)

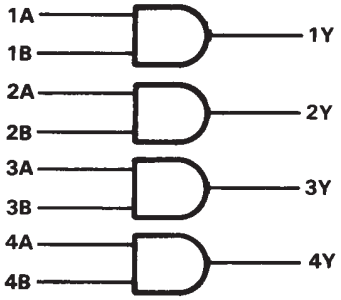


SN54LS08, SN54S08 . . . FK PACKAGE
(TOP VIEW)



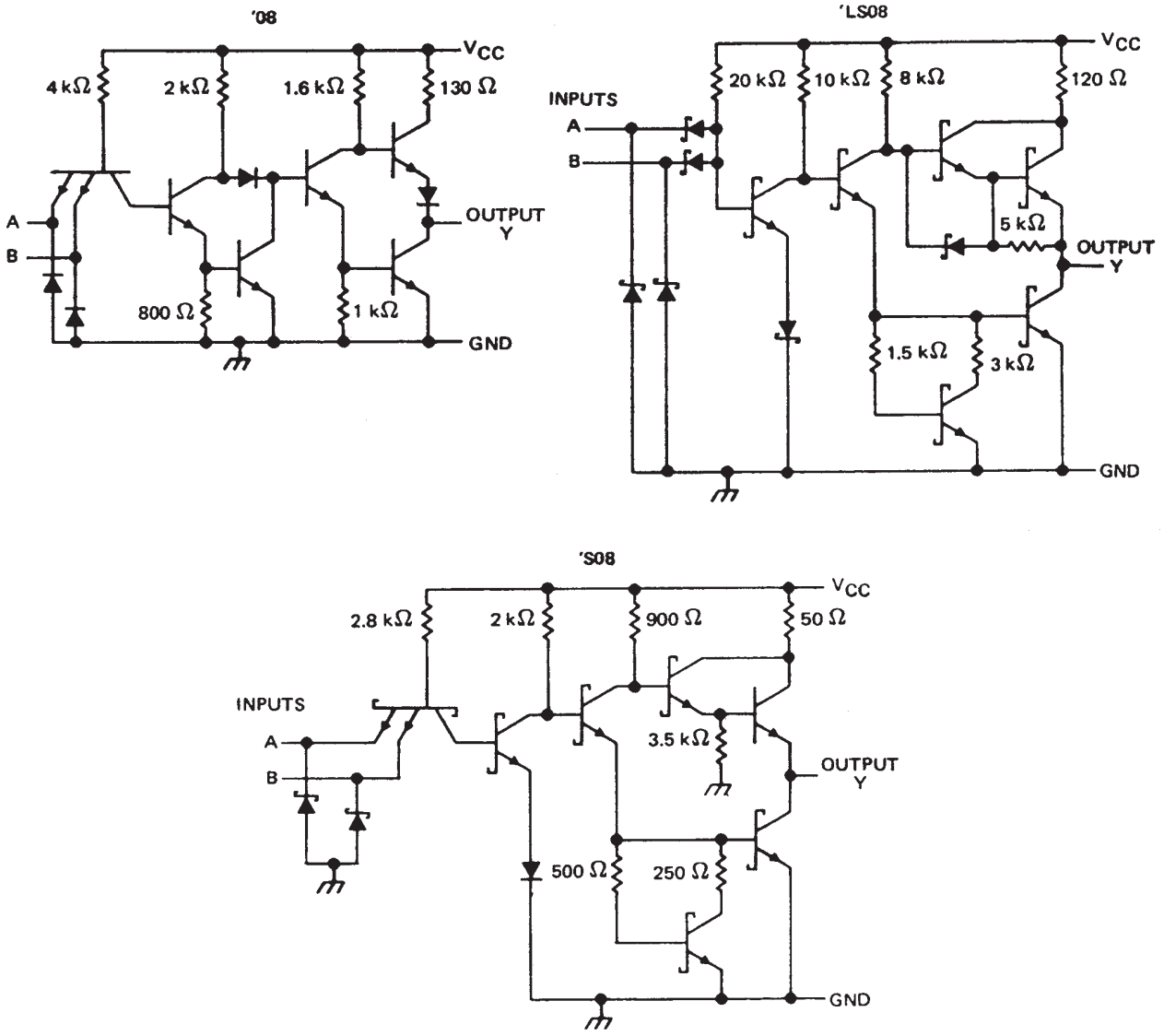
NC—No internal connection

logic diagram (positive logic)



$Y = A \cdot B$ or $Y = \overline{\overline{A} + \overline{B}}$

schematics (each gate)



Resistor values are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: '08, 'S08 . . . . . 5.5 V
'LS08 . . . . . 7 V
Operating free-air temperature range: SN54' . . . . . –55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . –65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN5408			SN7408			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH} High-level input voltage	2			2			V
V_{IL} Low-level input voltage			0.8			0.8	V
I_{OH} High-level output current			−0.8			−0.8	mA
I_{OL} Low-level output current			16			16	mA
T_A Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN5408			SN7408			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}	V_{CC} = MIN, V_{IH} = 2 V, I_{OH} = −0.8 mA	2.4	3.4		2.4	3.4		V
V_{OL}	V_{CC} = MIN, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
I_{IL}	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
I_{OS}§	V_{CC} = MAX	−20		−55	−18		−55	mA
I_{CCH}	V_{CC} = MAX, V_I = 4.5 V		11	21		11	21	mA
I_{CCL}	V_{CC} = MAX, V_I = 0 V		20	33		20	33	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 400 Ω, C_L = 15 pF		17.5	27	ns
t_{PHL}					12	19	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

		SN54LS08			SN74LS08			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			– 0.4			– 0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN54LS08			SN74LS08			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN,	I_I = – 18 mA				– 1.5			– 1.5	V
V_{OH}	V_{CC} = MIN,	V_{IH} = 2 V,	I_{OH} = – 0.4 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN,	V_{IL} = MAX,	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
	V_{CC} = MIN,	V_{IL} = MAX,	I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
I_{IL}	V_{CC} = MAX,	V_I = 0.4 V				– 0.4			– 0.4	mA
I_{OS}§	V_{CC} = MAX			– 20		– 100	– 20		– 100	mA
I_{CCH}	V_{CC} = MAX,	V_I = 4.5 V			2.4	4.8		2.4	4.8	mA
I_{CCL}	V_{CC} = MAX,	V_I = 0 V			4.4	8.8		4.4	8.8	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 2 kΩ,	C_L = 15 pF		8	15	ns
t_{PHL}						10	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

		SN54S08			SN74S08			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−1			−1	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN54S08			SN74S08			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = −18 mA			−1.2			−1.2	V
V_{OH}	V_{CC} = MIN, V_{IH} = 2 V, I_{OH} = −1 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN, V_{IL} = 0.8 V, I_{OL} = 20 mA			0.5			0.5	V
I_I	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.7 V			50			50	μA
I_{IL}	V_{CC} = MAX, V_I = 0.5 V			−2			−2	mA
I_{OS}§	V_{CC} = MAX	−40		−100	−40		−100	mA
I_{CCH}	V_{CC} = MAX, V_I = 4.5 V		18	32		18	32	mA
I_{CCL}	V_{CC} = MAX, V_I = 0 V		32	57		32	57	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 280 Ω, C_L = 15 pF		4.5	7	ns
t_{PHL}					5	7.5	ns
t_{PLH}			R_L = 280 Ω, C_L = 50 pF		6		ns
t_{PHL}					7.5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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FAIRCHILD SEMICONDUCTOR™

June 1986
Revised March 2000

DM74LS20
Dual 4-Input NAND Gate

General Description

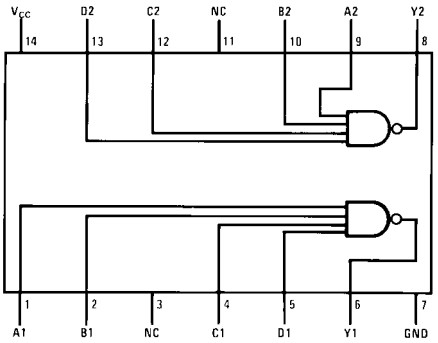
This device contains two independent gates each of which performs the logic NAND function.

Ordering Code:

Order Number	Package Number	Package Description
DM74LS20M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
DM74LS20N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table

$$Y = \overline{ABCD}$$

Inputs				Output
A	B	C	D	Y
X	X	X	L	H
X	X	L	X	H
X	L	X	X	H
L	X	X	X	H
H	H	H	H	L

H = HIGH Logic Level
L = LOW Logic Level
X = Either LOW or HIGH Logic Level

Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.4	mA
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max, V_{IL} = Max	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IH} = Min		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.36	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−20		−100	mA
I_{CCH}	Supply Current with Outputs HIGH	V_{CC} = Max		0.4	0.8	mA
I_{CCL}	Supply Current with Outputs LOW	V_{CC} = Max		1.2	2.2	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

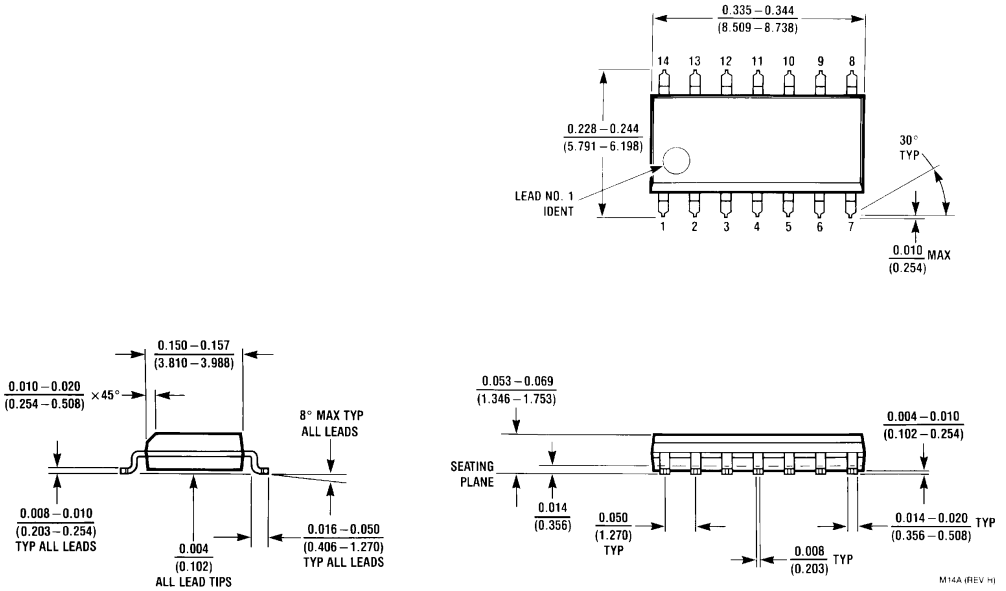
Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

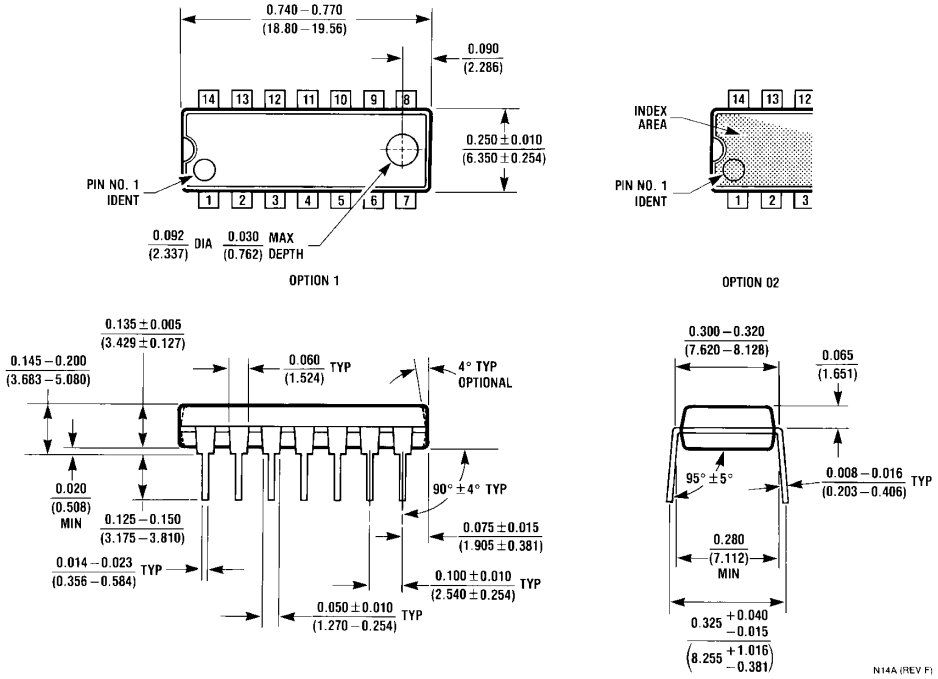
Symbol	Parameter	R_L = 2 kΩ				Units
		C_L = 15 pF		C_L = 50 pF		
		Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	3	10	4	15	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	3	10	4	15	ns

Physical Dimensions inches (millimeters) unless otherwise noted



14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

- **Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**

description

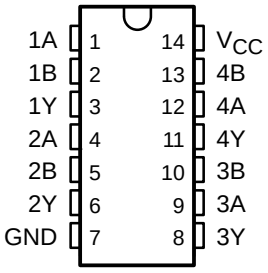
These devices contain four independent 2-input positive-OR gates. They perform the Boolean functions $Y = \overline{A} \bullet \overline{B}$ or $Y = A + B$ in positive logic.

The SN54ALS32 and SN54AS32 are characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS32 and SN74AS32 are characterized for operation from 0°C to 70°C.

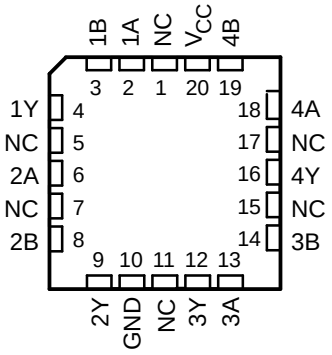
FUNCTION TABLE
(each gate)

INPUTS		OUTPUT
A	B	Y
H	X	H
X	H	H
L	L	L

SN54ALS32, SN54AS32 . . . J PACKAGE
SN74ALS32, SN74AS32 . . . D OR N PACKAGE
(TOP VIEW)

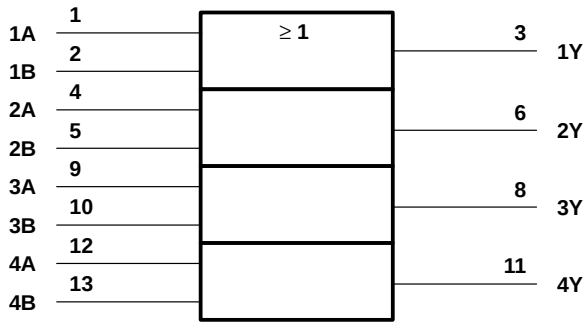


SN54ALS32, SN54AS32 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

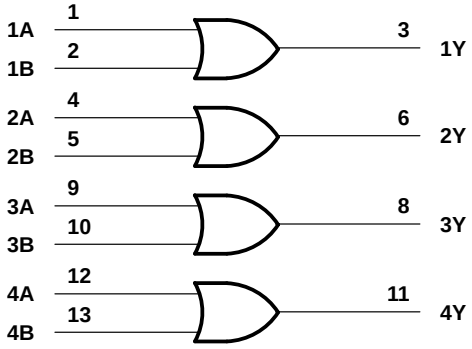
logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} . . . . . 7 V
Input voltage, V_I . . . . . 7 V
Operating free-air temperature range, T_A: SN54ALS32 . . . . . –55°C to 125°C
SN74ALS32 . . . . . 0°C to 70°C
Storage temperature range . . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54ALS32			SN74ALS32			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			–0.4			–0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS32			SN74ALS32			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = –18 mA			–1.5			–1.5	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = –0.4 mA	V_{CC} –2			V_{CC} –2			V
V_{OL}	V_{CC} = 4.5 V	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			–0.1			–0.1	mA
I_O§	V_{CC} = 5.5 V,	V_O = 2.25 V	–20		–112	–30		–112	mA
I_{CCH}	V_{CC} = 5.5 V,	V_I = 4.5 V		1.9	4		1.9	4	mA
I_{CCL}	V_{CC} = 5.5 V,	V_I = 0		2.6	4.9		2.6	4.9	mA

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX¶				UNIT
			SN54ALS32		SN74ALS32		
			MIN	MAX	MIN	MAX	
t_{PLH}	A or B	Y	3	18	3	14	ns
t_{PHL}			3	16	3	12	

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} . . . . . 7 V
Input voltage, V_I . . . . . 7 V
Operating free-air temperature range, T_A: SN54AS32 . . . . . –55°C to 125°C
SN74AS32 . . . . . 0°C to 70°C
Storage temperature range . . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS32			SN74AS32			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			–2			–2	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54AS32			SN74AS32			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = –18 mA			–1.2			–1.2	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = –2 mA	V_{CC} –2			V_{CC} –2			V
V_{OL}	V_{CC} = 4.5 V,	I_{OL} = 20 mA		0.35	0.5		0.35	0.5	V
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			–0.5			–0.5	mA
I_O§	V_{CC} = 5.5 V,	V_O = 2.25 V	–30		–112	–30		–112	mA
I_{CCH}	V_{CC} = 5.5 V,	V_I = 4.5 V		7.3	12		7.3	12	mA
I_{CCL}	V_{CC} = 5.5 V,	V_I = 0		16.5	26.6		16.5	26.6	mA

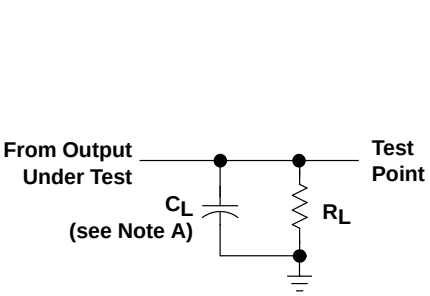
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

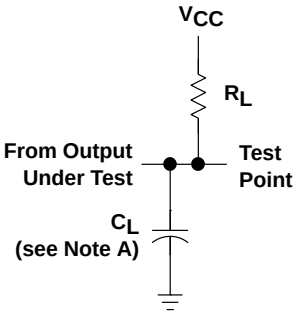
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX¶				UNIT
			SN54AS32		SN74AS32		
			MIN	MAX	MIN	MAX	
t_{PLH}	A or B	Y	1	7.5	1	5.8	ns
t_{PHL}			1	6.5	1	5.8	

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

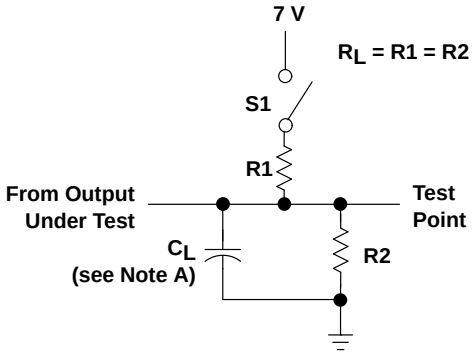
PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



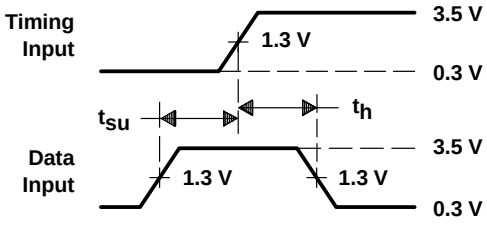
LOAD CIRCUIT FOR
BI-STATE
TOTEM-POLE OUTPUTS



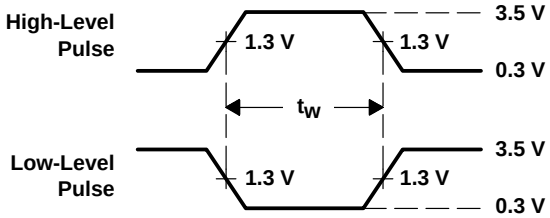
LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS



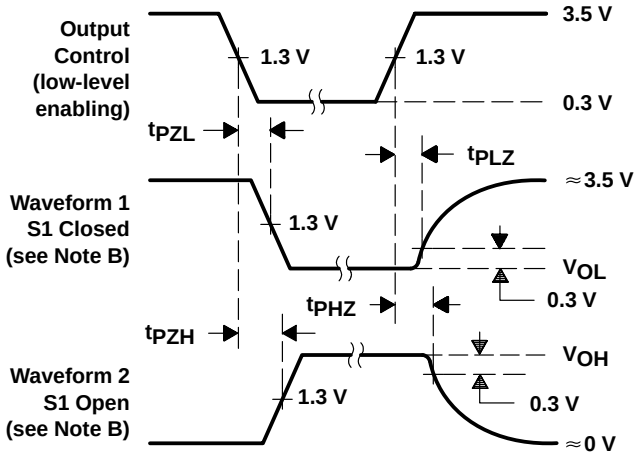
LOAD CIRCUIT
FOR 3-STATE OUTPUTS



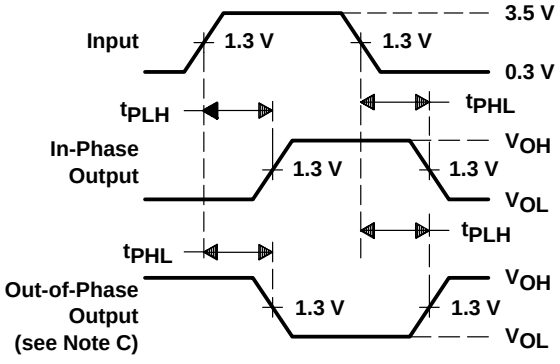
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: PRR ≤ 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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FAIRCHILD SEMICONDUCTOR™

September 1986
Revised February 2000

DM74ALS74A
Dual D Positive-Edge-Triggered Flip-Flop with Preset and Clear

General Description

The DM74ALS74A contains two independent positive edge-triggered flip-flops. Each flip-flop has individual D, clock, clear and preset inputs, and also complementary Q and $\overline{Q}$ outputs.

Information at input D is transferred to the Q output on the positive going edge of the clock pulse. Clock triggering occurs at a voltage level of the clock pulse and is not directly related to the transition time of the positive going pulse. When the clock input is at either the HIGH or LOW level, the D input signal has no effect.

Asynchronous preset and clear inputs will set or clear Q output respectively upon the application of low level signal.

Features

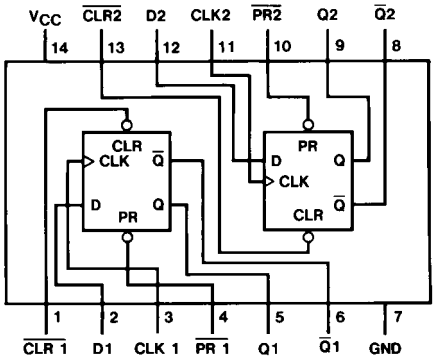
- Switching specifications at 50 pF
- Switching specifications guaranteed over full temperature and V_{CC} range
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Functionally and pin-for-pin compatible with Schottky and LS TTL counterpart
- Improved AC performance over LS74 at approximately half the power

Ordering Code:

Order Number	Package Number	Package Description
DM74ALS74AM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74ALS74ASJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS74AN	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



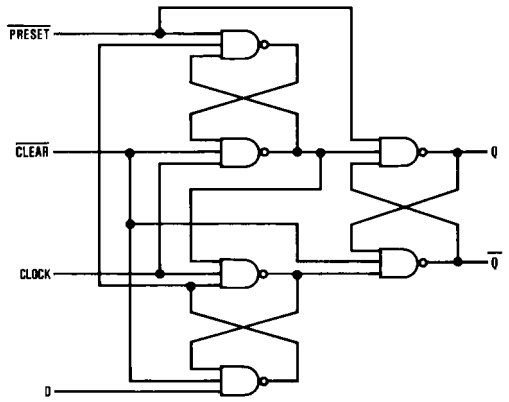
Function Table

Inputs				Outputs	
$\overline{PR}$	$\overline{CLR}$	CLK	D	Q	$\overline{Q}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H (Note 1)	H (Note 1)
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	Q_0	$\overline{Q}_0$

L = LOW State
H = HIGH State
X = Don't Care
↑ = Positive Edge Transition
Q_0 = Previous Condition of Q

Note 1: This condition is nonstable; it will not persist when preset and clear inputs return to their inactive (HIGH) level. The output levels in this condition are not guaranteed to meet the V_{OH} specification.

Logic Diagram



Absolute Maximum Ratings(Note 2)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C
Typical θ_{JA}	
N Package	87.0°C/W
M Package	117.0°C/W

Note 2: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter		Min	Nom	Max	Units
V_{CC}	Supply Voltage		4.5	5	5.5	V
V_{IH}	HIGH Level Input Voltage		2			V
V_{IL}	LOW Level Input Voltage				0.8	V
I_{OH}	HIGH Level Output Current				−0.4	mA
I_{OL}	LOW Level Output Current				8	mA
f_{CLK}	Clock Frequency		0		34	MHz
$t_{W(CLK)}$	Width of Clock Pulse	HIGH	14.5			ns
		LOW	14.5			ns
t_W	Pulse Width Preset & Clear	LOW	14.5			ns
t_{SU}	Data Setup Time	Data	15↑ (Note 3)			ns
		PRE or CLR Inactive	10↑ (Note 3)			
t_H	Data Hold Time		0↑ (Note 3)			ns
T_A	Free Air Operating Temperature		0		70	°C

Note 3: The (↑) arrow indicates the positive edge of the Clock is used for reference.

Electrical Characteristics

over recommended operating free air temperature range. All typical values are measured at V_{CC} = 5V, T_A = 25°C.

Symbol	Parameter	Conditions		Min	Typ	Max	Units
V_{IK}	Input Clamp Voltage	V_{CC} = 4.5V, I_I = −18 mA				−1.5	V
V_{OH}	HIGH Level Output Voltage	I_{OH} = −0.4 mA V_{CC} = 4.5V to 5.5V		V_{CC} − 2			V
V_{OL}	LOW Level Output Voltage	V_{CC} = 4.5V V_{IH} = 2V	I_{OL} = 8 mA		0.35	0.5	V
I_I	Input Current @ Max Input Voltage	V_{CC} = 5.5V, V_{IH} = 7V	Clock, D			0.1	mA
			Preset, Clear			0.2	
I_{IH}	HIGH Level Input Current	V_{CC} = 5.5V, V_{IH} = 2.7V	Clock, D			20	µA
			Preset, Clear			40	
I_{IL}	LOW Level Input Current	V_{CC} = 5.5V, V_{IL} = 0.4V	Clock, D			−0.2	mA
			Preset, Clear (Note 5)			−0.4	
I_O	Output Drive Current	V_{CC} = 5.5V, V_O = 2.25V		−30		−112	mA
I_{CC}	Supply Current	V_{CC} = 5.5V (Note 4)			2.4	4	mA

Note 4: I_{CC} is measured with D, CLK and PRESET grounded, then with D, CLK and CLEAR grounded.

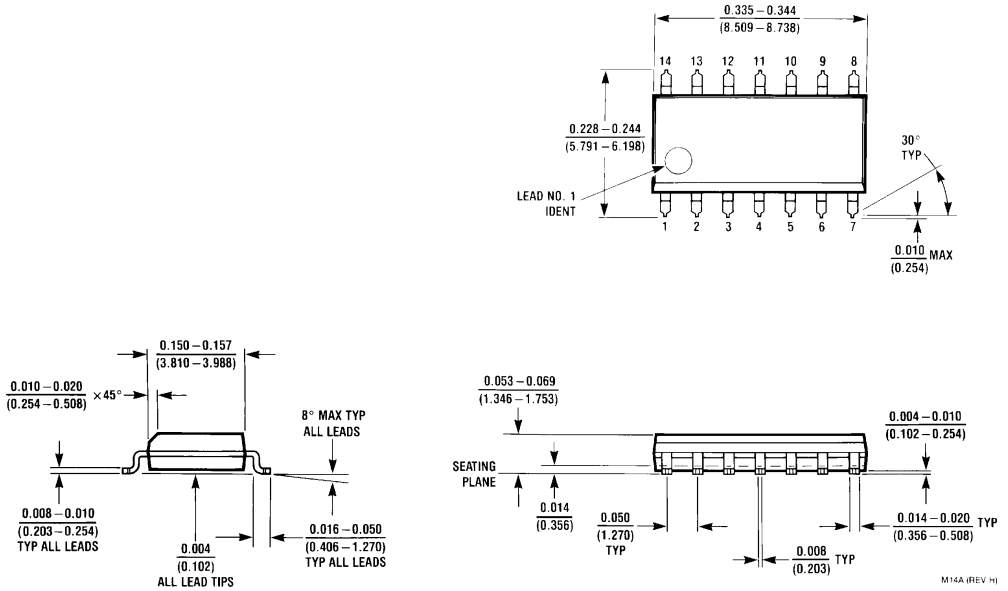
Note 5: I_{IL} PRE and CLR pins not guaranteed to meet specifications with both PRE and CLK LOW.

Switching Characteristics

over recommended operating free air temperature range.

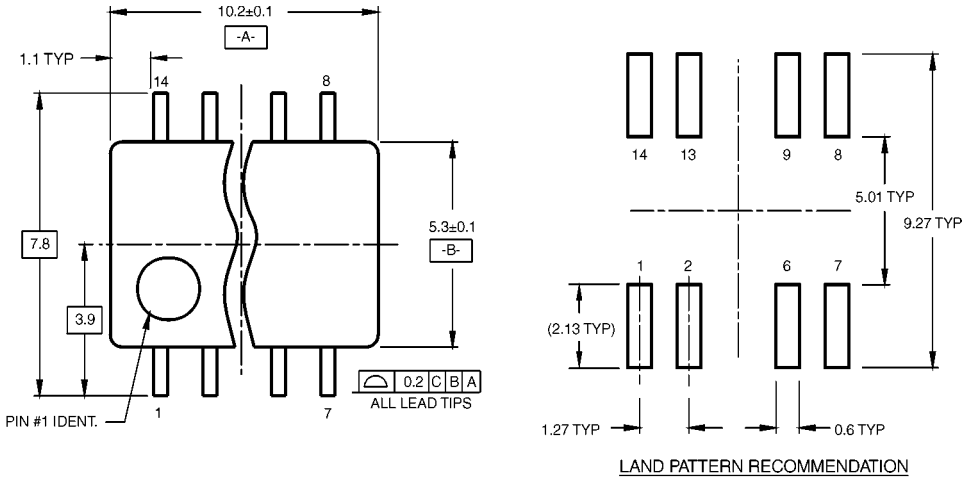
Parameter	Conditions	From	To	Min	Max	Units
f_{MAX}	V_{CC} = 4.5V to 5.5V			34		MHz
t_{PLH}	R_L = 500Ω	$\overline{\text{Preset}}$ or $\overline{\text{Clear}}$	Q or $\overline{Q}$	3	13	ns
t_{PHL}	C_L = 50 pF			5	15	ns
t_{PLH}		Clock	Q or $\overline{Q}$	5	16	ns
t_{PHL}				5	18	ns

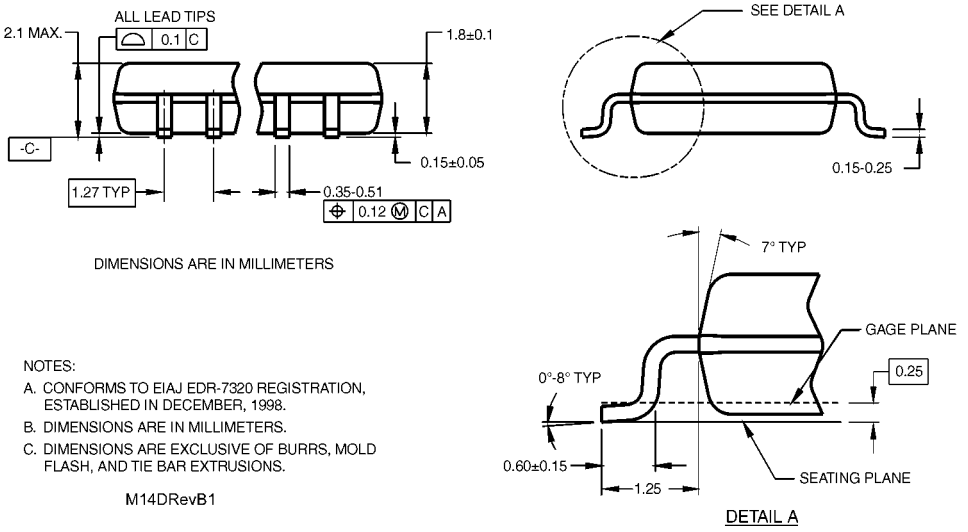
Physical Dimensions inches (millimeters) unless otherwise noted



14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





NOTES:

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.

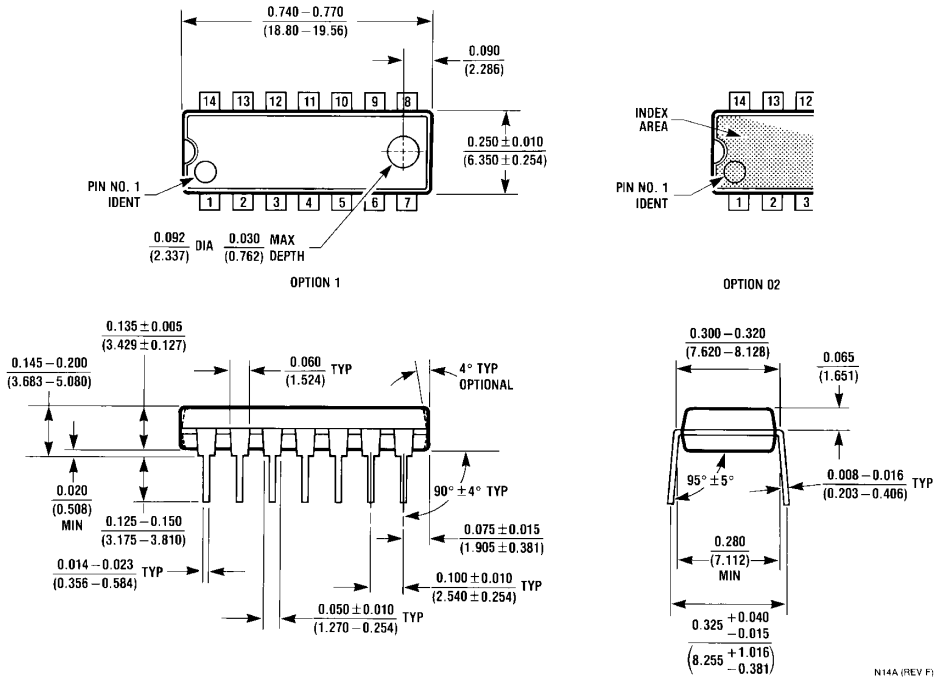
B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DRevB1

14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

DUAL J-K FLIP-FLOPS WITH PRESET AND CLEAR

SDLS121 – DECEMBER 1983 – REVISED MARCH 1988

- **Package Options Include Plastic and Ceramic DIPs and Ceramic Flat Packages**
- **Dependable Texas Instruments Quality and Reliability**

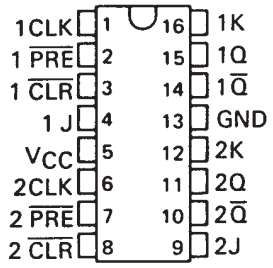
description

The '76 contains two independent J-K flip-flops with individual J-K, clock, preset, and clear inputs. The '76 is a positive-edge-triggered flip-flop. J-K input is loaded into the master while the clock is high and transferred to the slave on the high-to-low transition. For these devices the J and K inputs must be stable while the clock is high.

The 'LS76A contain two independent negative-edge-triggered flip-flops. The J and K inputs must be stable one setup time prior to the high-to-low clock transition for predicatble operation. The preset and clear are asynchronous active low inputs. When low they override the clock and data inputs forcing the outputs to the steady state levels as shown in the function table.

The SN5476 and the SN54LS76A are characterized for operation over the full military temperature range of −55°C to 125°C. The SN7476 and the SN74LS76A are characterized for operation from 0°C to 70°C.

SN5476, SN54LS76A . . . J PACKAGE
SN7476 . . . N PACKAGE
SN74LS76A . . . D OR N PACKAGE
(TOP VIEW)



'76
FUNCTION TABLE

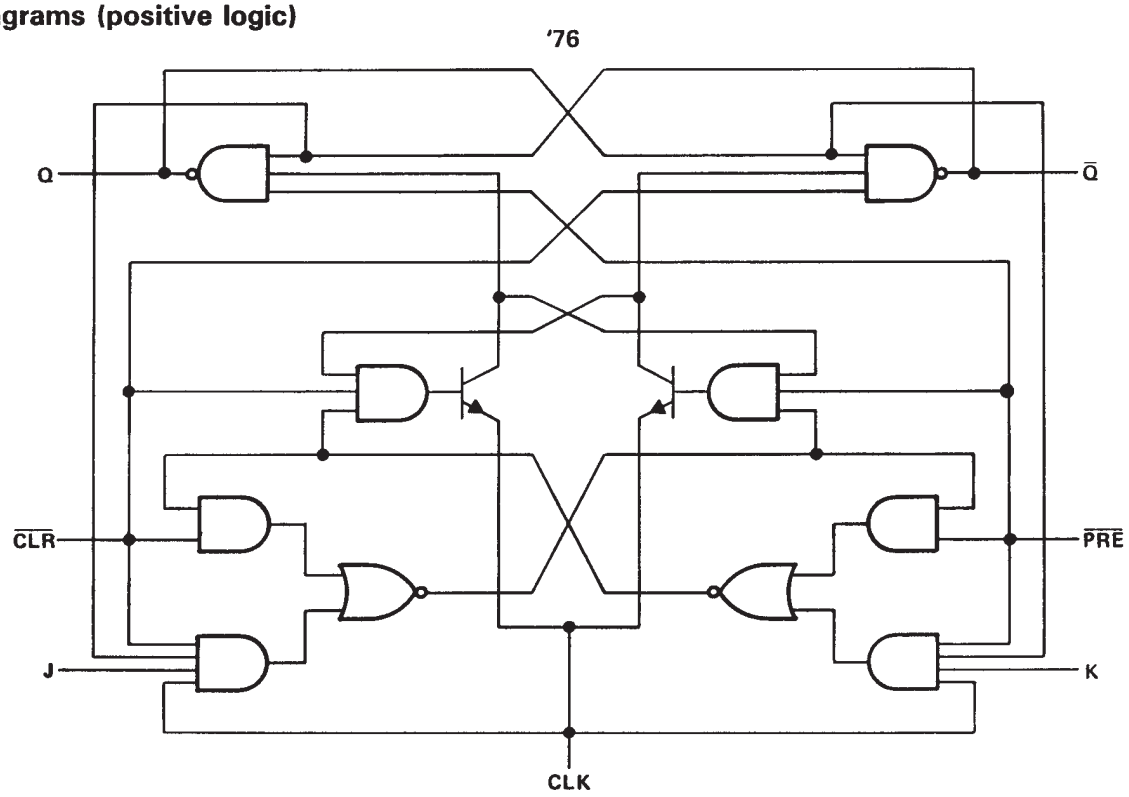
INPUTS					OUTPUTS	
PRE	CLR	CLK	J	K	Q	Q̄
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H†	H†
H	H	⎍	L	L	Q_0	$\overline{Q}_0$
H	H	⎍	H	L	H	L
H	H	⎍	L	H	L	H
H	H	⎍	H	H	TOGGLE	

'LS76A
FUNCTION TABLE

INPUTS					OUTPUTS	
PRE	CLR	CLK	J	K	Q	Q̄
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H†	H†
H	H	↓	L	L	Q_0	$\overline{Q}_0$
H	H	↓	H	L	H	L
H	H	↓	L	H	L	H
H	H	↓	H	H	TOGGLE	
H	H	H	X	X	Q_0	$\overline{Q}_0$

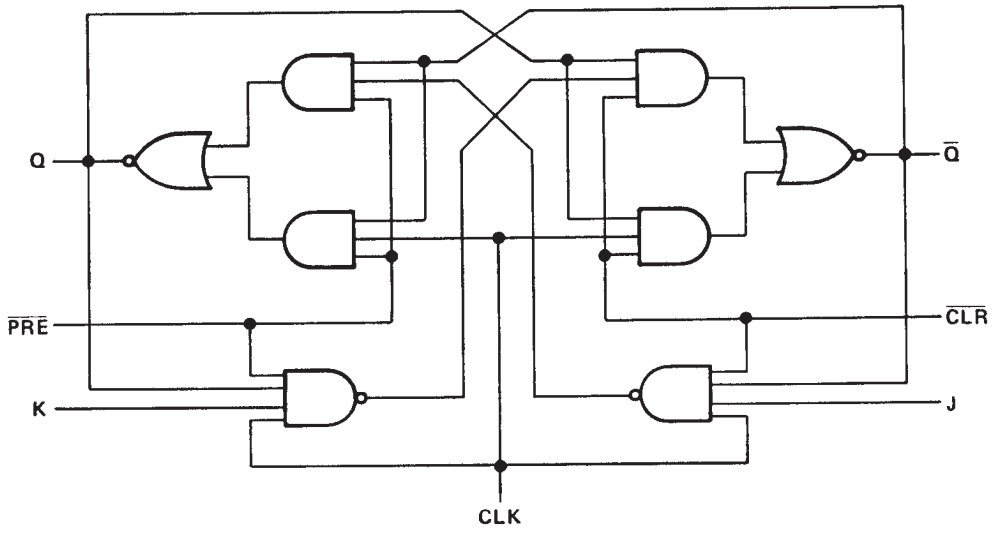
† This configuration is nonstable; that is, it will not persist when either preset or clear returns to its inactive (high) level.

logic diagrams (positive logic)



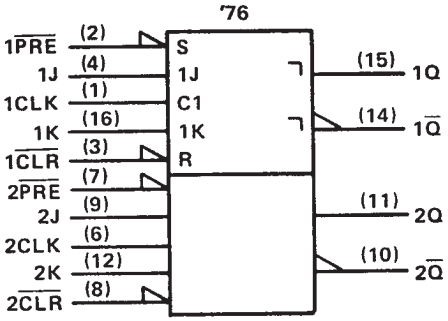
logic diagrams (positive logic) (continued)

'LS76A

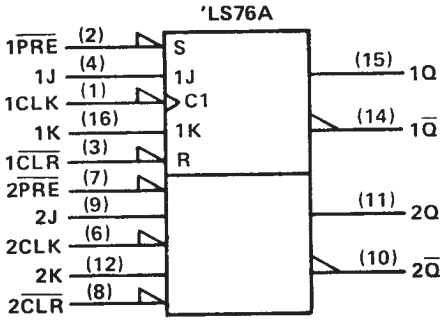


logic symbols†

'76



'LS76A

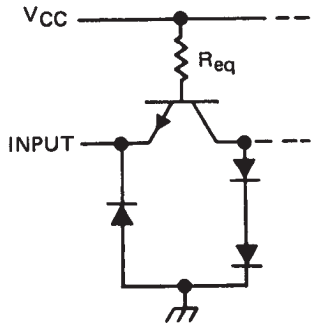


†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematics of inputs and outputs

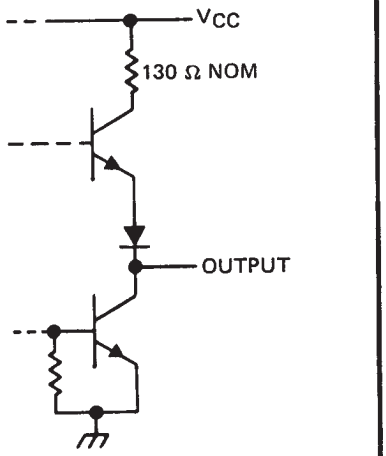
'76

EQUIVALENT OF EACH INPUT



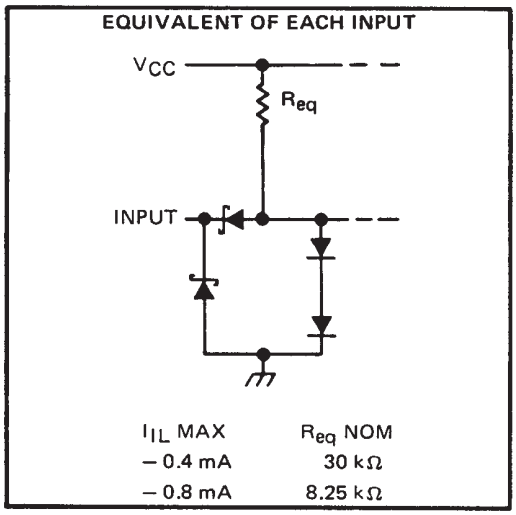
I_{IL} MAX	R_{eq} NOM
– 1.6 mA	4 kΩ
– 3.2 mA	2 kΩ

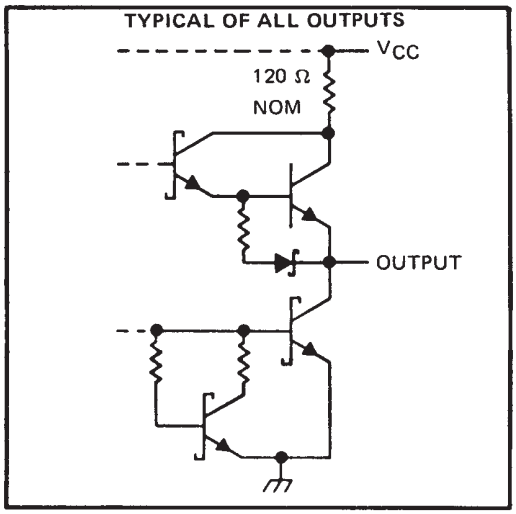
TYPICAL OF ALL OUTPUTS



schematics of inputs and outputs (continued)

'LS76A





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: '76 . . . . . 5.5 V
'LS76A . . . . . 7 V
Operating free-air temperature range: SN54' . . . . . −55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5476			SN7476			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.8			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				16			16	mA
t_w	Pulse duration	CLK high	20			20			ns
		CLK low	47			47			
		$\overline{PRE}$ or $\overline{CLR}$ low	25			25			
t_{su}	Input setup time before CLK↑		0			0			ns
t_h	Input hold time-data after CLK↓		0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN5476			SN7476			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −0.4 mA	2.4	3.4		2.4	3.4		V
V_{OL}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I		V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	J or K	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
	All other				80			80	
I_{IL}	J or K	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
	All other¶				−3.2			−3.2	
I_{OS}§		V_{CC} = MAX	−20		−57	−18		−57	mA
I_{CC}#		V_{CC} = MAX, See Note 2		10	20		10	20	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
¶ Clear is tested with preset high and preset is tested with clear high.
# Average per flip-flop.
NOTE 2: With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the time of measurement, the clock input is grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			R_L = 400 Ω, C_L = 15 pF	15	20		MHz
t_{PLH}	$\overline{PRE}$ or $\overline{CLR}$	Q or $\overline{Q}$			16	25	ns
t_{PHL}					25	40	ns
t_{PLH}	CLK	Q or $\overline{Q}$			16	25	ns
t_{PHL}					25	40	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

			SN54LS76A			SN74LS76A			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.75	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				4			8	mA
f_{clock}	Clock frequency		0		30	0		30	MHz
t_w	Pulse duration	CLK high	20			20			ns
		$\overline{PRE}$ or $\overline{CLR}$ low	25			25			
t_{su}	Setup time before CLK↓	data high or low	20			20			ns
		$\overline{CLR}$ inactive	20			20			
		$\overline{PRE}$ inactive	25			25			
t_h	Hold time-data after CLK↓		0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†			SN54LS76A			SN74LS76A			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}		V_{CC} = MIN, I_{OH} = −0.4 mA	V_{IH} = 2 V,	V_{IL} = MAX,	2.5	3.4		2.7	3.4		V
V_{OL}		V_{CC} = MIN, I_{OL} = 4 mA	V_{IL} = MAX,	V_{IH} = 2 V,		0.25	0.4		0.25	0.4	V
		V_{CC} = MIN, I_{OL} = 8 mA	V_{IL} = MAX,	V_{IH} = 2 V,					0.35	0.5	
I_I	J or K	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
	$\overline{CLR}$ or $\overline{PRE}$						0.3			0.3	
	CLK						0.4			0.4	
I_{IH}	J or K	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
	$\overline{CLR}$ or $\overline{PRE}$						60			60	
	CLK						80			80	
I_{IL}	J or K	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
	All other						−0.8			−0.8	
I_{OS}§		V_{CC} = MAX,	See Note 4		−20		−100	−20		−100	mA
I_{CC} (Total)		V_{CC} = MAX,	See Note 2			4	6		4	6	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.
NOTE 2: With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the time of measurement, the clock input is grounded.
NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V_O = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
f_{max}			R_L = 2 kΩ,	C_L = 15 pF	30	45		MHz
t_{PLH}	$\overline{PRE}$, $\overline{CLR}$ or CLK	Q or $\overline{Q}$				15	20	ns
t_{PHL}						15	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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- **Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**

description

These devices contain four independent 2-input exclusive-OR gates. They perform the Boolean functions $Y = A \oplus B$ or $Y = \overline{A}B + A\overline{B}$ in positive logic.

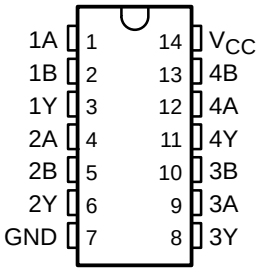
A common application is as a true/complement element. If one of the inputs is low, the other input is reproduced in true form at the output. If one of the inputs is high, the signal on the other input is reproduced inverted at the output.

The SN54ALS86 and SN54AS86A are characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS86 and SN74AS86A are characterized for operation from 0°C to 70°C.

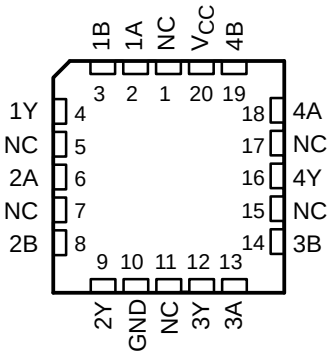
FUNCTION TABLE
(each gate)

INPUTS		OUTPUT
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

SN54ALS86, SN54AS86A . . . J PACKAGE
SN74ALS86, SN74AS86A . . . D OR N PACKAGE
(TOP VIEW)

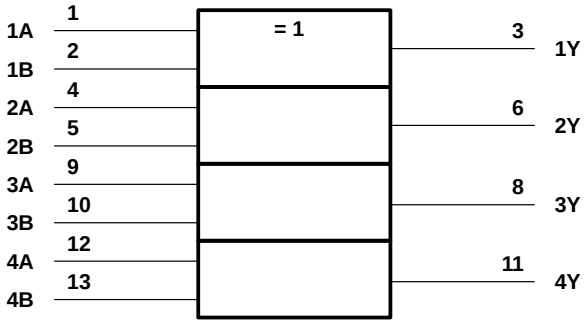


SN54ALS86, SN54AS86A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

logic symbol†

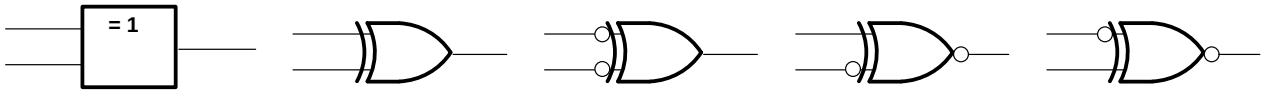


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

exclusive-OR logic

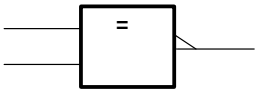
An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.

EXCLUSIVE-OR



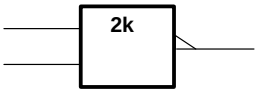
These are five equivalent exclusive-OR symbols valid for an ′ALS86 or ′AS86A gate in positive logic. Negation may be shown at any two ports.

LOGIC-IDENTITY ELEMENT



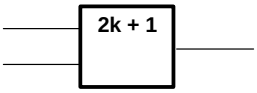
The output is active (low) if all inputs are at the same logic level (i.e., A = B).

EVEN-PARITY ELEMENT



The output is active (low) if an even number of inputs (i.e., 0 or 2) are active.

ODD-PARITY ELEMENT



The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} . . . . . 7 V
Input voltage, V_I . . . . . 7 V
Operating free-air temperature range, T_A: SN54ALS86 . . . . . –55°C to 125°C
SN74ALS86 . . . . . 0°C to 70°C
Storage temperature range . . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54ALS86			SN74ALS86			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			–0.4			–0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS86			SN74ALS86			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = –18 mA			–1.5			–1.5	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = –0.4 mA	V_{CC} –2			V_{CC} –2			V
V_{OL}	V_{CC} = 4.5 V	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			–0.1			–0.1	mA
I_O§	V_{CC} = 5.5 V,	V_O = 2.25 V	–20		–112	–30		–112	mA
I_{CC}	V_{CC} = 5.5 V,	All inputs at 4.5 V		3.9	5.9		3.9	5.9	mA

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX¶				UNIT
			SN54ALS86		SN74ALS86		
			MIN	MAX	MIN	MAX	
t_{PLH}	A or B (other input low)	Y	3	22	3	17	ns
t_{PHL}			2	14	2	12	
t_{PLH}	A or B (other input high)	Y	3	22	3	17	ns
t_{PHL}			2	12	2	10	

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} . . . . . 7 V
Input voltage, V_I . . . . . 7 V
Operating free-air temperature range, T_A: SN54AS86A . . . . . –55°C to 125°C
SN74AS86A . . . . . 0°C to 70°C
Storage temperature range . . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS86A			SN74AS86A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			–2			–2	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54AS86A			SN74AS86A			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = –18 mA			–1.2			–1.2	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = –2 mA	V_{CC} –2			V_{CC} –2			V
V_{OL}	V_{CC} = 4.5 V,	I_{OL} = 20 mA		0.35	0.5		0.35	0.5	V
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			–0.5			–0.5	mA
I_O§	V_{CC} = 5.5 V,	V_O = 2.25 V	–30		–112	–30		–112	mA
I_{CCH}	V_{CC} = 5.5 V,	$V_{I(A)}$ = 4.5 V, $V_{I(B)}$ = 0		11	18		11	18	mA
I_{CCL}	V_{CC} = 5.5 V,	V_I = 4.5 V		20	38		20	38	mA

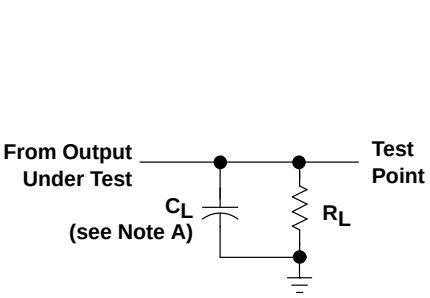
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

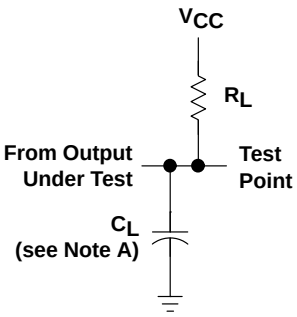
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX¶				UNIT
			SN54AS86A		SN74AS86A		
			MIN	MAX	MIN	MAX	
t_{PLH}	A or B (other input low)	Y	2	8.5	2	7.5	ns
t_{PHL}			2	8	2	6.5	
t_{PLH}	A or B (other input high)	Y	1	8	1	6.5	ns
t_{PHL}			1	9	1	7	

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

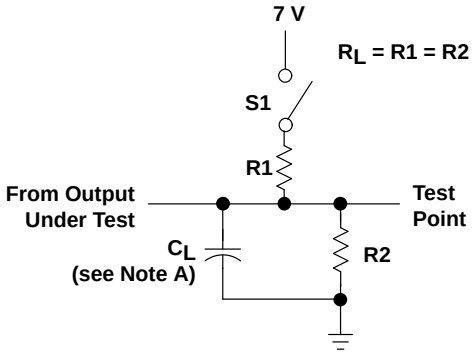
PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



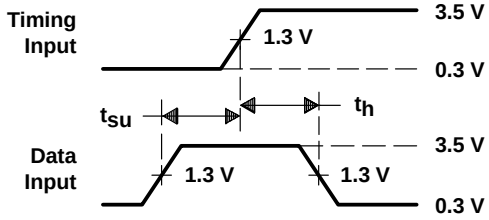
LOAD CIRCUIT FOR
BI-STATE
TOTEM-POLE OUTPUTS



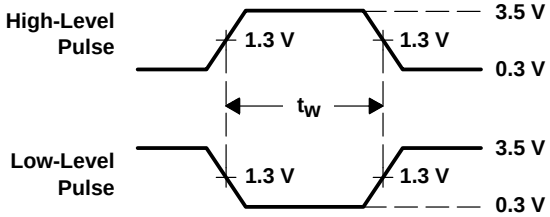
LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS



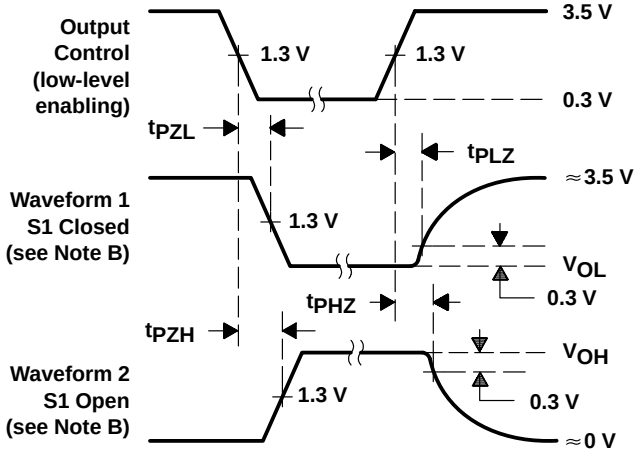
LOAD CIRCUIT
FOR 3-STATE OUTPUTS



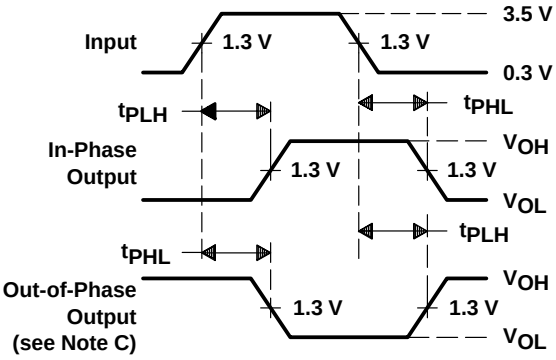
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: PRR ≤ 1 MHz, $t_r = t_f$ = 2 ns, duty cycle = 50%.
E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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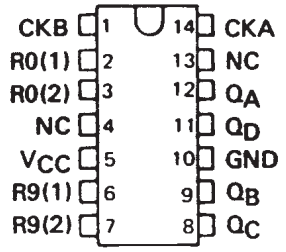
'90A, 'LS90 . . . Decade Counters

'92A, 'LS92 . . . Divide By-Twelve Counters

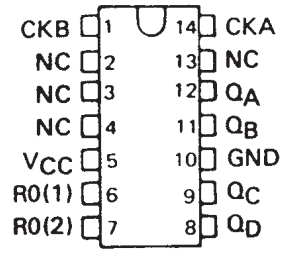
'93A, 'LS93 . . . 4-Bit Binary Counters

TYPES	TYPICAL POWER DISSIPATION
'90A	145 mW
'92A, '93A	130 mW
'LS90, 'LS92, 'LS93	45 mW

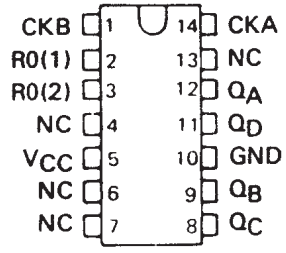
SN5490A, SN54LS90 . . . J OR W PACKAGE
SN7490A . . . N PACKAGE
SN74LS90 . . . D OR N PACKAGE
(TOP VIEW)



SN5492A, SN54LS92 . . . J OR W PACKAGE
SN7492A . . . N PACKAGE
SN74LS92 . . . D OR N PACKAGE
(TOP VIEW)



SN5493A, SN54LS93 . . . J OR W PACKAGE
SN7493 . . . N PACKAGE
SN74LS93 . . . D OR N PACKAGE
(TOP VIEW)



description

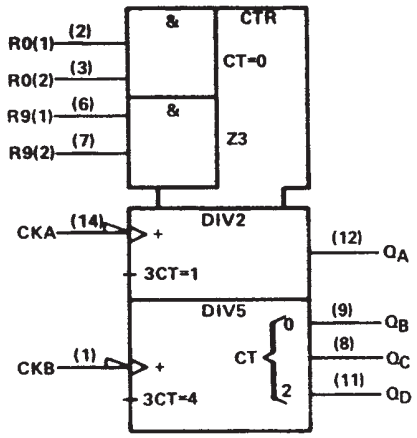
Each of these monolithic counters contains four master-slave flip-flops and additional gating to provide a divide-by-two counter and a three-stage binary counter for which the count cycle length is divide-by-five for the '90A and 'LS90, divide-by-six for the '92A and 'LS92, and the divide-by-eight for the '93A and 'LS93.

All of these counters have a gated zero reset and the '90A and 'LS90 also have gated set-to-nine inputs for use in BCD nine's complement applications.

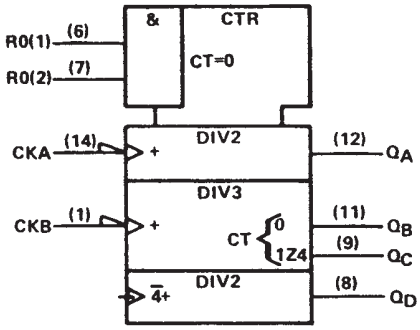
To use their maximum count length (decade, divide-by-twelve, or four-bit binary) of these counters, the CKB input is connected to the Q_A output. The input count pulses are applied to CKA input and the outputs are as described in the appropriate function table. A symmetrical divide-by-ten count can be obtained from the '90A or 'LS90 counters by connecting the Q_D output to the CKA input and applying the input count to the CKB input which gives a divide-by-ten square wave at output Q_A.

logic symbols†

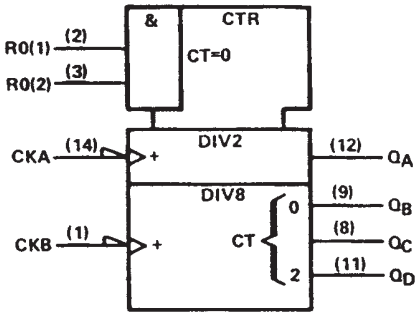
'90



'92



'93A, 'LS93



†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

'90A, 'LS90
BCD COUNT SEQUENCE
(See Note A)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

'90A, 'LS90
BI-QUINARY (5-2)
(See Note B)

COUNT	OUTPUT			
	Q_A	Q_D	Q_C	Q_B
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	H	L	L	L
6	H	L	L	H
7	H	L	H	L
8	H	L	H	H
9	H	H	L	L

'92A, 'LS92
COUNT SEQUENCE
(See Note C)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	H	L	L	L
7	H	L	L	H
8	H	L	H	L
9	H	L	H	H
10	H	H	L	L
11	H	H	L	H

'90A, 'LS90
RESET/COUNT FUNCTION TABLE

RESET INPUTS				OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	$R_{9(1)}$	$R_{9(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
X	L	X	L	COUNT			
L	X	L	X	COUNT			
L	X	X	L	COUNT			
X	L	L	X	COUNT			

'92A, 'LS92, '93A, 'LS93
RESET/COUNT FUNCTION TABLE

RESET INPUTS		OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

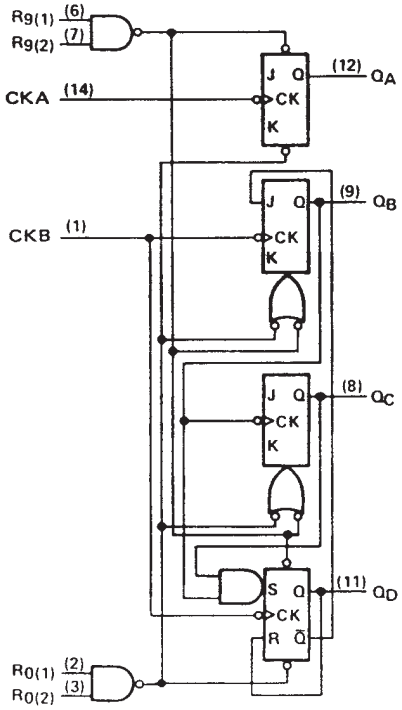
'93A, 'LS93
COUNT SEQUENCE
(See Note C)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

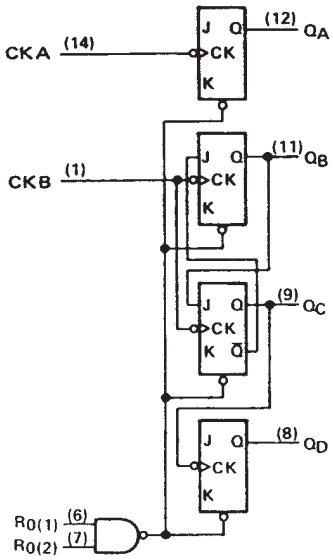
NOTES: A. Output Q_A is connected to input CKB for BCD count.
B. Output Q_D is connected to input CKA for bi-quinary count.
C. Output Q_A is connected to input CKB.
D. H = high level, L = low level, X = irrelevant

logic diagrams (positive logic)

'90A, 'LS90

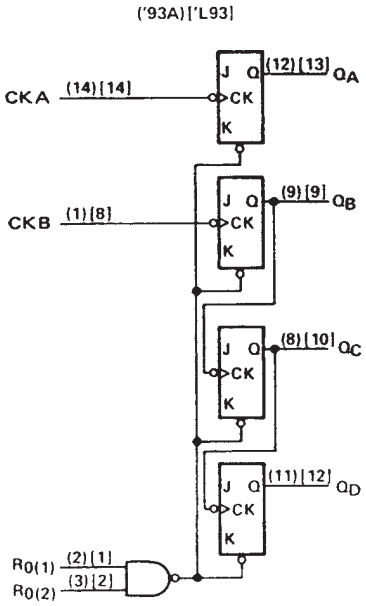


'92A, 'LS92



'93A, 'LS93

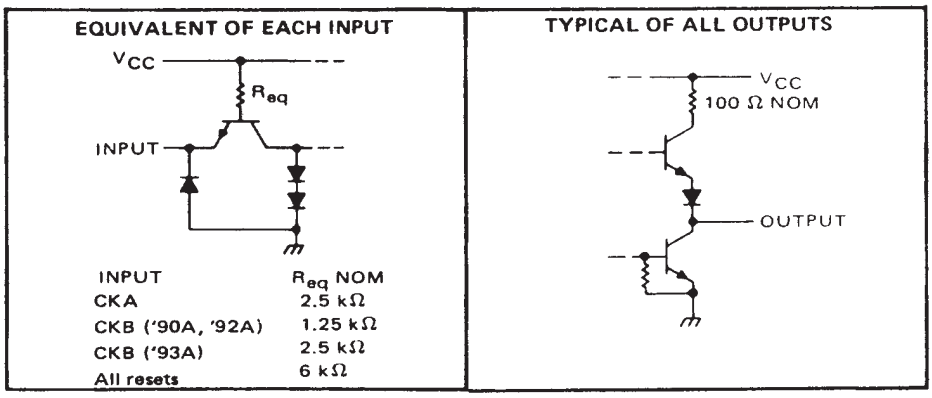
('93A) ['L93]



The J and K inputs shown without connection are for reference only and are functionally at a high level.
Pin numbers shown in ( ) are for the 'LS93 and '93A and pin numbers shown in [ ] are for the 54L93.

schematics of inputs and outputs

'90A, '92A, '93A

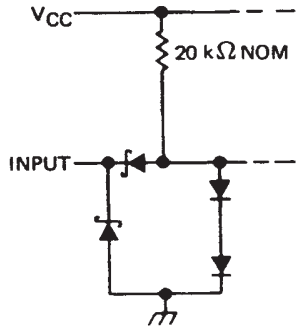


INPUT	R_{eq} NOM
CKA	2.5 kΩ
CKB ('90A, '92A)	1.25 kΩ
CKB ('93A)	2.5 kΩ
All resets	6 kΩ

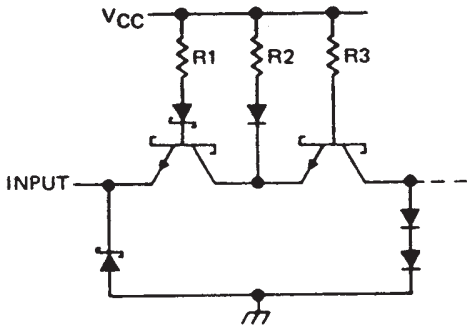
schematics of inputs and outputs (continued)

'LS90, 'LS92, 'LS93

EQUIVALENT OF EACH RESET INPUT

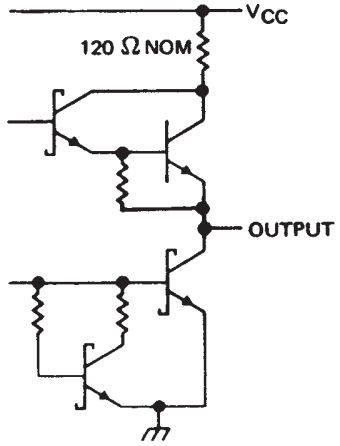


EQUIVALENT OF A AND B INPUTS



INPUT	NOMINAL VALUES R1	R2	R3
CKA	10 kΩ	10 kΩ	10 kΩ
CKB ('LS90, 'LS92)	6.7 kΩ	6.7 kΩ	5 kΩ
CKB ('LS93)	15 kΩ	15 kΩ	10 kΩ

TYPICAL OF ALL OUTPUTS



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Interemitter voltage (see Note 2) . . . . . 5.5 V
Operating free-air temperature range: SN5490A, SN5492A, SN5493A . . . . . −55°C to 125°C
SN7490A, SN7492A, SN7493A . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.
2. This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the two R_0 inputs, and for the '90A circuit, it also applies between the two R_9 inputs.

recommended operating conditions

		SN5490A, SN5492A SN5493A			SN7490A, SN7492A SN7493A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−800			−800	μA
Low-level output current, I_{OL}				16			16	mA
Count frequency, f_{count} (see Figure 1)	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	15			15			
Reset inactive-state setup time, t_{su}		25			25			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER ¶		TEST CONDITIONS†		'90A MIN	'90A TYP‡	'90A MAX	'92A MIN	'92A TYP‡	'92A MAX	'93A MIN	'93A TYP‡	'93A MAX	UNIT
V_{IH}	High-level input voltage			2			2			2			V
V_{IL}	Low-level input voltage					0.8			0.8			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −12 mA				−1.5			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA		2.4	3.4		2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA¶			0.2	0.4		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V				1			1			1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.4 V	Any reset			40			40			40	μA
			CKA			80			80			80	
			CKB			120			120			80	
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4 V	Any reset			−1.6			−1.6			−1.6	mA
			CKA			−3.2			−3.2			−3.2	
			CKB			−4.8			−4.8			−3.2	
I_{OS}	Short-circuit output current§	V_{CC} = MAX	SN54'	−20		−57	−20		−57	−20		−57	mA
			SN74'	−18		−57	−18		−57	−18		−57	
I_{CC}	Supply current	V_{CC} = MAX, See Note 3			29	42		26	39		26	39	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time.
¶Q_A outputs are tested at I_{OL} = 16 mA plus the limit value for I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.
NOTE 3: I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'90A			'92A			'93A			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
f_{max}	CKA	Q_A	C_L = 15 pF, R_L = 400 Ω, See Figure 1	32	42		32	42		32	42		MHz
	CKB	Q_B		16			16			16			
t_{PLH}	CKA	Q_A			10	16		10	16		10	16	ns
t_{PHL}					12	18		12	18		12	18	
t_{PLH}	CKA	Q_D			32	48		32	48		46	70	ns
t_{PHL}					34	50		34	50		46	70	
t_{PLH}	CKB	Q_B			10	16		10	16		10	16	ns
t_{PHL}					14	21		14	21		14	21	
t_{PLH}	CKB	Q_C			21	32		10	16		21	32	ns
t_{PHL}					23	35		14	21		23	35	
t_{PLH}	CKB	Q_D			21	32		21	32		34	51	ns
t_{PHL}					23	35		23	35		34	51	
t_{PHL}	Set-to-0	Any			26	40		26	40		26	40	ns
t_{PLH}	Set-to-9	Q_A, Q_D			20	30							ns
t_{PHL}		Q_B, Q_C			26	40							

† f_{max} = maximum count frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: R inputs . . . . . 7 V
A and B inputs . . . . . 5.5 V
Operating free-air temperature range: SN54LS' Circuits . . . . . −55°C to 125°C
SN74LS' Circuits . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS90 SN54LS92 SN54LS93			SN74LS90 SN74LS92 SN74LS93			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−400			−400	μA
Low-level output current, I_{OL}				4			8	mA
Count frequency, f_{count} (see Figure 1)	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	30			30			
Reset inactive-state setup time, t_{su}		25			25			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†			SN54LS90 SN54LS92			SN74LS90 SN74LS92			UNIT
						MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage					2			2			V
V_{IL}	Low-level input voltage							0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL}max,	V_{IH} = 2 V, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V,	I_{OL} = 4 mA¶		0.25	0.4		0.25	0.4	V
					I_{OL} = 8 mA¶					0.35	0.5	
I_I	Input current at maximum input voltage	Any reset	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
		CKA	V_{CC} = MAX,	V_I = 5.5 V				0.2			0.2	
		CKB						0.4			0.4	
I_{IH}	High-level input current	Any reset	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
		CKA						40			40	
		CKB						80			80	
I_{IL}	Low-level input current	Any reset	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
		CKA						−2.4			−2.4	
		CKB						−3.2			−3.2	
I_{OS}	Short-circuit output current§		V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX,	See Note 3	'LS90		9	15		9	15	mA
					'LS92		9	15		9	15	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
¶Q_A outputs are tested at specified I_{OL} plus the limit value of I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: I_{CC} is measured with all outputs open, both R_O inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†			SN54LS93			SN74LS93			UNIT
						MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage					2			2			V
V_{IL}	Low-level input voltage							0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max	V_{IH} = 2 V,	I_{OL} = 4 mA¶		0.25	0.4		0.25	0.4	V
					I_{OL} = 8 mA¶					0.35	0.5	
I_I	Input current at maximum input voltage	Any reset	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
		CKA or CKB	V_{CC} = MAX,	V_I = 5.5 V				0.2			0.2	
I_{IH}	High-level input current	Any reset	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
		CKA or CKB						40			80	
I_{IL}	Low-level input current	Any reset	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
		CKA						−2.4			−2.4	
		CKB						−1.6			−1.6	
I_{OS}	Short-circuit output current§		V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX,	See Note 3			9	15		9	15	mA

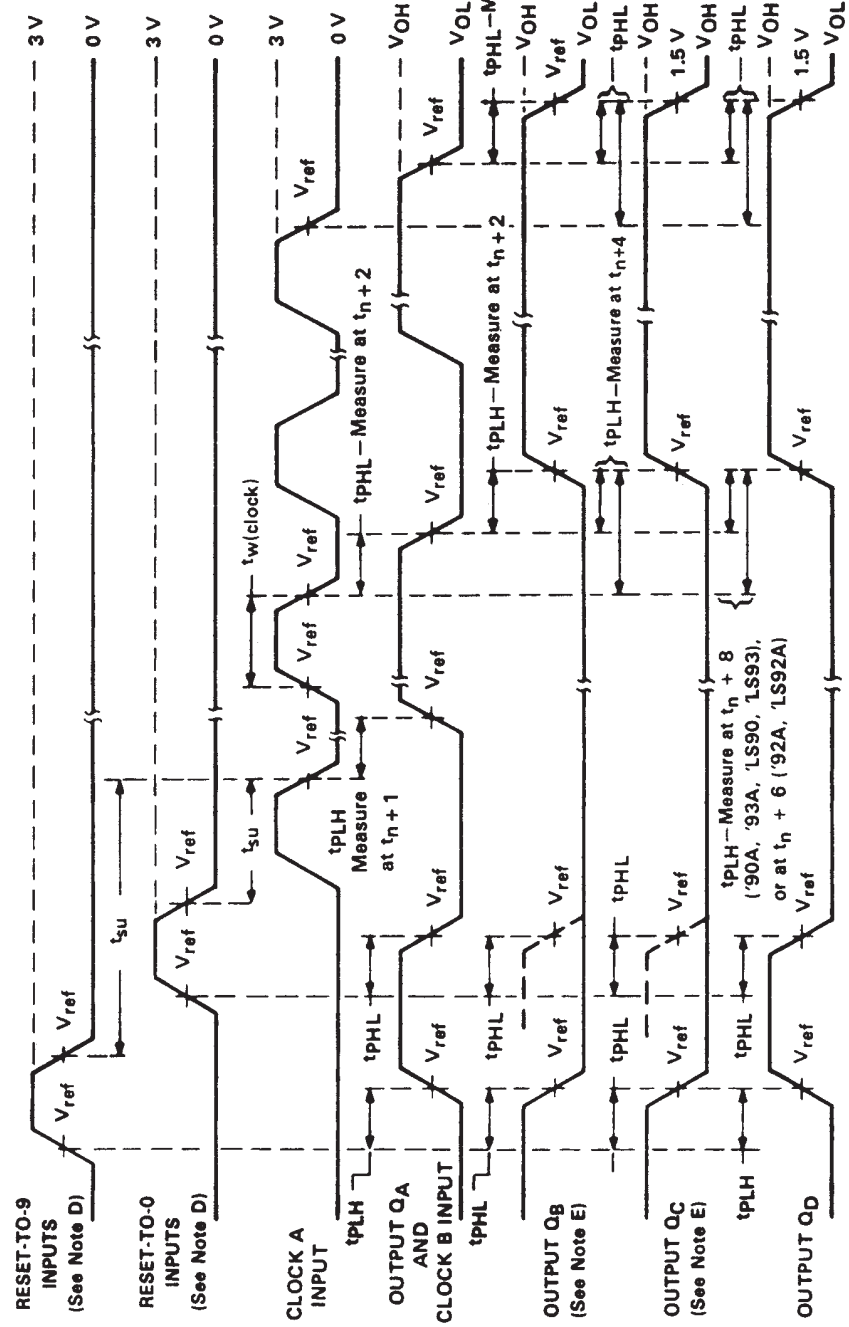
†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
¶Q_A outputs are tested at specified I_{OL} plus the limit value for I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.
NOTE 3: I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER#	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS90			'LS92			'LS93			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
f_{max}	CKA	Q_A	C_L = 15 pF, R_L = 2 kΩ, See Figure 1	32	42		32	42		32	42		MHz
	CKB	Q_B		16			16			16			
t_{PLH}	CKA	Q_A			10	16		10	16		10	16	ns
t_{PHL}					12	18		12	18		12	18	
t_{PLH}	CKA	Q_D			32	48		32	48		46	70	ns
t_{PHL}					34	50		34	50		46	70	
t_{PLH}	CKB	Q_B			10	16		10	16		10	16	ns
t_{PHL}					14	21		14	21		14	21	
t_{PLH}	CKB	Q_C			21	32		10	16		21	32	ns
t_{PHL}					23	35		14	21		23	35	
t_{PLH}	CKB	Q_D			21	32		21	32		34	51	ns
t_{PHL}					23	35		23	35		34	51	
t_{PHL}	Set-to-0	Any			26	40		26	40		26	40	ns
t_{PLH}	Set-to-9	Q_A, Q_D			20	30							ns
t_{PHL}		Q_B, Q_C			26	40							

#f_{max} = maximum count frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output

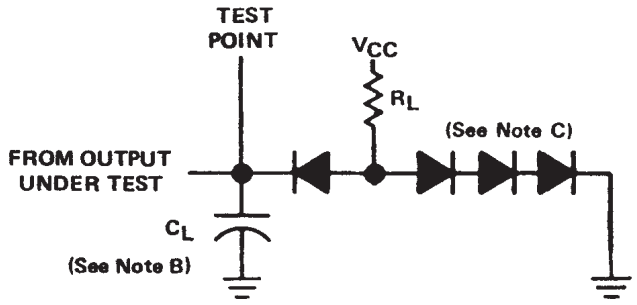
PARAMETER MEASUREMENT INFORMATION



NOTES: A. Input pulses are supplied by a generator having the following characteristics:
for '90A, '92A, '93A, $t_r \le 5$ ns, $t_f \le 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms;
for 'LS90, 'LS92, 'LS93, $t_r \le 15$ ns, $t_f \le 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms.
B. C_L includes probe and jig capacitance.
C. All diodes are 1N3064 or equivalent.
D. Each reset input is tested separately with the other reset at 4.5 V.
E. Reference waveforms are shown with dashed lines.
F. For '90A, '92A, and '93A; V_{ref} = 1.5 V. For 'LS90, 'LS92, and 'LS93; V_{ref} = 1.3 V.

FIGURE 1A

PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

NOTES: A. Input pulses are supplied by a generator having the following characteristics:
for '90A, '92A, '93A, $t_r \leq 5$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms;
for 'LS90, 'LS92, 'LS93, $t_r \leq 15$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms.
B. C_L includes probe and jig capacitance.
C. All diodes are 1N3064 or equivalent.
D. Each reset input is tested separately with the other reset at 4.5 V.
E. Reference waveforms are shown with dashed lines.
F. For '90A, '92A, and '93A; V_{ref} = 1.5 V. For 'LS90, 'LS92, and 'LS93; V_{ref} = 1.3 V.

FIGURE 1B

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SN54LS138, SN54S138, SN74LS138, SN74S138A
3-LINE TO 8-LINE DECODERS/DEMULTIPLEXERS

SDLS014

DECEMBER 1972—REVISED MARCH 1988

- **Designed Specifically for High-Speed:**
  Memory Decoders
  Data Transmission Systems
- **3 Enable Inputs to Simplify Cascading and/or Data Reception**
- **Schottky-Clamped for High Performance**

description

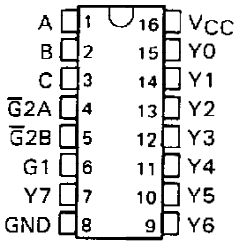
These Schottky-clamped TTL MSI circuits are designed to be used in high-performance memory decoding or data-routing applications requiring very short propagation delay times. In high-performance memory systems, these docoders can be used to minimize the effects of system decoding. When employed with high-speed memories utilizing a fast enable circuit, the delay times of these decoders and the enable time of the memory are usually less than the typical access time of the memory. This means that the effective system delay introduced by the Schottky-clamped system decoder is negligible.

The 'LS138, SN54S138, and SN74S138A decode one of eight lines dependent on the conditions at the three binary select inputs and the three enable inputs. Two active-low and one active-high enable inputs reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented without external inverters and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications.

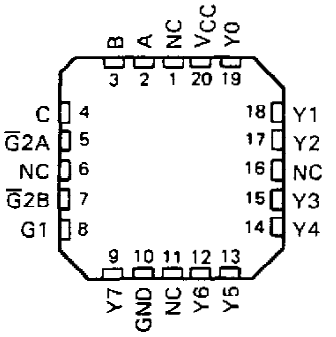
All of these decoder/demultiplexers feature fully buffered inputs, each of which represents only one normalized load to its driving circuit. All inputs are clamped with high-performance Schottky diodes to suppress line-ringing and to simplify system design.

The SN54LS138 and SN54S138 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN74LS138 and SN74S138A are characterized for operation from 0°C to 70°C.

SN54LS138, SN54S138 . . . J OR W PACKAGE
SN74LS138, SN74S138A . . . D OR N PACKAGE
(TOP VIEW)

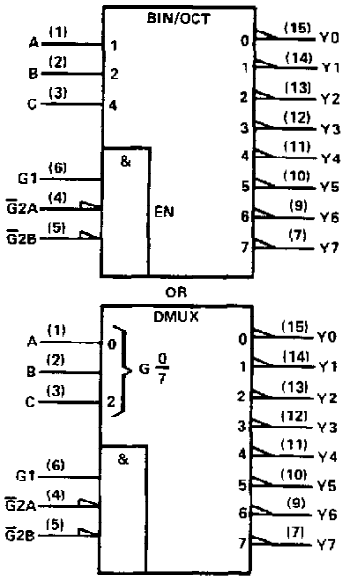


SN54LS138, SN54S138 . . . FK PACKAGE
(TOP VIEW)



NC—No internal connection

logic symbols†



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

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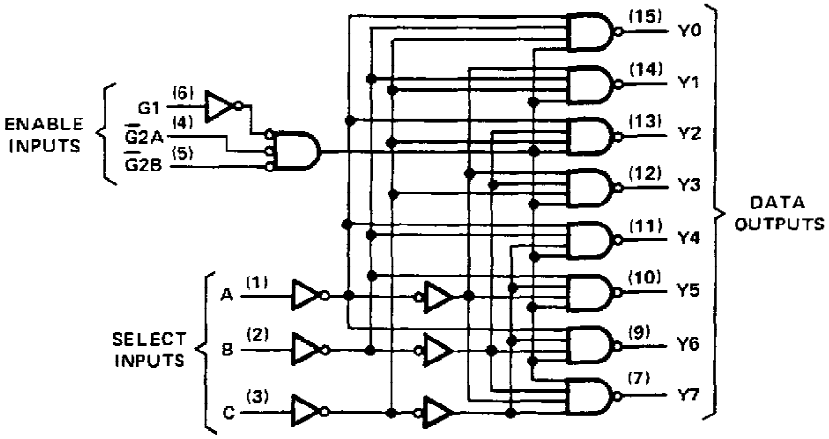
logic diagram and function table

'LS138, SN54S138, SN74S138A



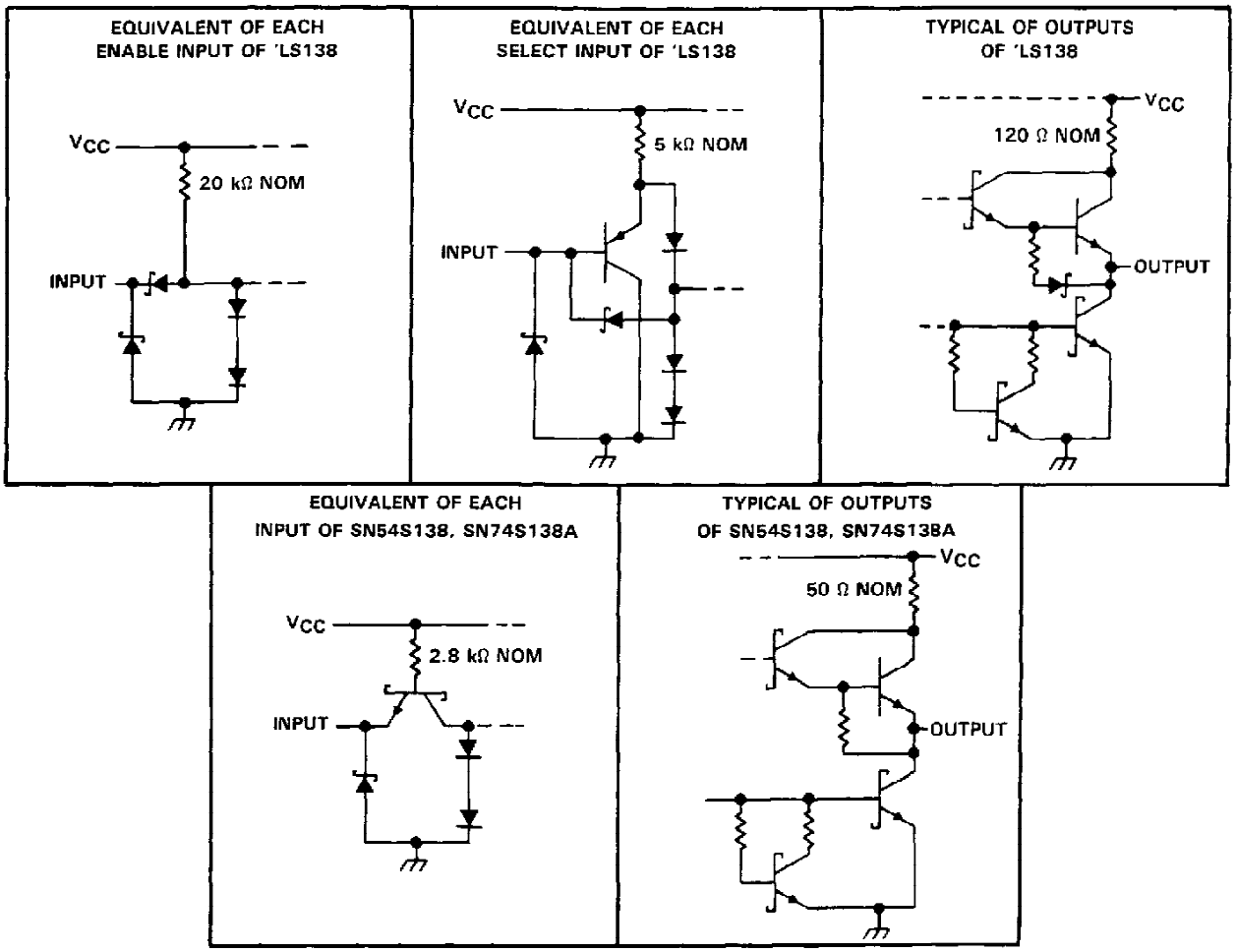
Pin numbers shown are for D, J, N, and W packages.

'LS138, SN54138, SN74S138A
FUNCTION TABLE

INPUTS					OUTPUTS							
ENABLE		SELECT										
G1	$\overline{G}$2*	C	B	A	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	H	X	X	X	H	H	H	H	H	H	H	H
L	X	X	X	X	H	H	H	H	H	H	H	H
H	L	L	L	L	L	H	H	H	H	H	H	H
H	L	L	L	H	H	L	H	H	H	H	H	H
H	L	L	H	L	H	H	L	H	H	H	H	H
H	L	L	H	H	H	H	H	L	H	H	H	H
H	L	H	L	L	H	H	H	H	L	H	H	H
H	L	H	L	H	H	H	H	H	H	L	H	H
H	L	H	H	L	H	H	H	H	H	H	L	H
H	L	H	H	H	H	H	H	H	H	H	H	L

*$\overline{G}2 = \overline{G}2A + \overline{G}2B$
H = high level, L = low level, X = irrelevant

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Operating free-air temperature range: SN54LS138, SN54S138 . . . . . −55°C to 125°C
SN74LS138, SN74S138A . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS138			SN74LS138			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54LS138			SN74LS138			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = −18 mA				−1.5			−1.5	V
V_{OH}	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX, I_{OH} = −0.4 mA		2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = MAX, V_I = 7 V				0.1			0.1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.7 V				20			20	μA
I_{IL}	V_{CC} = MAX, V_I = 0.4 V	Enable			−0.4			−0.4	mA
		A, B, C			−0.2			−0.2	
I_{OS}§	V_{CC} = MAX		−20		100	−20		−100	mA
I_{CC}	V_{CC} = MAX, Outputs enabled and open			6.3	10		6.3	10	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short-circuit test should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	LEVELS OF DELAY	TEST CONDITIONS	SN54LS138 SN74LS138			UNIT
					MIN	TYP	MAX	
t_{PLH}	Binary Select	Any	2	R_L = 2 kΩ, C_L = 15 pF, See Note 2		11	20	ns
t_{PHL}						18	41	ns
t_{PLH}			3			21	27	ns
t_{PHL}						20	39	ns
t_{PLH}	Enable	Any	2			12	18	ns
t_{PHL}						20	32	ns
t_{PLH}			3			14	26	ns
t_{PHL}						13	38	ns

¶ t_{PLH} = propagation delay time, low-to-high-level ouput
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Operating free-air temperature range: SN54S138 . . . . . −55°C to 125°C
SN74S138A . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54S138			SN74S138A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−1			−1	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54S138 SN74S138A			UNIT
			MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = −18 mA				−1.2	V
V_{OH}	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −1 mA	SN54S'	2.5	3.4		V
		SN74S'	2.7	3.4		
V_{OL}	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 20 mA				0.5	V
I_I	V_{CC} = MAX, V_I = 5.5 V				1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.7 V				50	μA
I_{IL}	V_{CC} = MAX, V_I = 0.5 V				−2	mA
I_{OS}§	V_{CC} = MAX		−40		−100	mA
I_{CC}	V_{CC} = MAX, Outputs enabled and open			49	74	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short circuit test should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	LEVELS OF DELAY	TEST CONDITIONS	SN54S138 SN74S138A			UNIT
					MIN	TYP	MAX	
t_{PLH}	Binary Select	Any	2	R_L = 280 Ω, C_L = 15 pF, See Note 2		4.5	7	ns
t_{PHL}						7	10.5	ns
t_{PLH}			3			7.5	12	ns
t_{PHL}						8	12	ns
t_{PLH}	Enable	Any	2			5	8	ns
t_{PHL}						7	11	ns
t_{PLH}			3			7	11	ns
t_{PHL}						7	11	ns

†t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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FAIRCHILD SEMICONDUCTOR™

August 1986
Revised March 2000

DM74LS151
1-of-8 Line Data Selector/Multiplexer

General Description

This data selector/multiplexer contains full on-chip decoding to select the desired data source. The DM74LS151 selects one-of-eight data sources. The DM74LS151 has a strobe input which must be at a low logic level to enable these devices. A high level at the strobe forces the W output HIGH, and the Y output LOW.

The DM74LS151 features complementary W and Y outputs.

Features

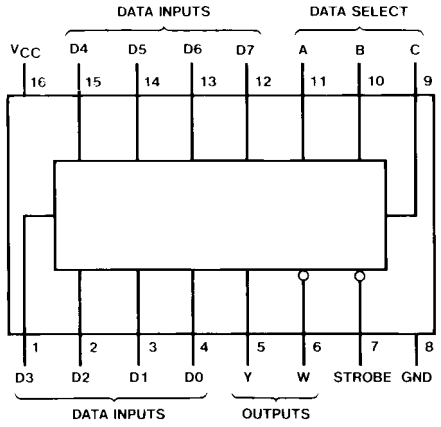
- Select one-of-eight data lines
- Performs parallel-to-serial conversion
- Permits multiplexing from N lines to one line
- Also for use as Boolean function generator
- Typical average propagation delay time data input to W output 12.5 ns
- Typical power dissipation 30 mW

Ordering Code:

Order Number	Package Number	Package Description
DM74LS151M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74LS151SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74LS151N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

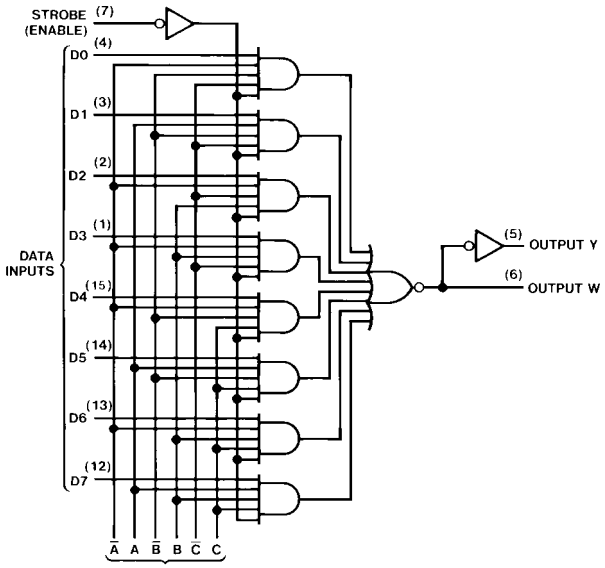


Truth Table

Inputs				Outputs	
Select			Strobe	Y	W
C	B	A	S		
X	X	X	H	L	H
L	L	L	L	D0	$\overline{D0}$
L	L	H	L	D1	$\overline{D1}$
L	H	L	L	D2	$\overline{D2}$
L	H	H	L	D3	$\overline{D3}$
H	L	L	L	D4	$\overline{D4}$
H	L	H	L	D5	$\overline{D5}$
H	H	L	L	D6	$\overline{D6}$
H	H	H	L	D7	$\overline{D7}$

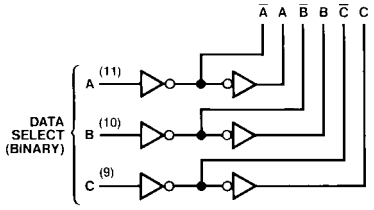
H = HIGH Level
L = LOW Level
X = Don't Care
D0, D1...D7 = the level of the respective D input

Logic Diagrams



See Address Buffers

Address Buffers



Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.4	mA
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max, V_{IH} = Min	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IL} = Max, V_{IH} = Min		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.4	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−20		−100	mA
I_{CC}	Supply Current	V_{CC} = Max (Note 4)		6	10	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

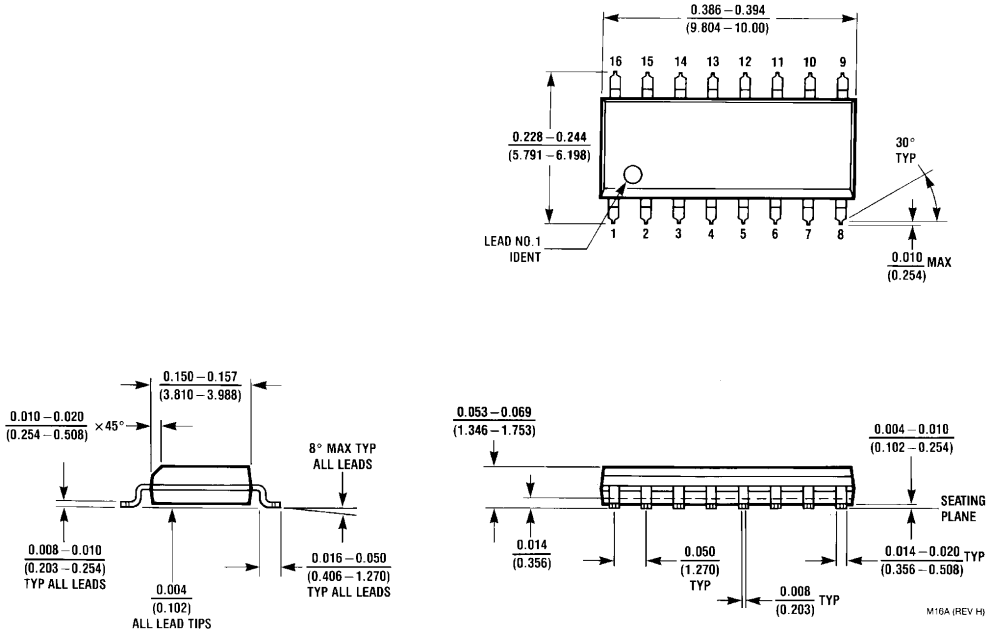
Note 4: I_{CC} is measured with all outputs OPEN, strobe and data select inputs at 4.5V, and all other inputs OPEN.

Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

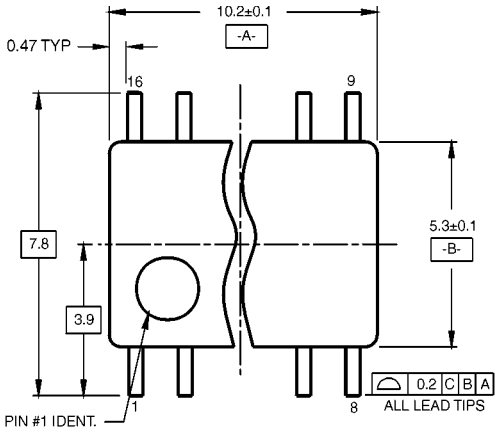
Symbol	Parameter	From (Input) To (output)	R_L = 2 kΩ				Units
			C_L = 15 pF		C_L = 50 pF		
			Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Select (4 Levels) to Y		43		46	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Select (4 Levels) to Y		30		36	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Select (3 Levels) to W		23		25	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Select (3 Levels) to W		32		40	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Strobe to Y		42		44	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Strobe to Y		32		40	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Strobe to W		24		27	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Strobe to W		30		36	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	D0 thru D7 to Y		32		35	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	D0 thru D7 to Y		26		33	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	D0 thru D7 to W		21		25	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	D0 thru D7 to W		20		27	ns

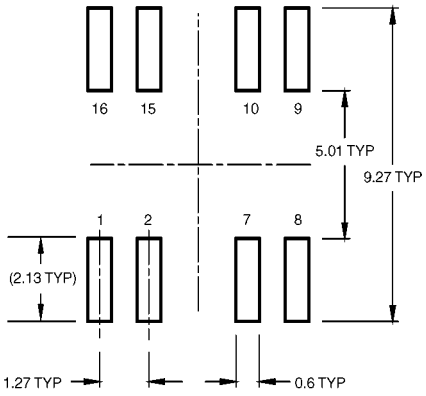
Physical Dimensions inches (millimeters) unless otherwise noted



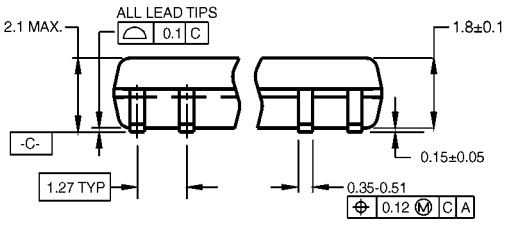
16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A

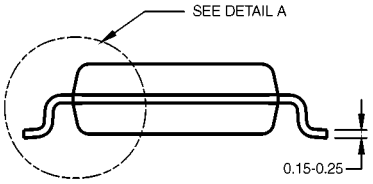
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





LAND PATTERN RECOMMENDATION





DIMENSIONS ARE IN MILLIMETERS

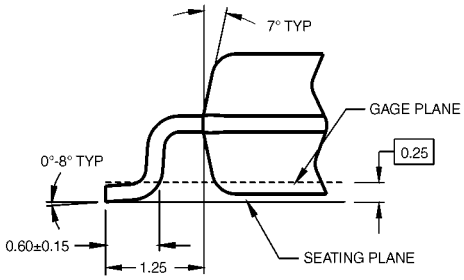
NOTES:

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.

B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

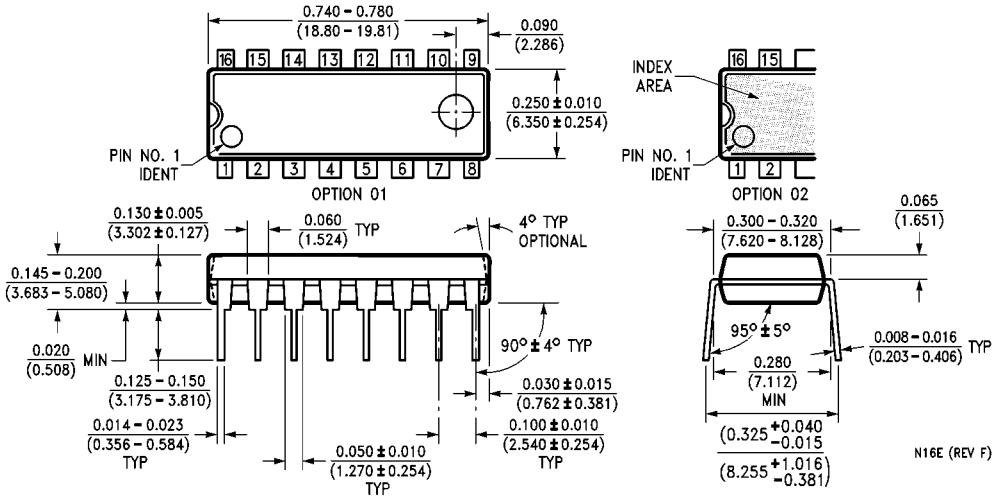
M16DRevB1



DETAIL A

16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M16D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N16E

FAIRCHILD SEMICONDUCTOR™

August 1986
Revised March 2000

DM74LS154
4-Line to 16-Line Decoder/Demultiplexer

General Description

Each of these 4-line-to-16-line decoders utilizes TTL circuitry to decode four binary-coded inputs into one of sixteen mutually exclusive outputs when both the strobe inputs, G1 and G2, are LOW. The demultiplexing function is performed by using the 4 input lines to address the output line, passing data from one of the strobe inputs with the other strobe input LOW. When either strobe input is HIGH, all outputs are HIGH. These demultiplexers are ideally suited for implementing high-performance memory decoders. All inputs are buffered and input clamping diodes are provided to minimize transmission-line effects and thereby simplify system design.

Features

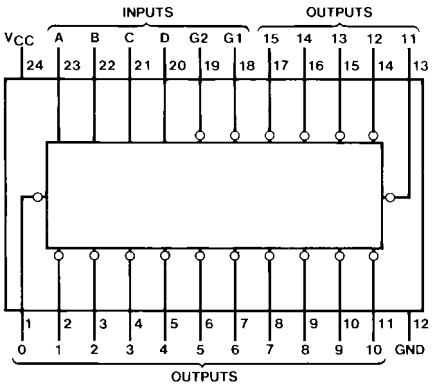
- Decodes 4 binary-coded inputs into one of 16 mutually exclusive outputs
- Performs the demultiplexing function by distributing data from one input line to any one of 16 outputs
- Input clamping diodes simplify system design
- High fan-out, low-impedance, totem-pole outputs
- Typical propagation delay
  - 3 levels of logic 23 ns
  - Strobe 19 ns
- Typical power dissipation 45 mW

Ordering Code:

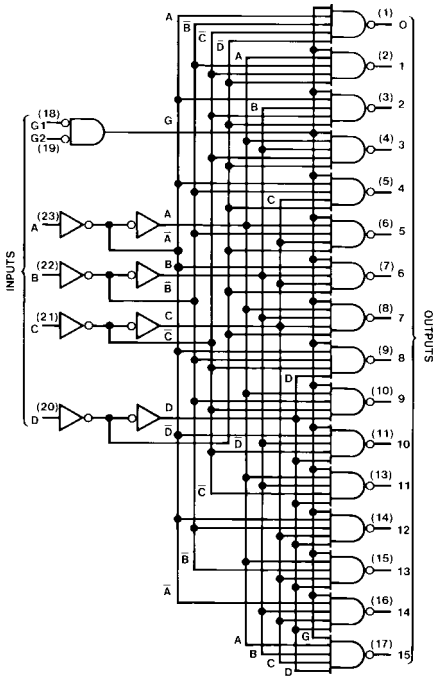
Order Number	Package Number	Package Description
DM74LS154WM	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
DM74LS154N	N24A	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.600 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Logic Diagram



Function Table

Inputs						Outputs															
G1	G2	D	C	B	A	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
L	L	L	L	L	L	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
L	L	L	L	L	H	H	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H
L	L	L	L	H	L	H	H	L	H	H	H	H	H	H	H	H	H	H	H	H	H
L	L	L	L	H	H	H	H	H	L	H	H	H	H	H	H	H	H	H	H	H	H
L	L	L	H	L	L	H	H	H	H	L	H	H	H	H	H	H	H	H	H	H	H
L	L	L	H	L	H	H	H	H	H	H	L	H	H	H	H	H	H	H	H	H	H
L	L	L	H	H	L	H	H	H	H	H	H	L	H	H	H	H	H	H	H	H	H
L	L	L	H	H	H	H	H	H	H	H	H	H	L	H	H	H	H	H	H	H	H
L	L	H	L	L	L	H	H	H	H	H	H	H	H	L	H	H	H	H	H	H	H
L	L	H	L	L	H	H	H	H	H	H	H	H	H	H	L	H	H	H	H	H	H
L	L	H	L	H	L	H	H	H	H	H	H	H	H	H	H	L	H	H	H	H	H
L	L	H	L	H	H	H	H	H	H	H	H	H	H	H	H	H	L	H	H	H	H
L	L	H	H	L	L	H	H	H	H	H	H	H	H	H	H	H	H	L	H	H	H
L	L	H	H	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	L	H	H
L	L	H	H	H	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	L	H
L	L	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	L
L	H	X	X	X	X	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
H	L	X	X	X	X	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
H	H	X	X	X	X	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H

H = HIGH Level
L = Low Level
X = Don't Care

Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.4	mA
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max, V_{IL} = Max, V_{IH} = Min	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IL} = Max, V_{IH} = Min		0.25	0.4	V
				0.35	0.5	
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.4	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−20		−100	mA
I_{CC}	Supply Current	V_{CC} = Max (Note 4)		9	14	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

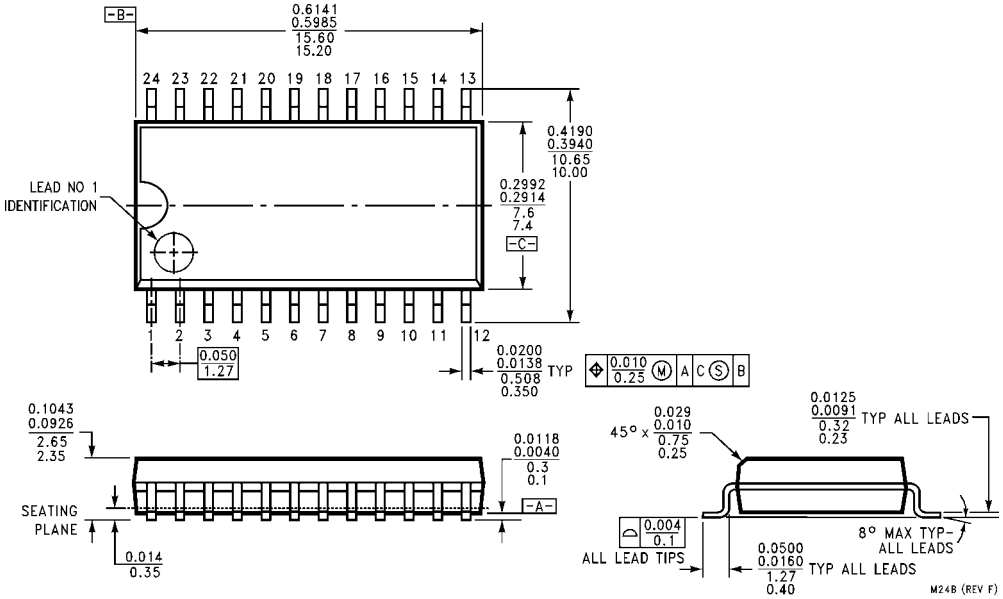
Note 4: I_{CC} is measured with all outputs OPEN and all inputs GROUNDED.

Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

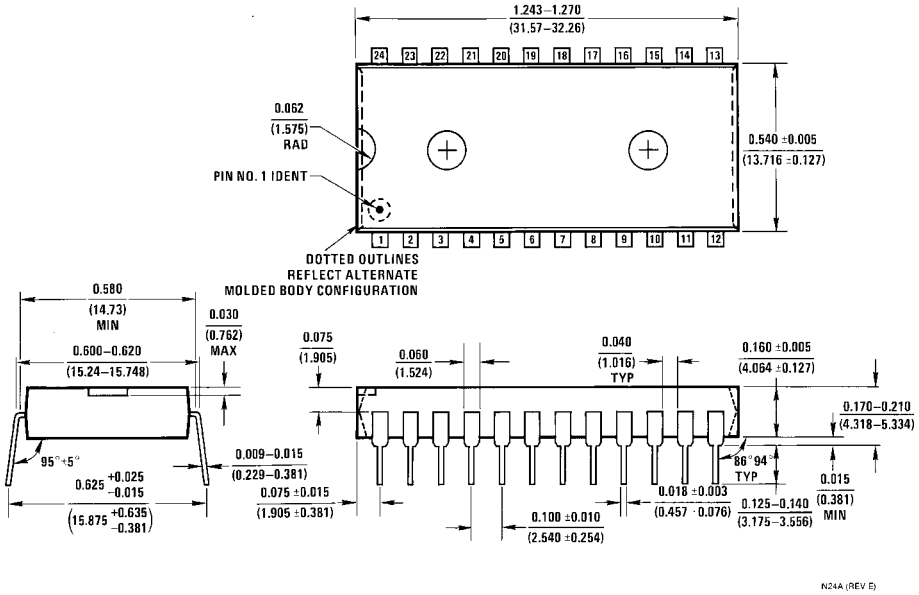
Symbol	Parameter	From (Input) To (Output)	R_L = 2 kΩ				Units
			C_L = 15 pF		C_L = 50 pF		
			Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Data to Output		30		35	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Data to Output		30		35	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Strobe to Output		20		25	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Strobe to Output		25		35	ns

Physical Dimensions inches (millimeters) unless otherwise noted



24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M24B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.600 Wide
Package Number N24A

FAIRCHILD SEMICONDUCTOR®

May 2007

DM74ALS161B, DM74ALS162B, DM74ALS163B Synchronous Four-Bit Counter

Features

- Switching specifications at 50pF
- Switching specifications guaranteed over full temperature and V_{CC} range
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Functionally and pin-for-pin compatible with Schottky and low power Schottky TTL counterpart
- Improved AC performance over Schottky and low power Schottky counterparts
- Synchronously programmable
- Internal look ahead for fast counting
- Carry output for n-bit cascading
- Synchronous counting
- Load control line
- ESD inputs

General Description

These synchronous presettable counters feature an internal carry look ahead for application in high speed counting designs. The DM74ALS162B is a four-bit decade counter, while the DM74ALS161B and DM74ALS163B are four-bit binary counters. The DM74ALS161B clears asynchronously, while the DM74ALS162B and DM74ALS163B clear synchronously. The carry output is decoded to prevent spikes during normal counting mode of operation. Synchronous operation is provided by having all flip-flops clocked simultaneously so that outputs change coincident with each other when so instructed by count enable inputs and internal gating. This mode of operation eliminates the output counting spikes which are normally associated with asynchronous (ripple clock) counters. A buffered clock input triggers the four flip-flops on the rising (positive-going) edge of the clock input waveform.

These counters are fully programmable, that is, the outputs may be preset to either level. As presetting is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with set up data after the next clock pulse regardless of the levels of enable input. LOW-to-HIGH transitions at the load input are perfectly acceptable regardless of the logic levels on the clock or enable inputs.

The DM74ALS161B clear function is asynchronous. A low level at the clear input sets all four of the flip-flop outputs LOW regardless of the levels of clock, load or enable inputs. These two counters are provided with a clear on power-up feature. The DM74ALS162B and DM74ALS163B clear function is synchronous; and a low level at the clear input sets all four of the flip-flop outputs LOW after the next clock pulse, regardless of the levels of enable inputs. This synchronous clear allows the count length to be modified easily, as decoding the maximum count desired can be accomplished with one external NAND gate. The gate output is connected to the clear input to synchronously clear the counter to all low outputs. LOW-to-HIGH transitions at the clear input of the DM74ALS162B and DM74ALS163B are also permissible regardless of the levels of logic on the clock, enable or load inputs.

The carry look ahead circuitry provides for cascading counters for n bit synchronous application without additional gating. Instrumental in accomplishing this function are two count enable inputs (P and T) and a ripple carry output. Both count enable inputs must be HIGH to count. The T input is fed forward to enable the ripple carry output. The ripple carry output thus enabled will produce a high level output pulse with a duration approximately equal to the high level portion of QA output. This high level overflow ripple carry pulse can be used to enable successive cascaded stages. HIGH-to-LOW level transitions at the enable P or T inputs of the DM74ALS161B through DM74ALS163B may occur regardless of the logic level on the clock.

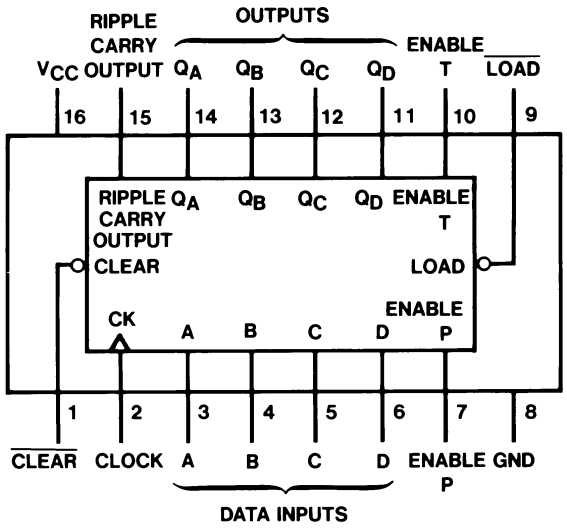
The DM74ALS161B through DM74ALS163B feature a fully independent clock circuit. changes made to control inputs (enable P or T, or load) that will modify the operating mode will have no effect until clocking occurs. The function of the counter (whether enabled, disabled, loading or counting) will be dictated solely by the conditions meeting the stable set-up and hold times.

Ordering Information

Order Number	Package Number	Package Description
DM74ALS161BM	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS162BM	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS162BN	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
DM74ALS163BM	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS163BN	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter “X” to the ordering number.

Connection Diagram



Mode Select Table

$\overline{\text{Clear}}$	$\overline{\text{Load}}$	Enable T	Enable P	Action on the Rising Clock Edge (⌐)
L	X	X	X	Reset (Clear)
H	L	X	X	Load ($P_n \rightarrow Q_n$)
H	H	H	H	Count (Increment)
H	H	L	X	No Change (Hold)
H	H	X	L	No Change (Hold)

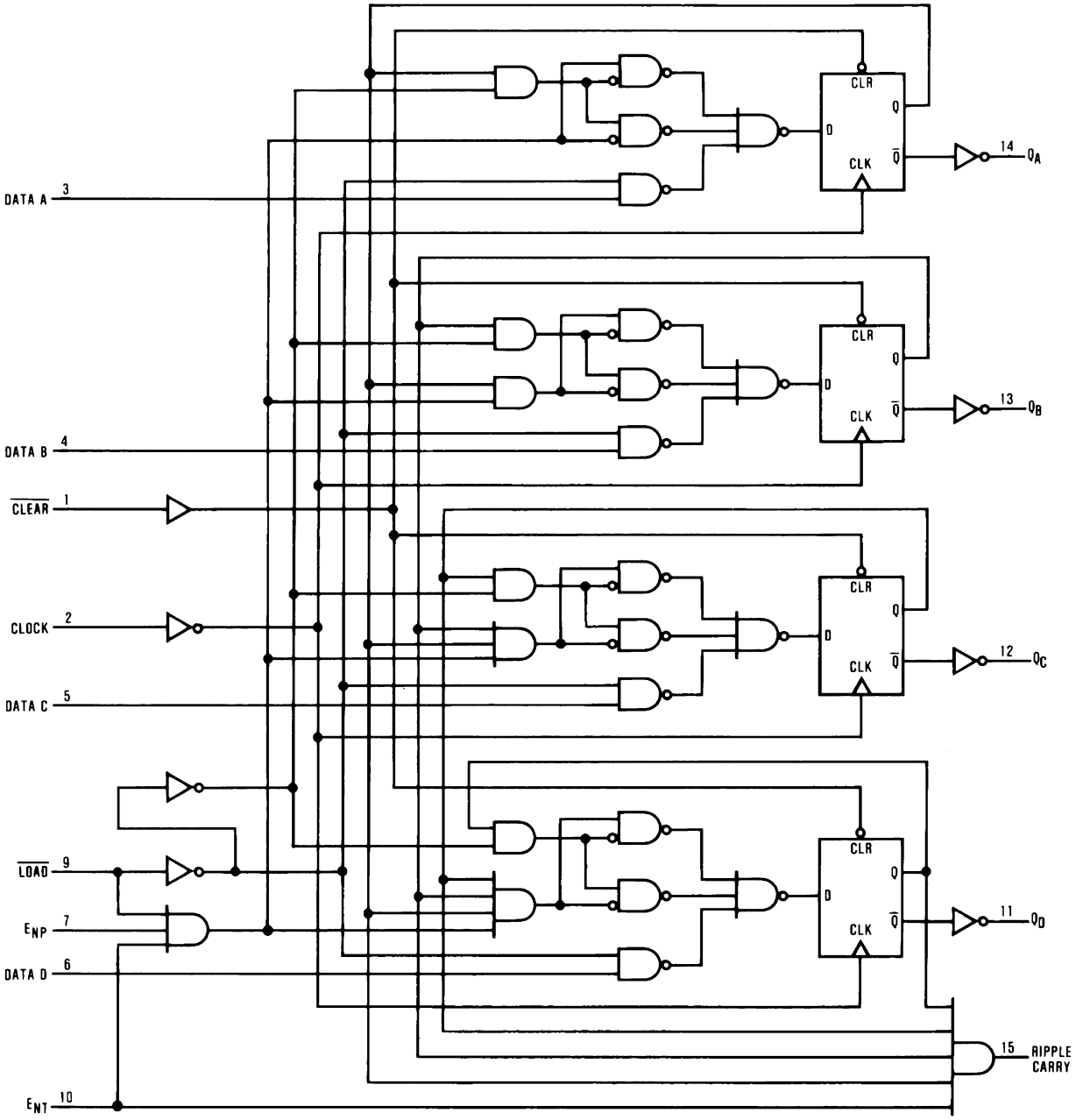
H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

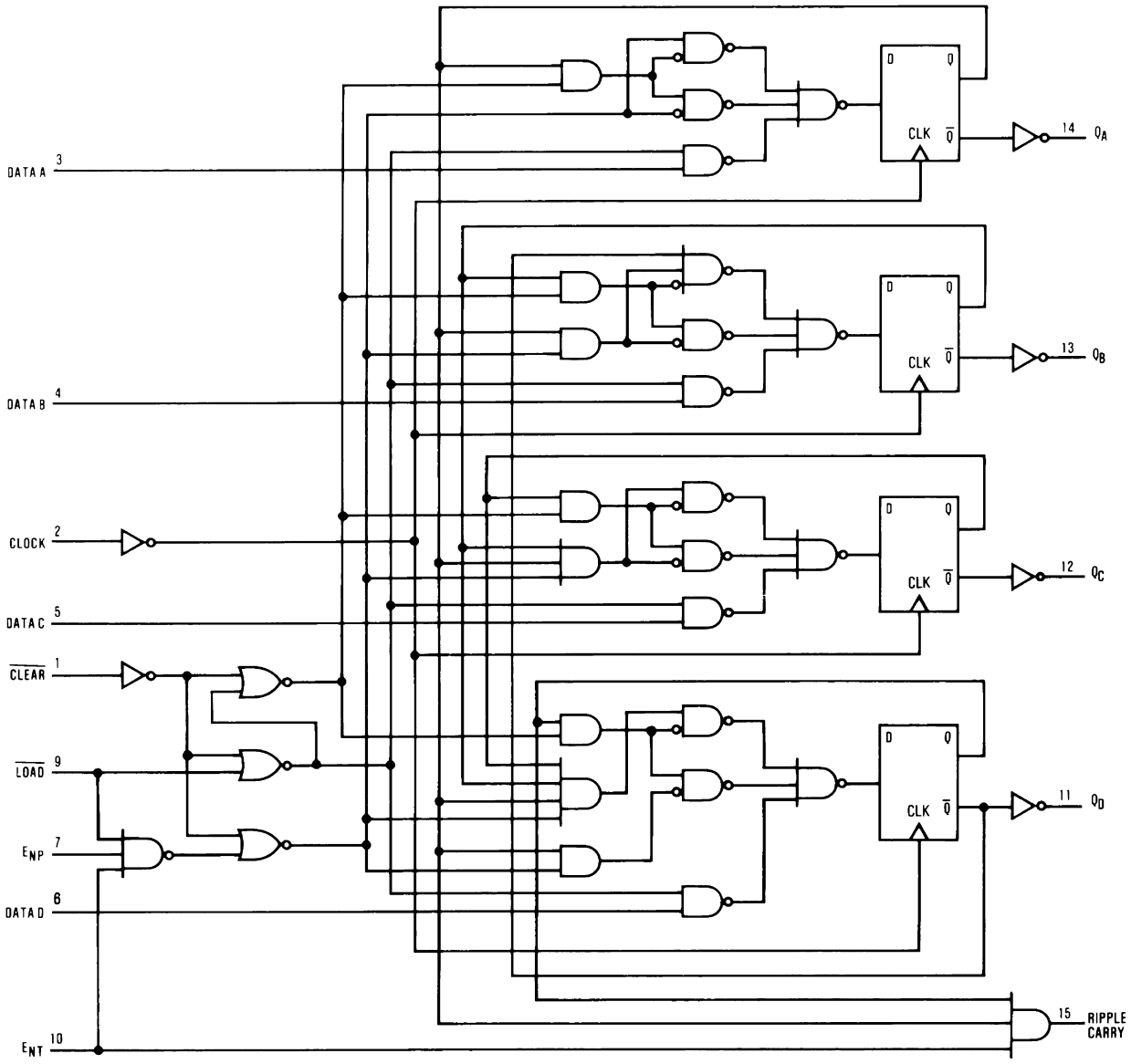
Logic Diagrams

DM74ALS161B



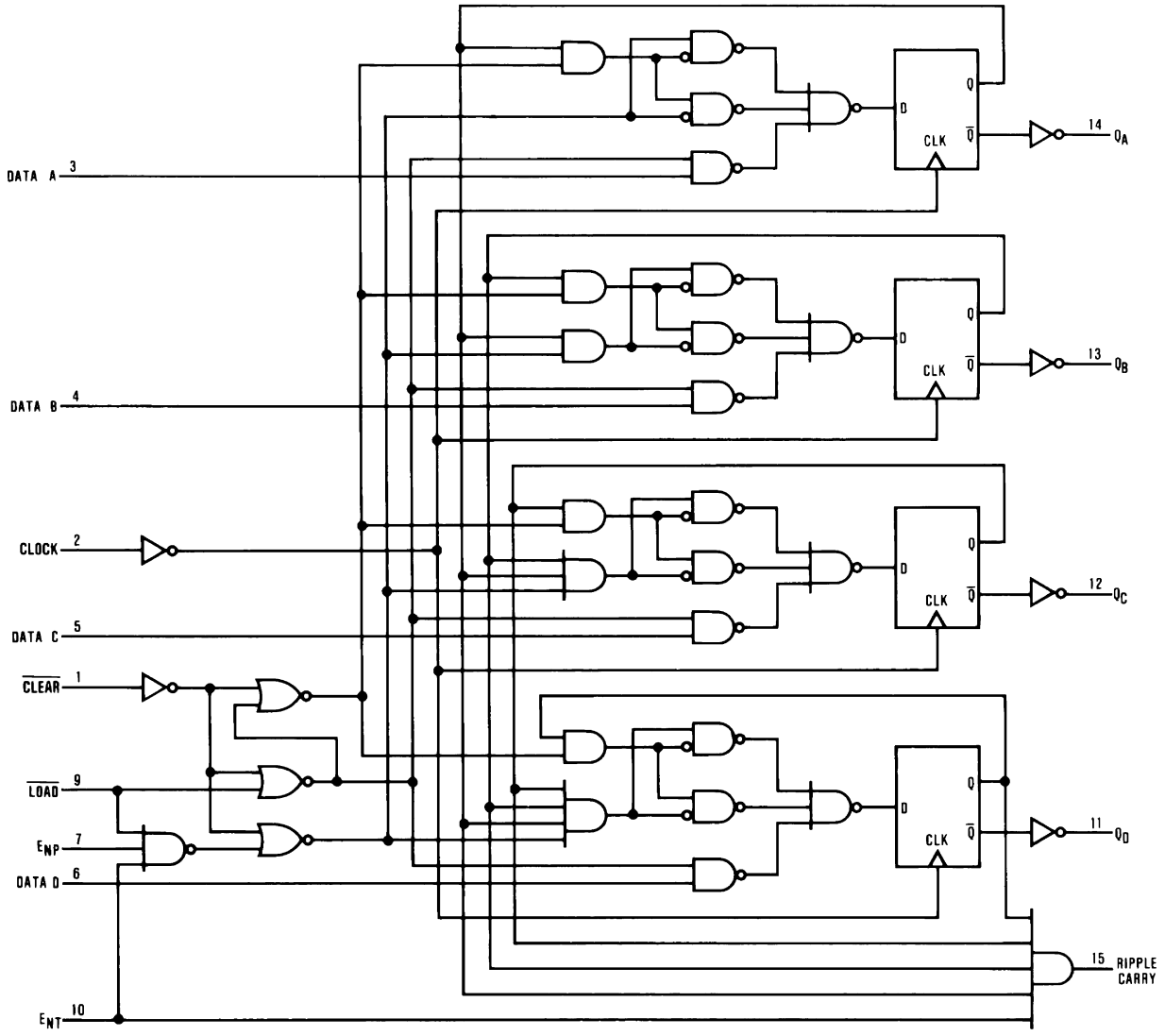
Logic Diagrams (Continued)

DM74ALS162B



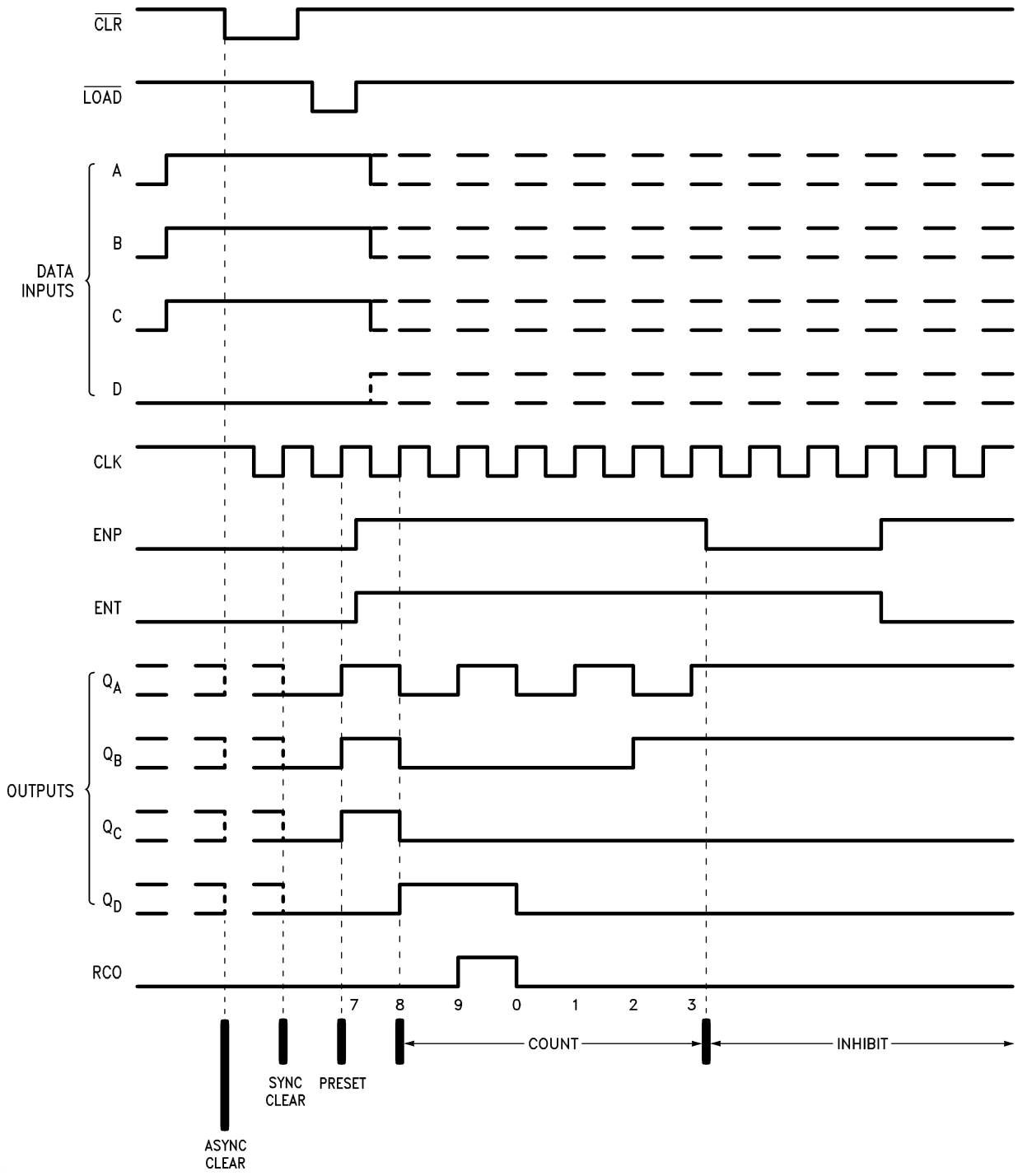
Logic Diagrams (Continued)

DM74ALS163B



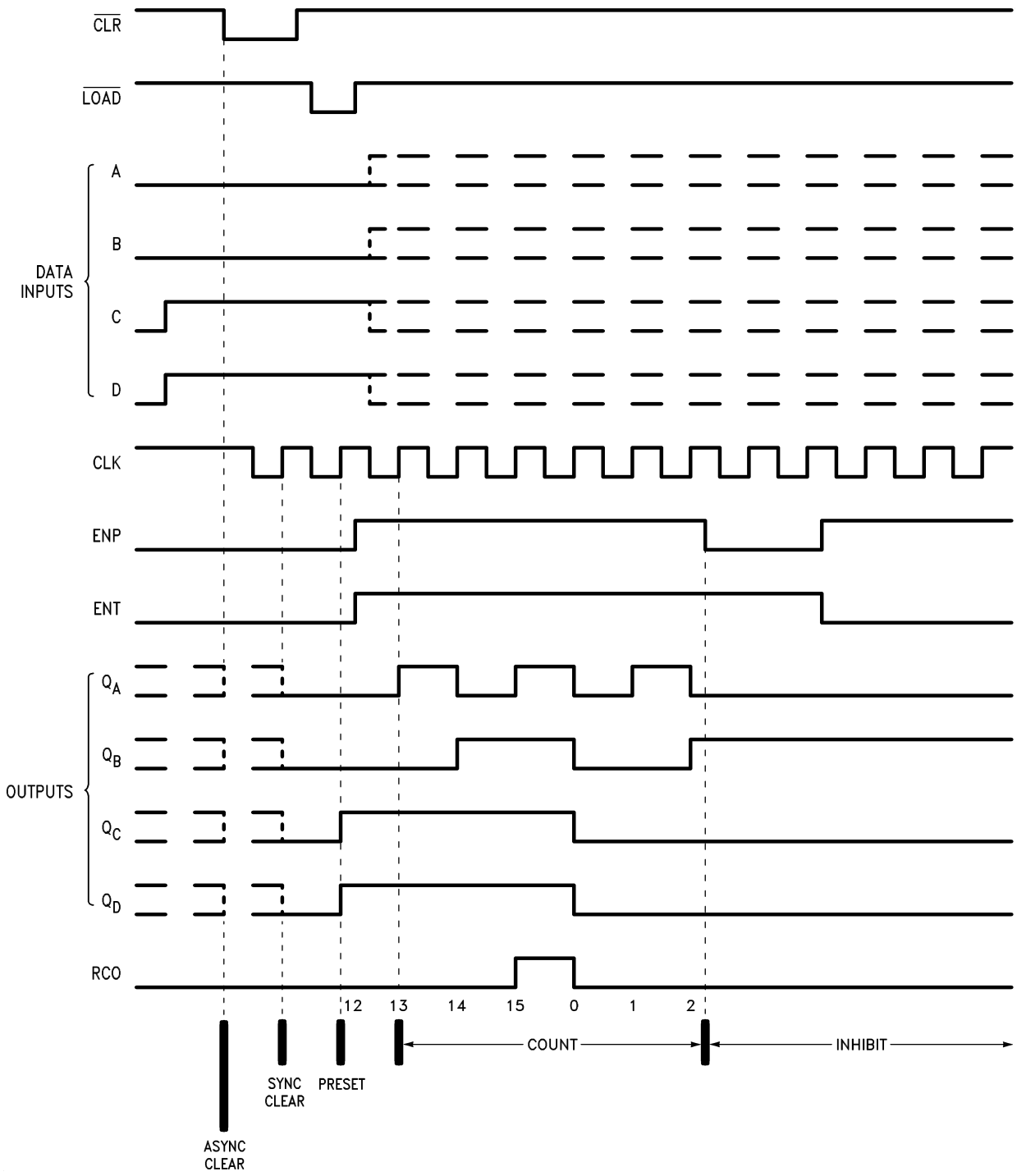
Timing Diagrams

DM74ALS162B



Timing Diagrams (Continued)

DM74ALS161B, DM74ALS163B



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	7V
V_I	Input Voltage	7V
T_A	Operating Free Air Temperature Range	0°C to +70°C
T_{STG}	Storage Temperature Range	–65°C to +150°C
θ_{JA}	Typical Thermal Resistance	
	N Package	78.1°C/W
	M Package	106.8°C/W

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter			Min.	Nom.	Max.	Units
V_{CC}	Supply Voltage			4.5	5	5.5	V
V_{IH}	HIGH Level Input Voltage			2			V
V_{IL}	LOW Level Input Voltage					0.8	V
I_{OH}	HIGH Level Output Current					–0.4	mA
I_{OL}	LOW Level Output Current					8	mA
f_{CLK}	Clock Frequency			0		40	MHz
t_{SETUP}	Setup Time	Data; A, B, C, D		15↑(1)			ns
		En P, En T		15↑(1)			
		Load		15↑(1)			
		$\overline{\text{Clear}}$ (Only for DM74ALS162B and DM74ALS163B)	LOW	15↑(1)			
			HIGH	12↑(1)			
	Setup 1 (Only for 161B)	$\overline{\text{Clear}}$ Inactive		10	4		
t_{HOLD}	Hold Time	Data; A, B, C, D		0↑(1)	–3		ns
		En P, En T		0↑(1)	–3		
		Load		0↑(1)	–4		
		$\overline{\text{Clear}}$ (Only for DM74ALS162B and DM74ALS163B		0↑(1)	–7		
	Hold 0 (Only for 161B)	Clear		0	–4		
t_W	Width of Clock or $\overline{\text{Clear}}$ Pulse	CLK HIGH or LOW		12.5			ns
		DM74ALS161B $\overline{\text{CLR}}$ LOW		15			
	Width of $\overline{\text{Load}}$ Pulse			15			
T_A	Operating Free Air Temperature			0		70	°C

Note:

1. The symbol (↑) indicates that the rising edge of the clock is used as a reference.

Electrical Characteristics

Over recommended operating free air temperature range. All typical values are measured at V_{CC} = 5V, T_A = 25°C.

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Units
V_{IK}	Input Clamp Voltage	V_{CC} = 4.5V, I_I = –18mA				–1.5	V
V_{OH}	HIGH Level Output Voltage	I_{OH} = –0.4mA, V_{CC} = 4.5V to 5.5V		V_{CC} – 2			V
V_{OL}	LOW Level Output Voltage	V_{CC} = 4.5V	I_{OL} = 4mA		0.25	0.4	V
			I_{OL} = 8mA		0.35	0.5	
I_I	Input Current at Max. Input Voltage	V_{CC} = 5.5V, V_{IH} = 7V				0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = 5.5V, V_{IH} = 2.7V				20	µA
I_{IL}	LOW Level Input Current	V_{CC} = 5.5V, V_{IL} = 0.4V				–0.2	mA
I_O	Output Drive Current	V_{CC} = 5.5V, V_O = 2.25V		–30		–112	mA
I_{CC}	Supply Current	V_{CC} = 5.5V			12	21	mA

Switching Characteristics DM74ALS161B

Over recommended operating free air temperature range.

Symbol	Parameter	Conditions	From	To	Min.	Max.	Units
f_{MAX}	Maximum Clock Frequency	V_{CC} = 4.5V to 5.5V, R_L = 500Ω, C_L = 50pF			40		MHz
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output		Clock	Ripple Carry	5	20	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output		Clock	Ripple Carry	5	20	ns
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output		Clock	Any Q	4	15	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output		Clock	Any Q	6	20	ns
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output		En T	Ripple Carry	3	13	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output		En T	Ripple Carry	3	13	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output		Clear	Any Q	8	24	ns
			Clear	Ripple Carry	11	23	

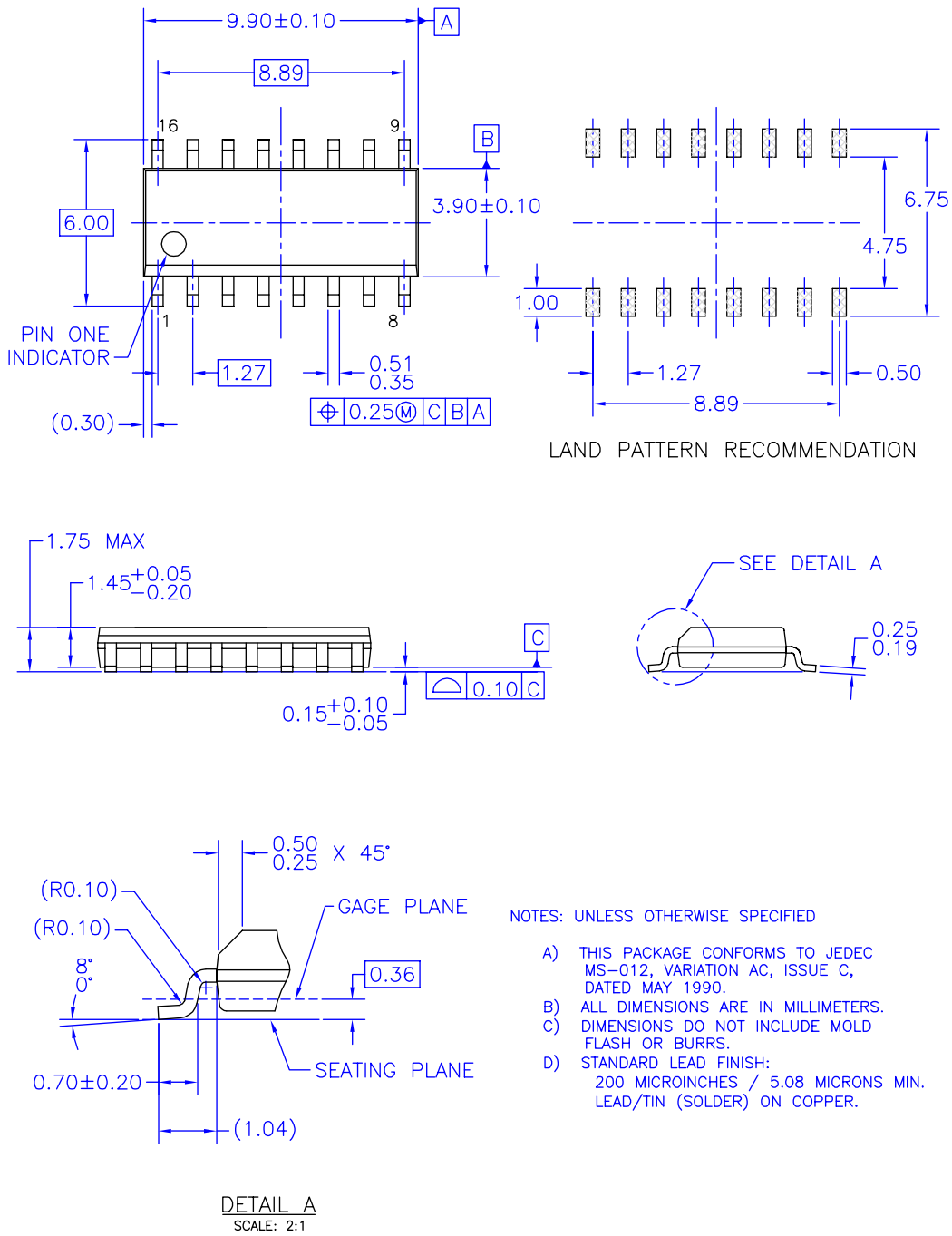
Switching Characteristics DM74ALS162B, DM74ALS163B

Over recommended operating free air temperature range.

Symbol	Parameter	Conditions	From	To	Min.	Max.	Units
f_{MAX}	Maximum Clock Frequency	V_{CC} = 4.5V to 5.5V, R_L = 500Ω, C_L = 50pF, T_A = Min. to Max.			40		MHz
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output		Clock	Ripple Carry	5	20	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output		Clock	Ripple Carry	5	20	ns
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output		Clock	Any Q	4	15	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output		Clock	Any Q	6	20	ns
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output		En T	Ripple Carry	3	13	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output		En T	Ripple Carry	3	13	ns

Physical Dimensions

Dimensions are in millimeters unless otherwise noted.



NOTES: UNLESS OTHERWISE SPECIFIED

A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AC, ISSUE C, DATED MAY 1990.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
D) STANDARD LEAD FINISH: 200 MICROINCHES / 5.08 MICRONS MIN. LEAD/TIN (SOLDER) ON COPPER.

Figure 1. 16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M16A

Physical Dimensions (Continued)

Dimensions are in inches (millimeters) unless otherwise noted.

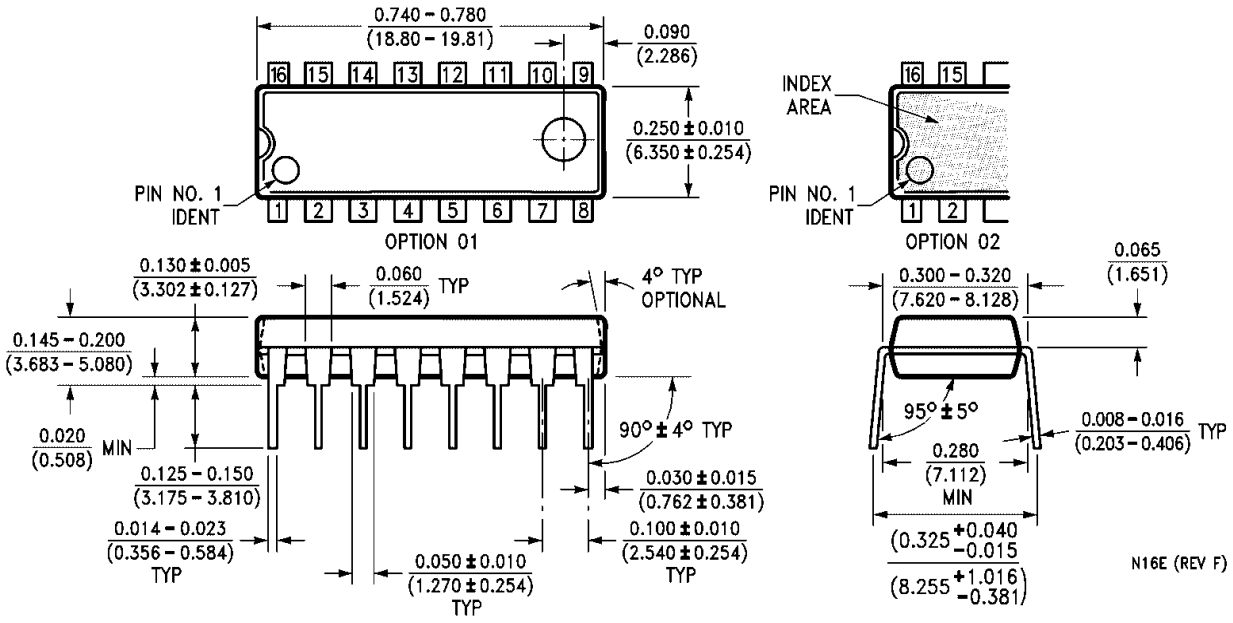


Figure 2. 16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N16E

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SPM®
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SuperSOT™-6
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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. I28

FAIRCHILD SEMICONDUCTOR®

May 2007

DM74ALS174, DM74ALS175
Hex/Quad D-Type Flip-Flops with Clear

Features

- Advanced oxide-isolated ion-implanted Schottky TTL process
- Pin and functional compatible with LS family counterpart
- Typical clock frequency maximum is 80MHz
- Switching performance guaranteed over full temperature and V_{CC} supply range

General Description

These positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic. Both have an asynchronous clear input, and the quad (DM74ALS175) version features complementary outputs from each flip-flop.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the HIGH or LOW level, the D input signal has no effect at the output.

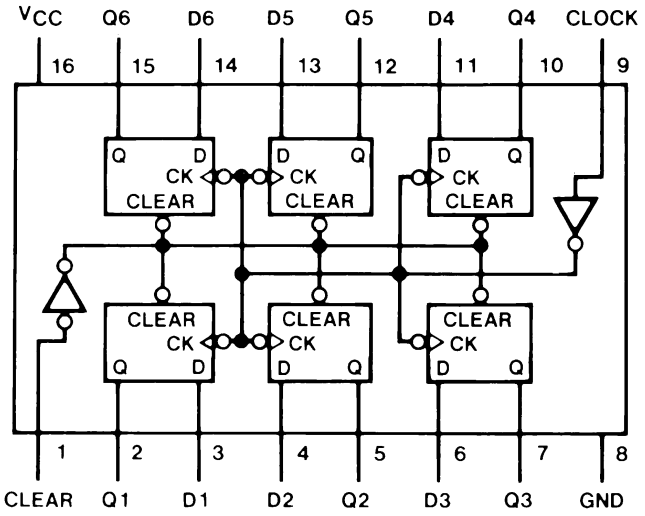
Ordering Information

Ordering Code	Package Number	Package Description
DM74ALS174M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS174SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS175M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS175SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS175N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

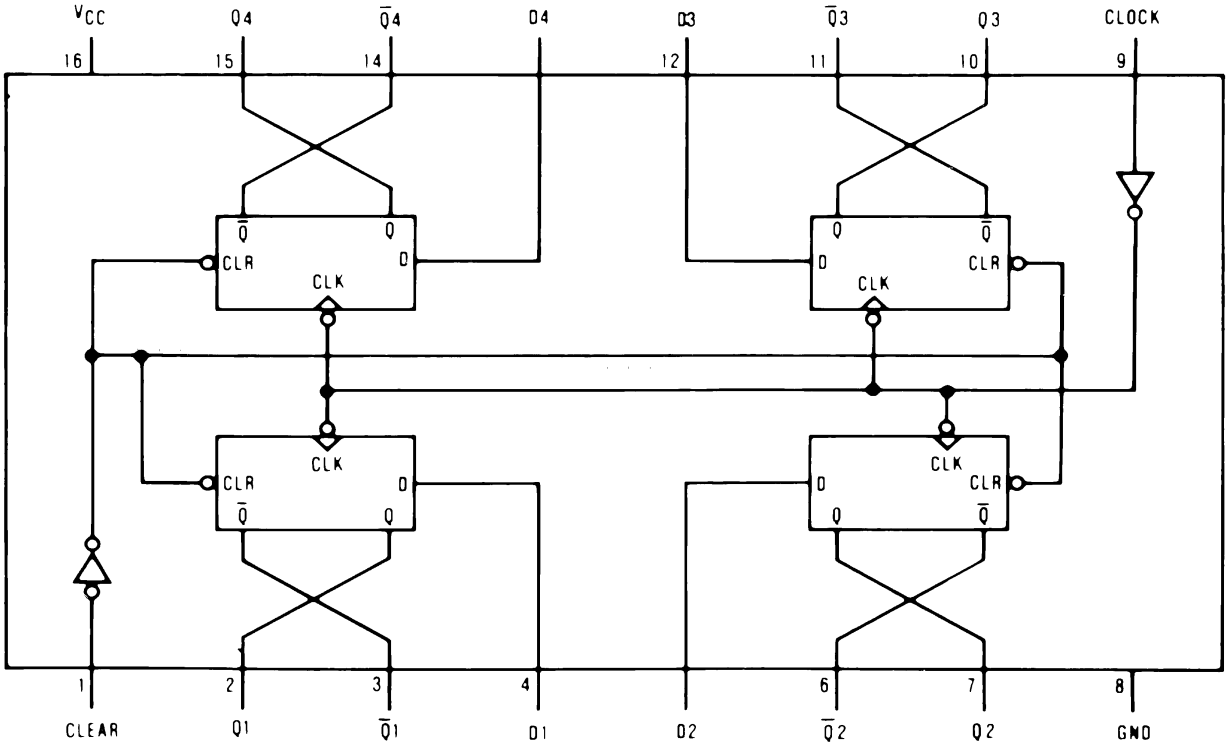
Devices also available in Tape and Reel. Specify by appending the suffix letter “X” to the ordering number.

Connection Diagrams

DM74ALS174



DM74ALS175



Function Table

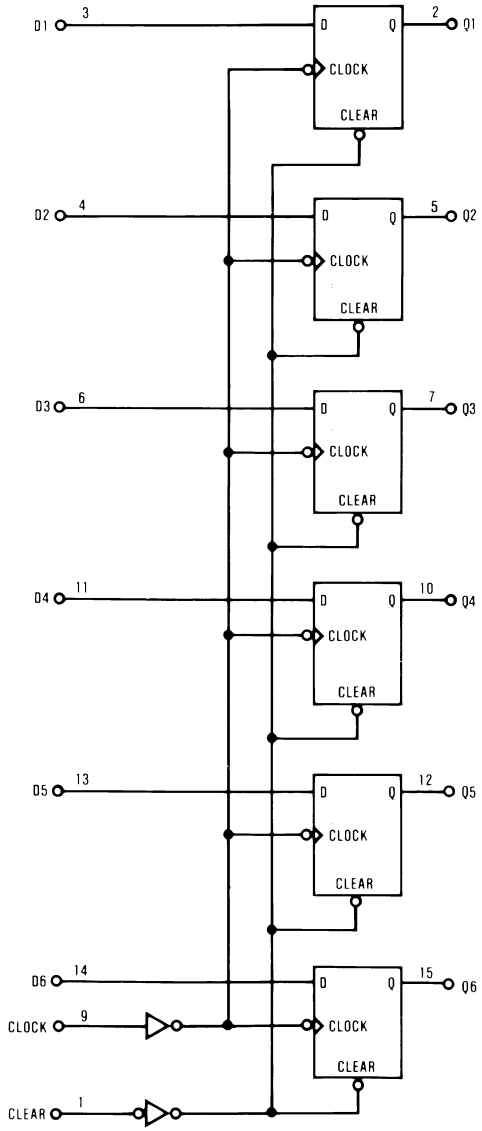
Inputs			Outputs	
Clear	**Clock**	**D**	**Q**	$\overline{Q}^{(1)}$
L	X	X	L	H
H	↑	H	H	L
H	↑	L	L	H
H	L	X	Q_0	$\overline{Q}_0$

H = HIGH Level (steady state) L = LOW Level (steady state)
X = Don't Care ↑ = Transition from LOW-to-HIGH Level
Q_0 = the level of Q before the indicated steady-state input conditions were established.

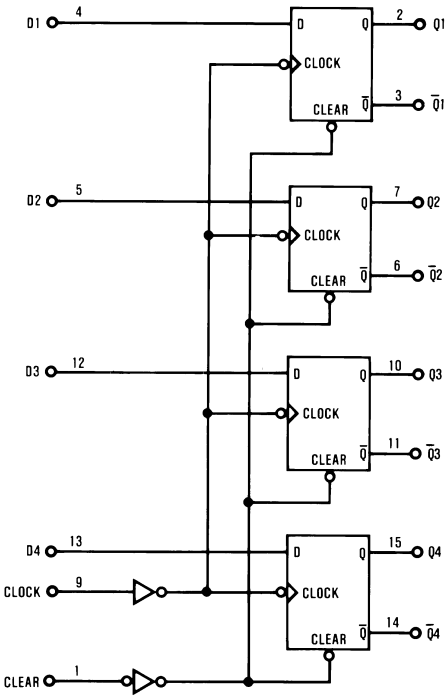
Note:
1. Applies to DM74ALS175 only.

Logic Diagrams

DM74ALS174



DM74ALS175



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	7V
V_I	Input Voltage	7V
T_A	Operating Free Air Temperature Range	0°C to +70°C
T_{STG}	Storage Temperature Range	–65°C to +150°C
θ_{JA}	Typical Thermal Resistance	
	N Package	77.9°C/W
	M Package	107.3°C/W

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter		Min.	Nom.	Max.	Units
V_{CC}	Supply Voltage		4.5	5	5.5	V
V_{IH}	HIGH Level Input Voltage		2			V
V_{IL}	LOW Level Input Voltage				0.8	V
I_{OH}	HIGH Level Output Current				–0.4	mA
I_{OL}	LOW Level Output Current				8	mA
t_W	Pulse Width	Clock HIGH or LOW	10			ns
		$\overline{\text{Clear}}$ LOW	10			
t_{SETUP}	Setup Time(2)	Data Input	10↑			ns
		$\overline{\text{Clear}}$, Inactive State	6↑			
t_{HOLD}	Data Hold Time(2)		0↑			ns
f_{CLOCK}	Clock Frequency		0		50	MHz
T_A	Free Air Operating Temperature		0		70	°C

Note:

2. The symbol ↑ indicates that the rising edge of the clock is used as reference.

Electrical Characteristics

Over recommended operating free air temperature range. All typical values are measured at V_{CC} = 5V, T_A = 25°C.

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Units
V_{IK}	Input Clamp Voltage	V_{CC} = 4.5V, I_{IN} = –18 mA				–1.5	V
V_{OH}	HIGH Level Output Voltage	I_{OH} = –400µA, V_{CC} = 4.5V to 5.5V		V_{CC} – 2	V_{CC} – 1.6		V
V_{OL}	LOW Level Output Voltage	V_{CC} = 4.5V, I_{OL} = 8mA			0.35	0.5	V
I_I	Input Current at Max. Input Voltage	V_{CC} = 5.5V, V_{IN} = 7V				0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = 5.5V, V_{IH} = 2.7V				20	µA
I_{IL}	LOW Level Input Current	V_{CC} = 5.5V, V_{IN} = 0.4V				–0.1	mA
I_O	Output Drive Current	V_{CC} = 5.5V, V_O = 2.25V		–30		–112	mA
I_{CC}	Supply Current	V_{CC} = 5.5V, Clock = 4.5V, Clear = GND, D Input = GND	DM74ALS174		11	19	mA
			DM74ALS175		8	14	

Switching Characteristics

Over recommended operating free air temperature range.

Symbol	Parameter	Conditions	Min.	Max.	Units
f_{MAX}	Maximum Clock Frequency	R_L = 500Ω, C_L = 50pF, V_{CC} = 4.5V to 5.5V	50		MHz
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output From Clear (175 Only)		5	18	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output From Clear		8	23	ns
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output From Clock		3	15	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output From Clock		5	17	ns

Physical Dimensions

Dimensions are in millimeters unless otherwise noted.

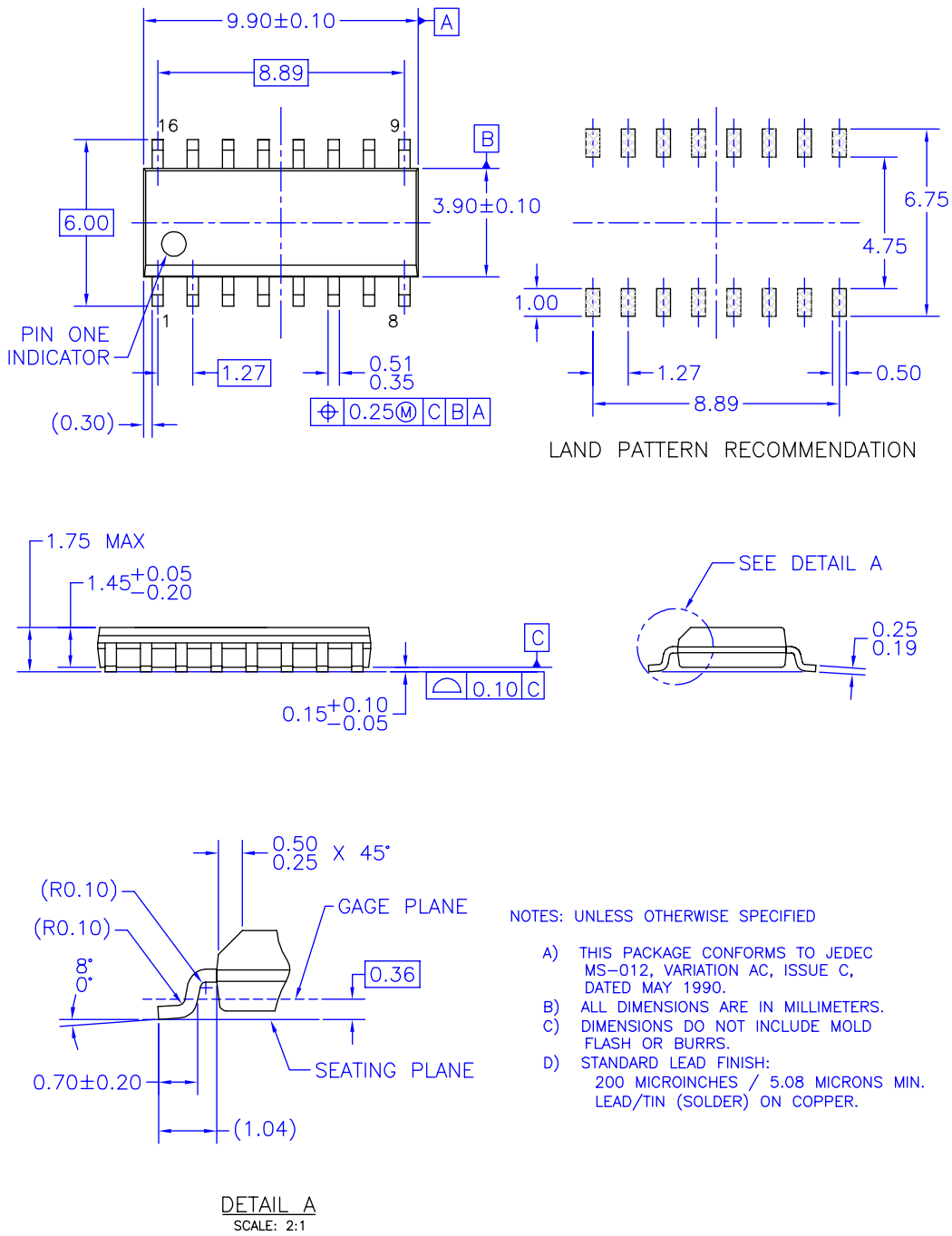
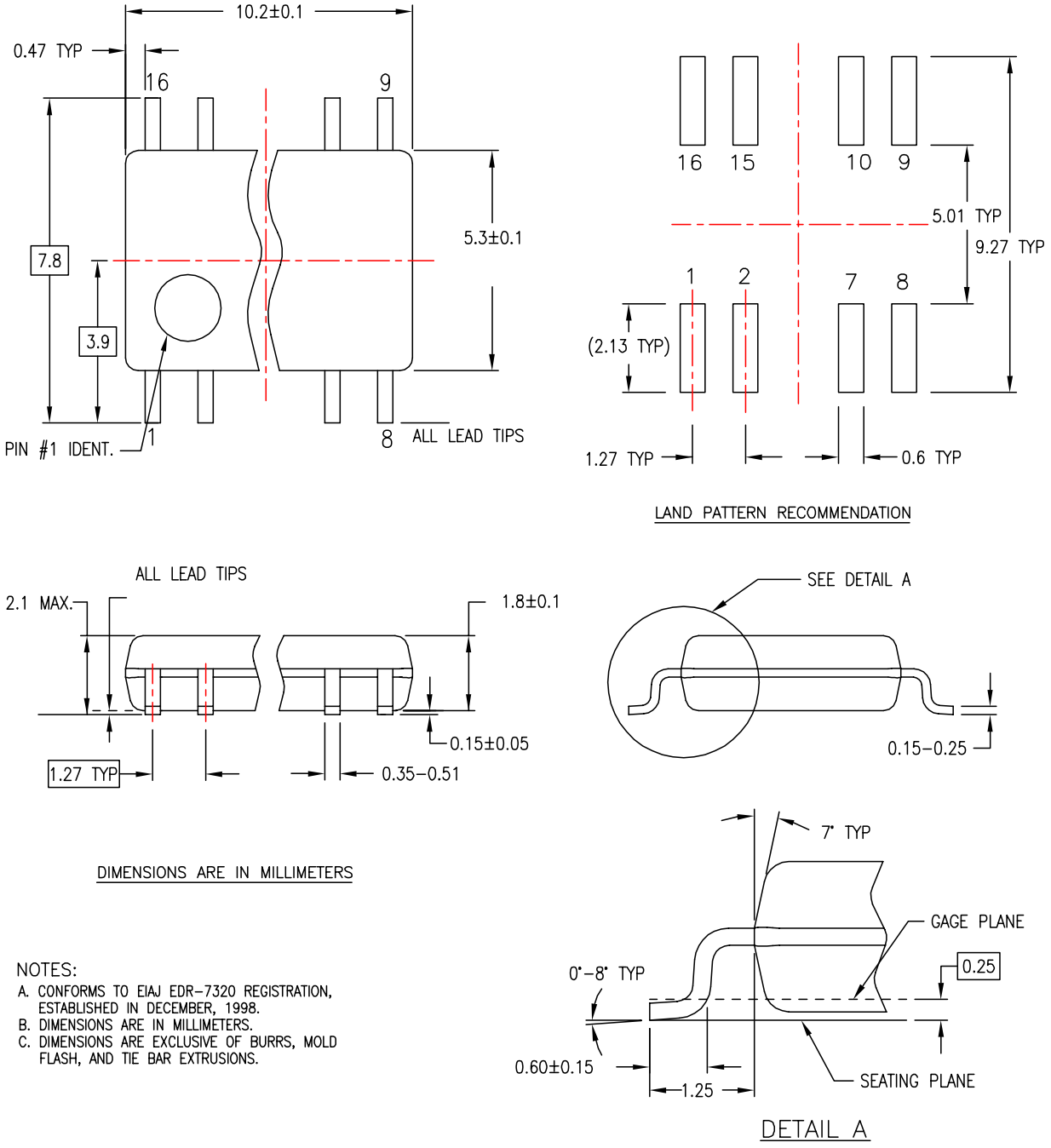


Figure 1. 16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M16A

Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.



NOTES:

A. CONFORMS TO EIAJ EDR–7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DREVC

Figure 2. 16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M16D

Physical Dimensions (Continued)

Dimensions are in inches (millimeters) unless otherwise noted.

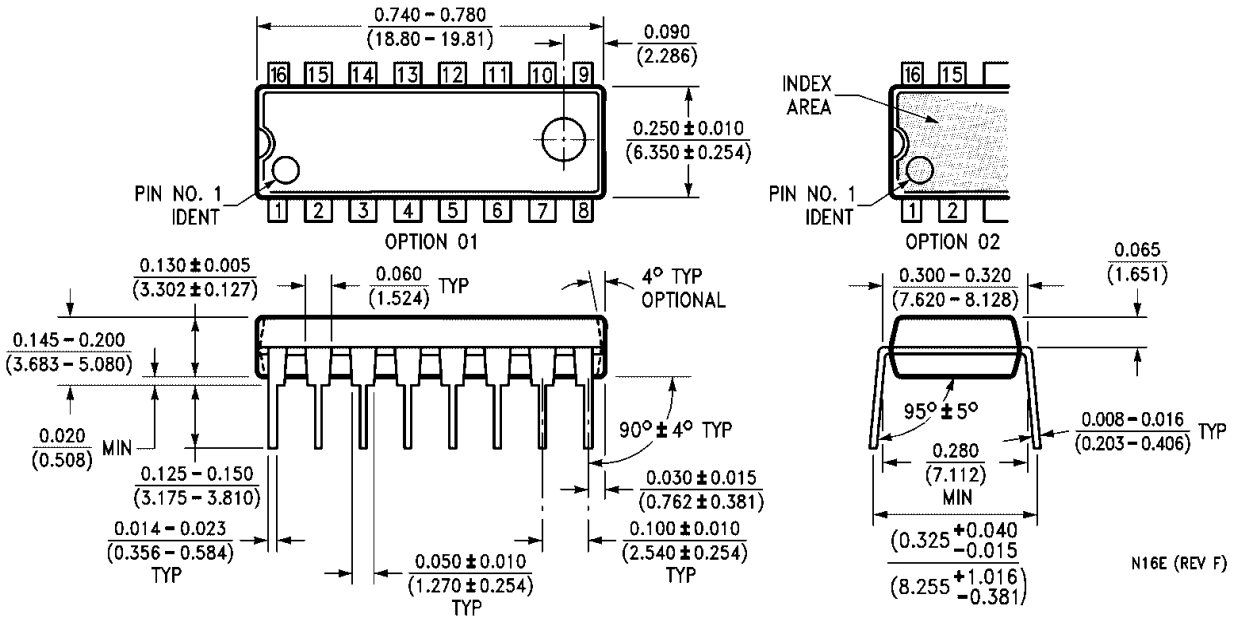


Figure 3. 16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N16E

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

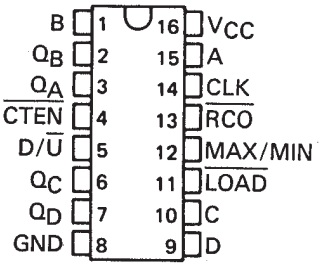
Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. I28

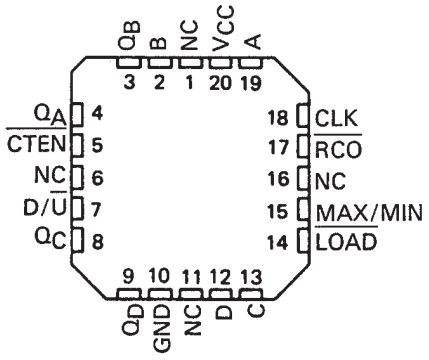
- **Counts 8-4-2-1 BCD or Binary**
- **Single Down/Up Count Control Line**
- **Count Enable Control Input**
- **Ripple Clock Output for Cascading**
- **Asynchronously Presettable with Load Control**
- **Parallel Outputs**
- **Cascadable for n-Bit Applications**

TYPE	AVERAGE PROPAGATION DELAY	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
'190,'191	20ns	25MHz	325mW
'LS190,'LS191	20ns	25MHz	100mW

SN54190, SN54191, SN54LS190, SN54LS191 . . . J PACKAGE
SN74190, SN74191 . . . N PACKAGE
SN74LS190, SN74LS191 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS190, SN54LS191 . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

description

The '190, 'LS190, '191, and 'LS191 are synchronous, reversible up/down counters having a complexity of 58 equivalent gates. The '191 and 'LS191 are 4-bit binary counters and the '190 and 'LS190 are BCD counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

The outputs of the four master-slave flip-flops are triggered on a low-to-high transition of the clock input if the enable input is low. A high at the enable input inhibits counting. Level changes at the enable input should be made only when the clock input is high. The direction of the count is determined by the level of the down/up input. When low, the counter count up and when high, it counts down. A false clock may occur if the down/up input changes while the clock is low. A false ripple carry may occur if both the clock and enable are low and the down/up input is high during a load pulse.

These counters are fully programmable; that is, the outputs may be preset to either level by placing a low on the load input and entering the desired data at the data inputs. The output will change to agree with the data inputs independently of the level of the clock input. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

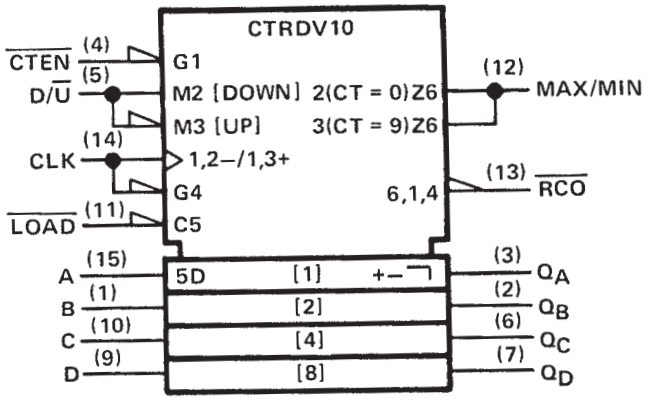
The clock, down/up, and load inputs are buffered to lower the drive requirement which significantly reduces the number of clock drivers, etc., required for long parallel words.

Two outputs have been made available to perform the cascading function: ripple clock and maximum/minimum count. The latter output produces a high-level output pulse with a duration approximately equal to one complete cycle of the clock when the counter overflows or underflows. The ripple clock output produces a low-level output pulse equal in width to the low-level portion of the clock input when an overflow or underflow condition exists. The counters can be easily cascaded by feeding the ripple clock output to the enable input of the succeeding counter if parallel clocking is used, or to the clock input if parallel enabling is used. The maximum/minimum count output can be used to accomplish look-ahead for high-speed operation.

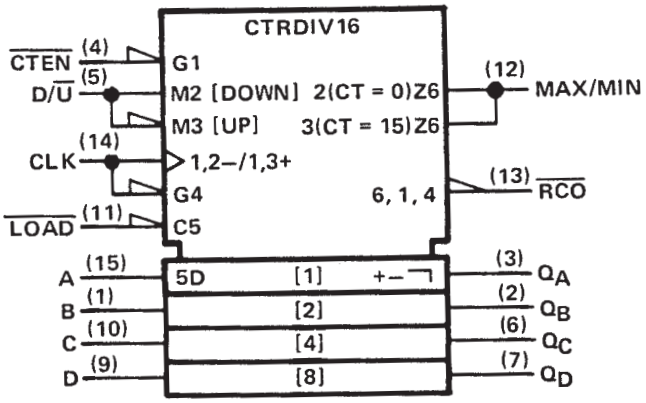
Series 54' and 54LS' are characterized for operation over the full military temperature range of −55°C to 125°C; Series 74' and 74LS' are characterized for operation from 0°C to 70°C.

logic symbols†

'190, 'LS190



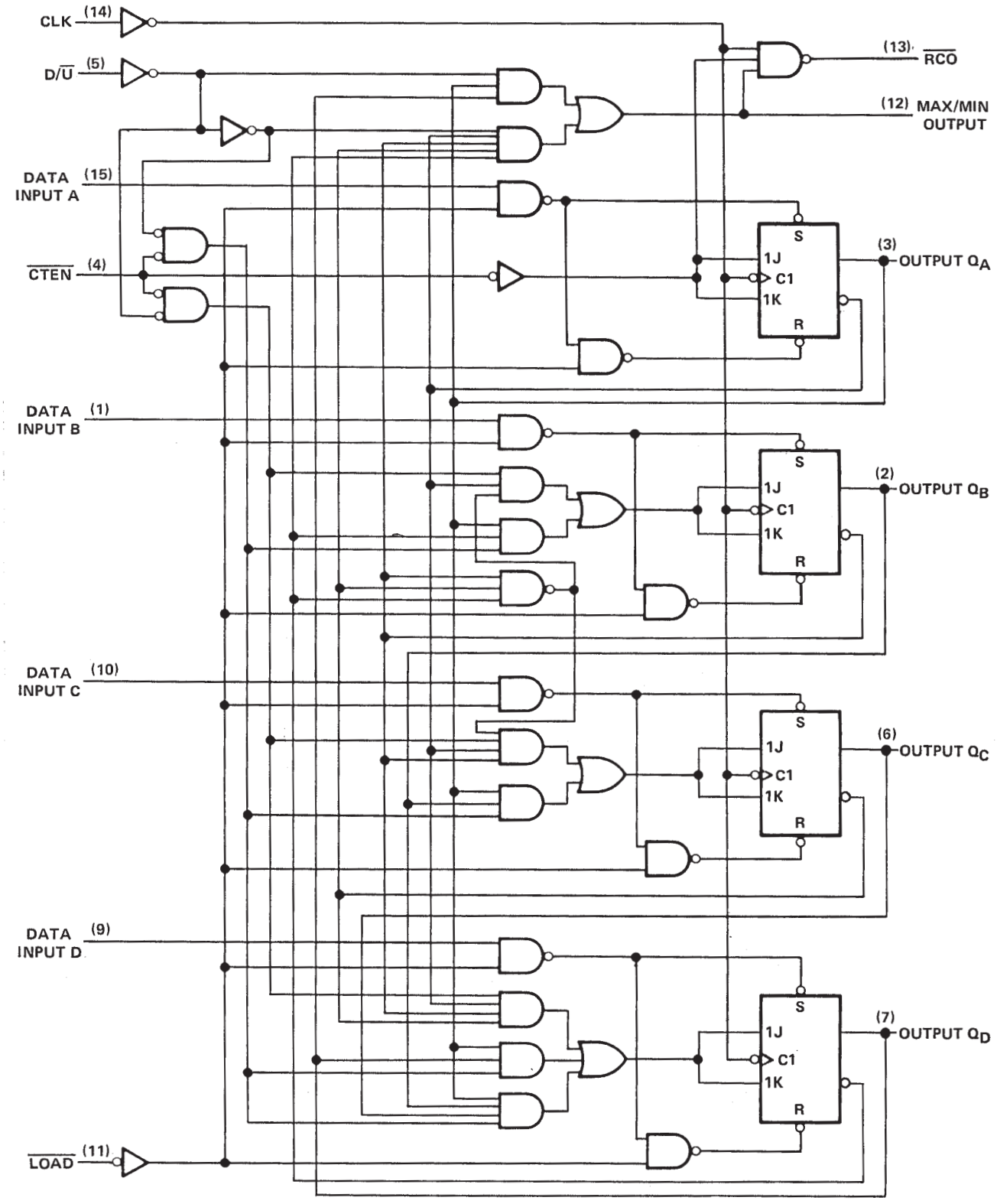
'191, 'LS191



† These symbols are accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, and N packages.

logic diagram (positive logic)

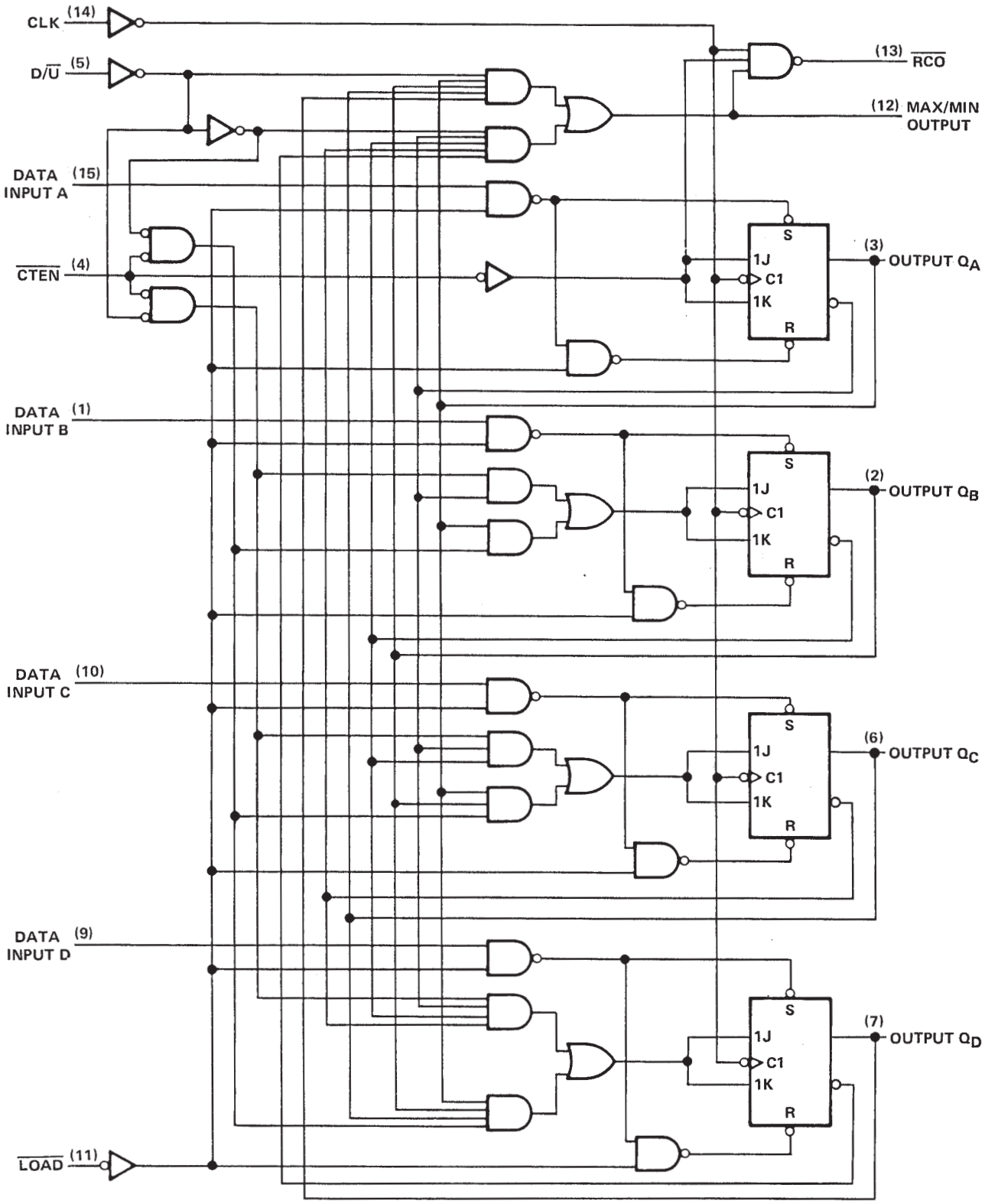
'190, 'LS190 DECADE COUNTERS



Pin numbers shown are for D, J, and N packages.

logic diagram (positive logic)

'191, 'LS191 BINARY COUNTERS



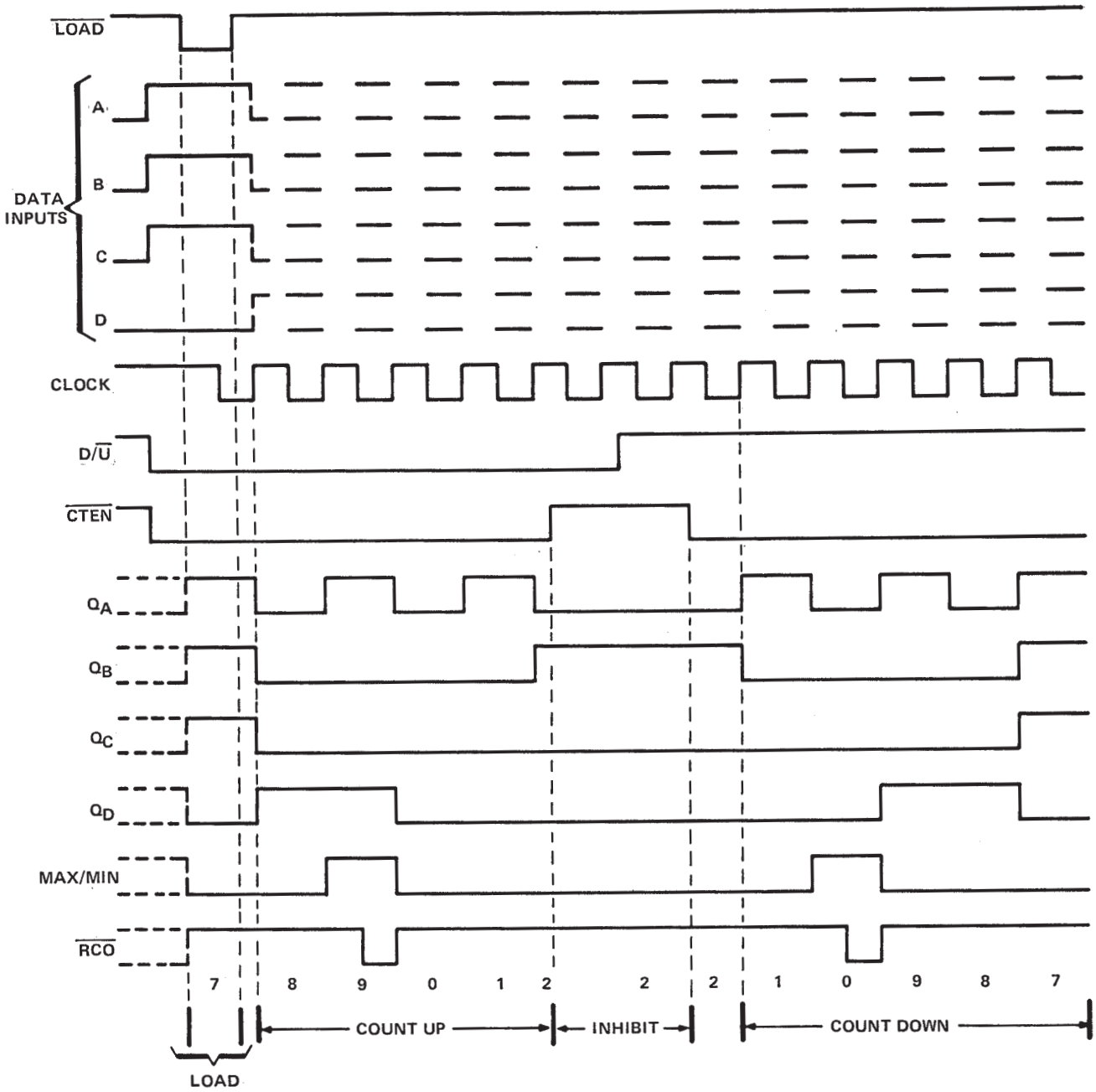
Pin numbers shown are for D, J, and N packages.

'190, 'LS190 DECADE COUNTERS

typical load, count, and inhibit sequences

Illustrated below is the following sequence:

1. Load (preset) to BCD seven.
2. Count up to eight, nine (maximum), zero, one, and two.
3. Inhibit.
4. Count down to one, zero (minimum), nine, eight, and seven.

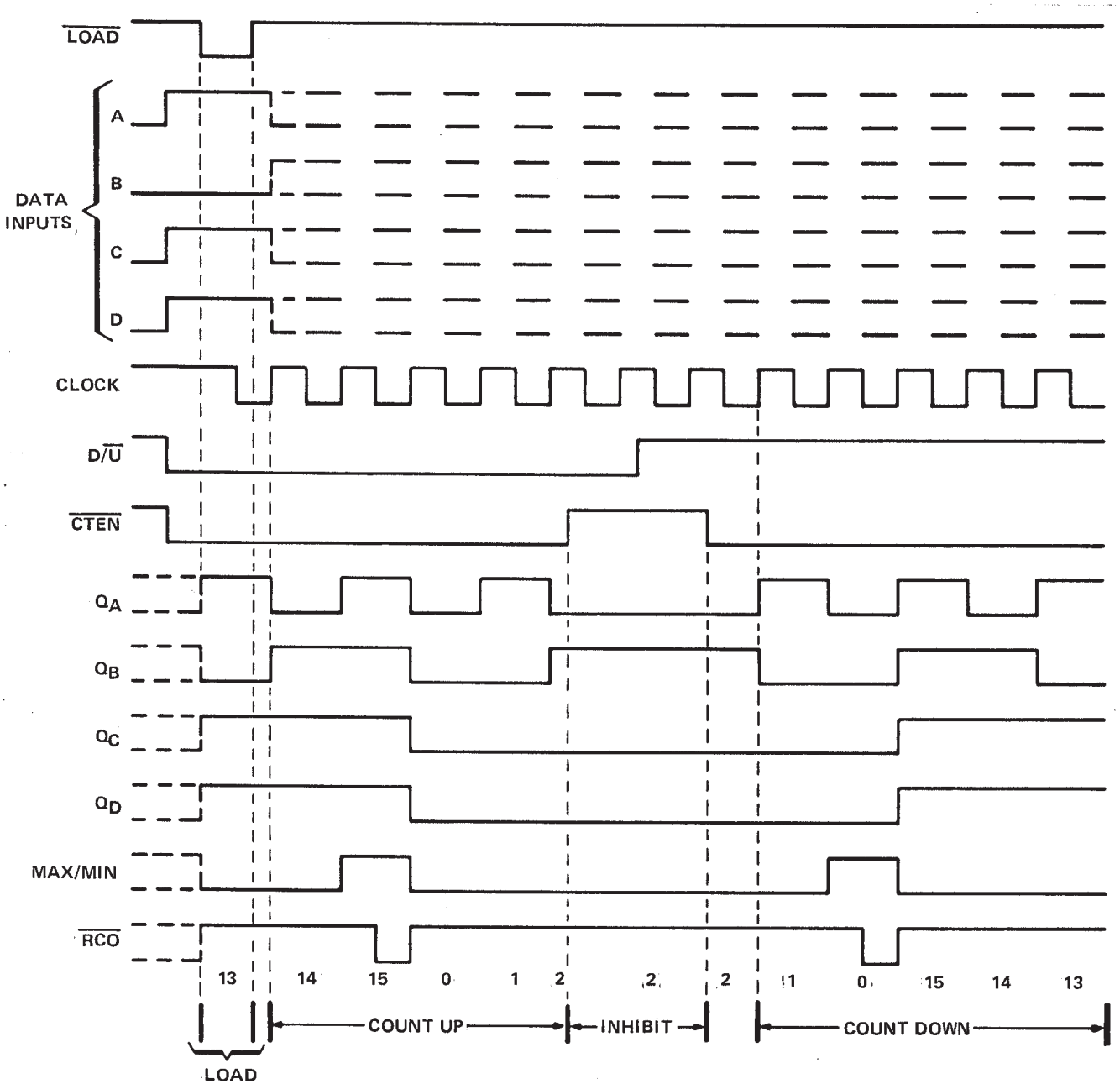


'191, 'LS191 BINARY COUNTERS

pical load, count, and inhibit sequences

Illustrated below is the following sequence:

1. Load (preset) to binary thirteen.
2. Count up to fourteen, fifteen (maximum), zero, one, and two.
3. Inhibit.
4. Count down to one, zero (minimum), fifteen, fourteen, and thirteen.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: SN54', SN74' Circuits . . . . . 5.5 V
SN54LS', SN74LS' Circuits . . . . . 7 V
Operating free-air temperature range: SN54', SN54LS' Circuits . . . . . −55°C to 125°C
SN74', SN74LS' Circuits . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN54190, SN54191			SN74190, SN74191			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current				−0.8			−0.8	mA
I_{OL}	Low-level output current				16			16	mA
f_{clock}	Input clock frequency		0		20	0		20	MHz
$t_{w(clock)}$	Width of clock input pulse		25			25			ns
$t_{w(load)}$	Width of load input pulse		35			35			ns
t_{su}	Setup time	Data, high or low (See Figure 1 and 2)	20			20			ns
		Load inactive state	20			20			
t_{hold}	Data hold time		0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54190, SN54191			SN74190, SN74191			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage	V_{CC} = MIN	2			2			V
V_{IL}	Low-level input voltage	V_{CC} = MIN			0.8			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −0.8 mA	2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	High-level input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current at any input except enable	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
I_{IH}	High-level input current at enable input				120			120	μA
I_{IL}	Low-level input current at any input except enable	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
I_{IL}	Low-level input current at enable input				−4.8			−4.8	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX	−20		−65	−18		−65	mA
I_{CC}	Supply current	V_{CC} = MAX, See Note 2		65	99		65	105	mA

† For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 2: I_{CC} is measured with all inputs grounded and all outputs open.

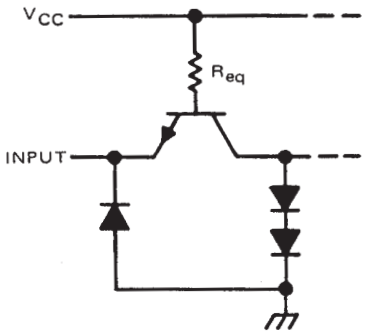
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'190, '191			UNIT
				MIN	TYP	MAX	
f_{max}			C_L = 15 pF, R_L = 400 Ω, See Figures 1 and 3 thru 7	20	25		MHz
t_{PLH}	$\overline{Load}$	Q_A, Q_B, Q_C, Q_D			22	33	ns
t_{PHL}					33	50	
t_{PLH}	Data A, B, C, D	Q_A, Q_B, Q_C, Q_D			14	22	ns
t_{PHL}					35	50	
t_{PLH}	CLK	$\overline{RCO}$			13	20	ns
t_{PHL}					16	24	
t_{PLH}	CLK	Q_A, Q_B, Q_C, Q_D			16	24	ns
t_{PHL}					24	36	
t_{PLH}	CLK	Max/Min			28	42	ns
t_{PHL}					37	52	
t_{PLH}	D/$\overline{U}$	$\overline{RCO}$			30	45	ns
t_{PHL}					30	45	
t_{PLH}	D/$\overline{U}$	Max/Min			21	33	ns
t_{PHL}					22	33	

† f_{max} ≡ maximum clock frequency
t_{PLH} ≡ propagation delay time, low-to-high-level output
t_{PHL} ≡ propagation delay time, high-to-low-level output

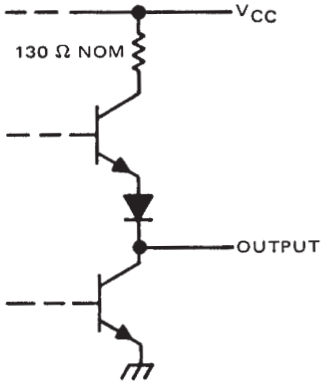
schematics of inputs and outputs

EQUIVALENT OF EACH INPUT



Enable input: R_{eq} = 1.3 kΩ NOM
All other inputs: R_{eq} = 4 kΩ NOM

TYPICAL OF ALL OUTPUTS



recommended operating conditions

		SN54LS190 SN54LS191			SN74LS190 SN74LS191			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			4			8	mA
f_{clock}	Clock frequency	0		20	0		20	MHz
$t_{w(clock)}$	Width of clock input pulse	25			25			ns
$t_{w(load)}$	Width of load input pulse	35			35			ns
t_{su}	Data setup time (See Figures 1 and 2)	20			20			ns
t_{su}	Load inactive state setup time	30			30			ns
t_h	Data hold time	5			5			ns
t_h	Enable hold time	0			0			ns
t_{enable}	Count enable time (see Note 3)	40			40			ns
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS190 SN54LS191			SN74LS190 SN74LS191			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 8 mA					0.35	0.5	
I_I	High-level input current at maximum input voltage	Enable	V_{CC} = MAX, V_I = 7 V				0.3			0.3	mA
		Others					0.1			0.1	
I_{IH}	High-level input current	Enable	V_{CC} = MAX, V_I = 2.7 V				60			60	μA
		Others					20			20	
I_{IL}	Low-level input current	Enable	V_{CC} = MAX, V_I = 0.4 V				−1.2			−1.2	mA
		Others					−0.4			−0.4	
I_{OS}	Short-circuit output current§		V_{CC} = MAX,		−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX, See Note 2			20	35		20	35	mA

†For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions for the applicable device type.

‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTES: 2. I_{CC} is measured with all inputs grounded and all outputs open.

3. Minimum count enable time is the interval immediately preceeding the rising edge of the clock pulse during which interval the count enable input must be low to ensure counting.

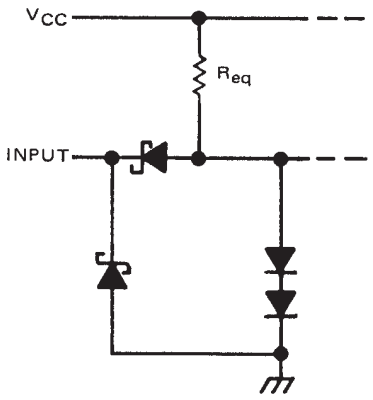
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS190, 'LS191			UNIT
				MIN	TYP	MAX	
f_{max}			C_L = 15 pF, R_L = 2 kΩ, See Figures 1 and 3 thru 7	20	25		MHz
t_{PLH}	$\overline{Load}$	Q_A, Q_B, Q_C, Q_D			22	33	ns
t_{PHL}					33	50	
t_{PLH}	Data A, B, C, D	Q_A, Q_B, Q_C, Q_D			20	32	ns
t_{PHL}					27	40	
t_{PLH}	CLK	$\overline{RCO}$			13	20	ns
t_{PHL}					16	24	
t_{PLH}	CLK	Q_A, Q_B, Q_C, Q_D			16	24	ns
t_{PHL}					24	36	
t_{PLH}	CLK	Max/Min			28	42	ns
t_{PHL}					37	52	
t_{PLH}	D/$\overline{U}$	$\overline{RCO}$			30	45	ns
t_{PHL}					30	45	
t_{PLH}	D/$\overline{U}$	Max/Min			21	33	ns
t_{PHL}					22	33	
t_{PLH}	$\overline{CTEN}$	$\overline{RCO}$			21	33	ns
t_{PHL}					22	33	

† f_{max} ≡ maximum clock frequency
t_{PLH} ≡ propagation delay time, low-to-high-level output
t_{PHL} ≡ propagation delay time, high-to-low-level output

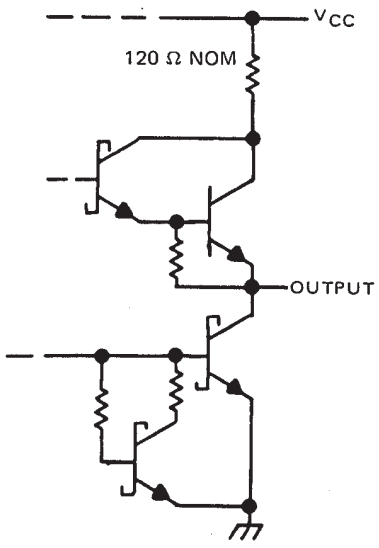
schematics of inputs and outputs

EQUIVALENT OF EACH INPUT



Enable input: R_{eq} = 8.33 kΩ NOM
Load input: R_{eq} = 25 kΩ NOM
All other inputs: R_{eq} = 17 kΩ NOM

TYPICAL OF ALL OUTPUTS



PARAMETER MEASUREMENT INFORMATION

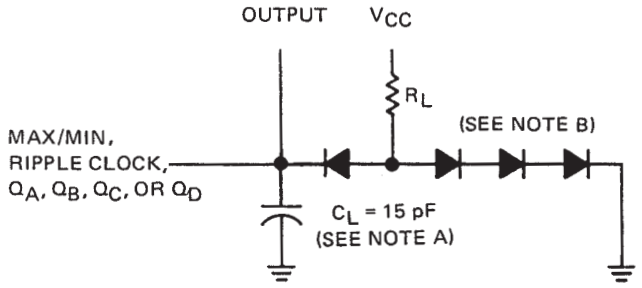
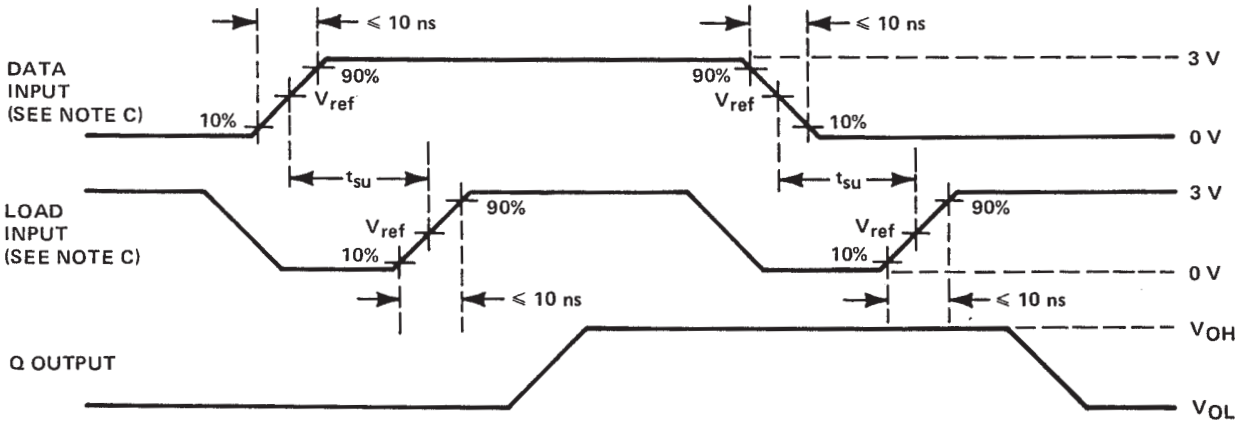
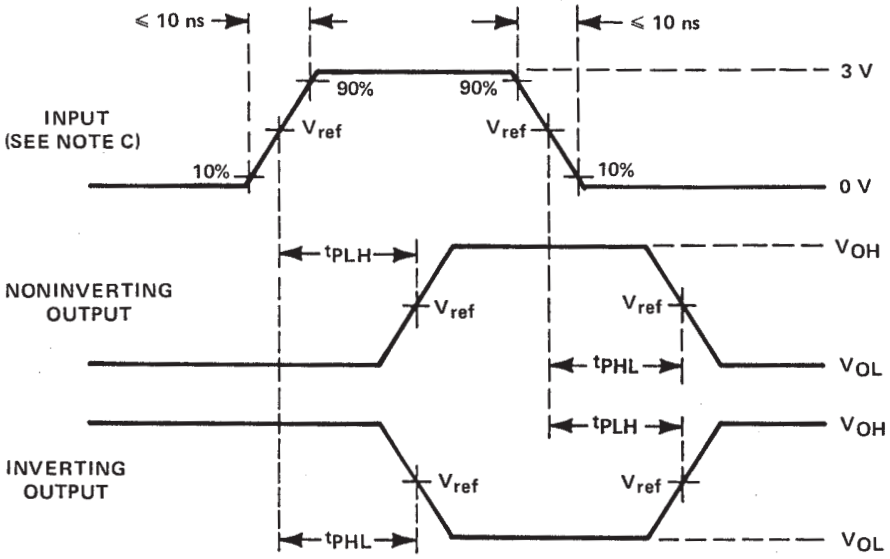


FIGURE 1–LOAD CIRCUIT
FOR SWITCHING TIME MEASUREMENT



FIGUTE 2-DATA SETUP TIME VOLTAGE WAVEFORMS

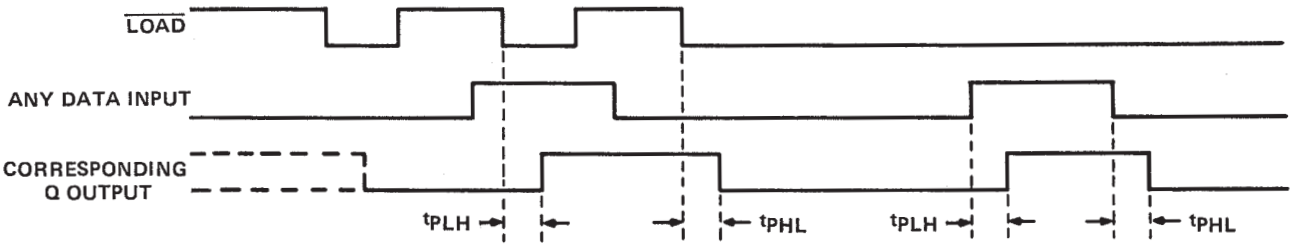


See waveform sequences in figures 4 through 7 for propagation times from a specific input to a specific output. For simplication, pulse rise times, reference levels, etc., have not been shown in figures 4 through 7.

FIGURE 3-GENERAL VOLTAGE WAVEFORMS FOR PROPAGATION TIMES

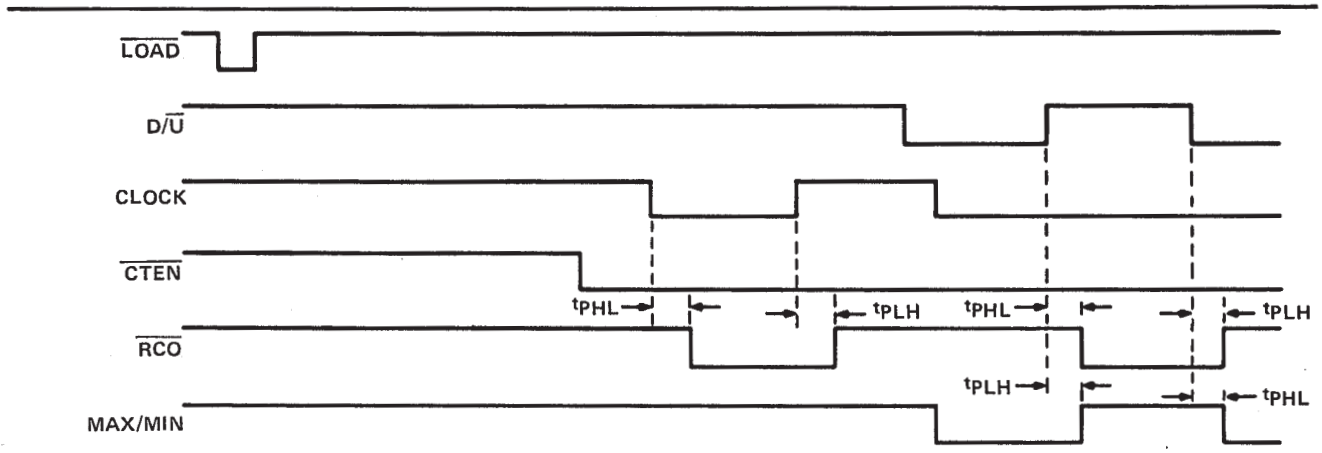
NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. The input pulses are supplied by generators having the following characteristics: Z_{out} = 50 Ω, duty cycle ⩽ 50%, PRR ⩽ 1 MHz.
D. V_{ref} = 1.5 V for '190 and '191; 1.3 V for 'LS190 and 'LS191.

PARAMETER MEASUREMENT INFORMATION (continued)



NOTE E: Conditions on other inputs are irrelevant.

FIGURE 4—LOAD TO OUTPUT AND DATA TO OUTPUT

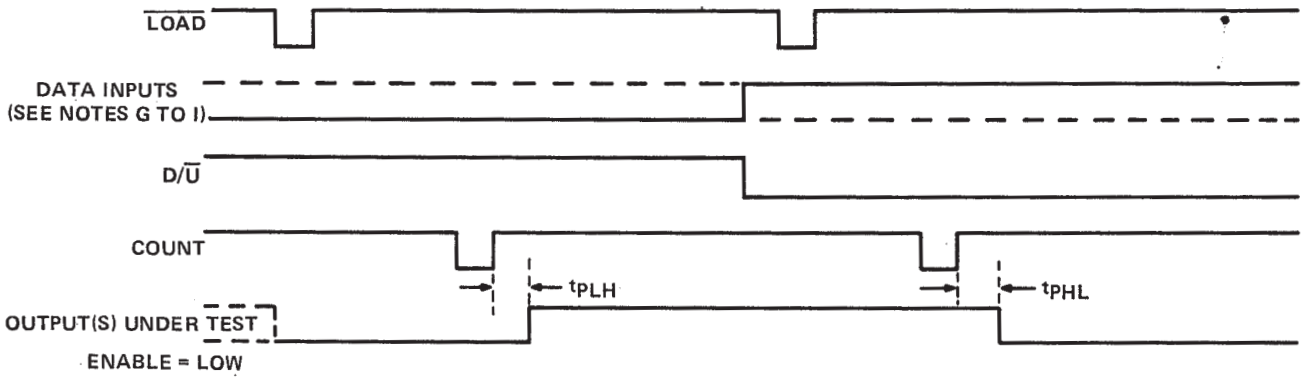


NOTE F: All data inputs are low.

FIGURE 5—ENABLE TO RIPPLE CLOCK, CLOCK TO RIPPLE CLOCK, DOWN/UP TO RIPPLE CLOCK, AND DOWN/UP TO MAX/MIN

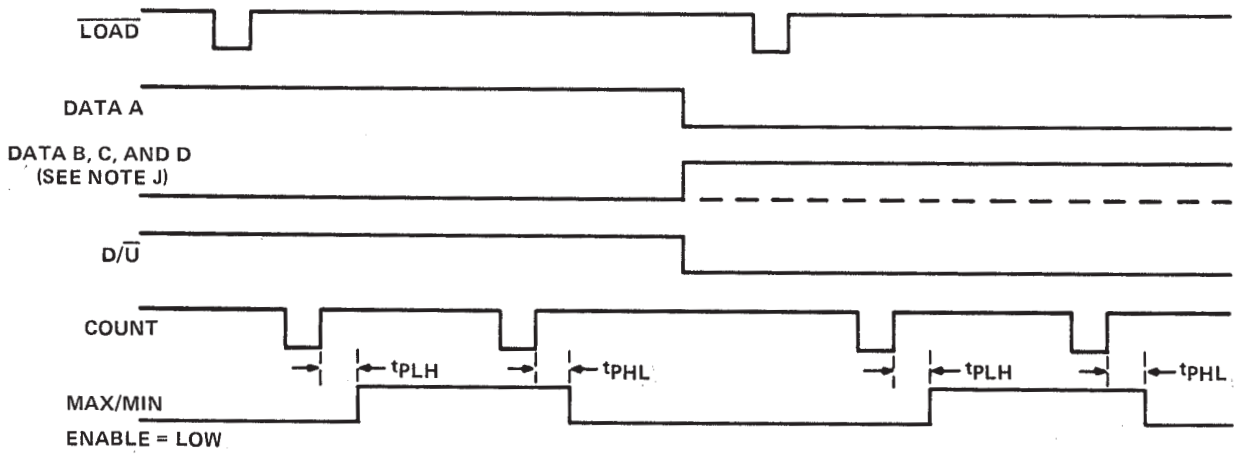
PARAMETER MEASUREMENT INFORMATION (continued)

switching characteristics (continued)



NOTES: G. To test Q_A, Q_B, and Q_C outputs of '190 and 'LS190: Data inputs A, B, and C are shown by the solid line. Data input D is shown by the dashed line.
H. To test Q_D output of '190 and 'LS190: Data inputs A and D are shown by the solid line. Data inputs B and C are held at the low logic level.
I. To test Q_A, Q_B, Q_C, and Q_D outputs of '191 and 'LS191: All four data inputs are shown by the solid line.

FIGURE 6-CLOCK TO OUTPUT



NOTE J: Data inputs B and C are shown by the dashed line for the '190 and 'LS190 and the solid line for the '191 and 'LS191: Data input D is shown by the solid line for both devices.

FIGURE 7-CLOCK TO MAX/MIN

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MOTOROLA

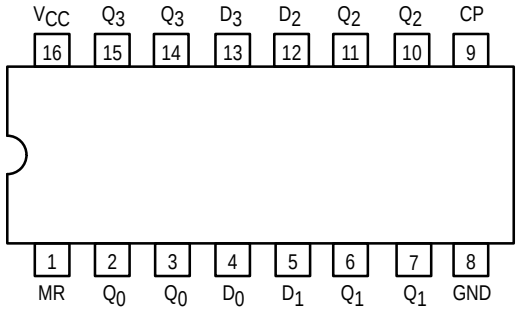
QUAD D FLIP-FLOP

The LSTTL/MSI SN54/74LS175 is a high speed Quad D Flip-Flop. The device is useful for general flip-flop requirements where clock and clear inputs are common. The information on the D inputs is stored during the LOW to HIGH clock transition. Both true and complemented outputs of each flip-flop are provided. A Master Reset input resets all flip-flops, independent of the Clock or D inputs, when LOW.

The LS175 is fabricated with the Schottky barrier diode process for high speed and is completely compatible with all Motorola TTL families.

- Edge-Triggered D-Type Inputs
- Buffered-Positive Edge-Triggered Clock
- Clock to Output Delays of 30 ns
- Asynchronous Common Reset
- True and Complement Output
- Input Clamp Diodes Limit High Speed Termination Effects

CONNECTION DIAGRAM DIP (TOP VIEW)



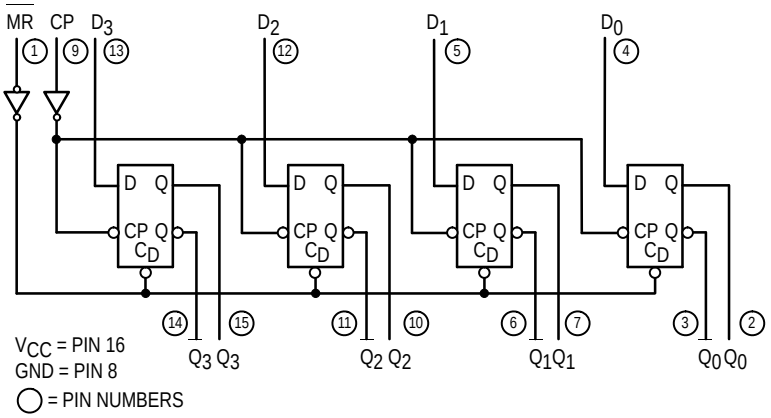
NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

PIN NAMES

		LOADING (Note a) HIGH	LOW
D_0-D_3	Data Inputs	0.5 U.L.	0.25 U.L.
$\overline{CP}$	Clock (Active HIGH Going Edge) Input	0.5 U.L.	0.25 U.L.
MR	Master Reset (Active LOW) Input	0.5 U.L.	0.25 U.L.
$\overline{Q}_0-\overline{Q}_3$	True Outputs (Note b)	10 U.L.	5 (2.5) U.L.
Q_0-Q_3	Complemented Outputs (Note b)	10 U.L.	5 (2.5) U.L.

NOTES:
a. 1 TTL Unit Load (U.L.) = 40 µA HIGH/1.6 mA LOW.
b. The Output LOW drive factor is 2.5 U.L. for Military (54) and 5 U.L. for Commercial (74) Temperature Ranges.

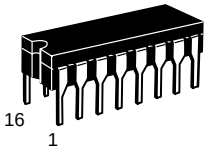
LOGIC DIAGRAM



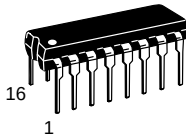
SN54/74LS175

QUAD D FLIP-FLOP

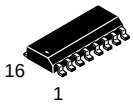
LOW POWER SCHOTTKY



J SUFFIX
CERAMIC
CASE 620-09



N SUFFIX
PLASTIC
CASE 648-08

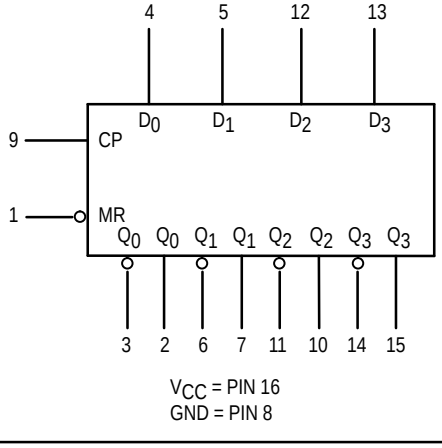


D SUFFIX
SOIC
CASE 751B-03

ORDERING INFORMATION

SN54LSXXXJ	Ceramic
SN74LSXXXN	Plastic
SN74LSXXXD	SOIC

LOGIC SYMBOL



FUNCTIONAL DESCRIPTION

The LS175 consists of four edge-triggered D flip-flops with individual D inputs and Q and Q outputs. The Clock and Master Reset are common. The four flip-flops will store the state of their individual D inputs on the LOW to HIGH Clock (CP) transition, causing individual Q and Q outputs to follow. A LOW input on the Master Reset ($\overline{MR}$) will force all Q outputs LOW and Q outputs HIGH independent of Clock or Data inputs.

The LS175 is useful for general logic applications where a common Master Reset and Clock are acceptable.

TRUTH TABLE

Inputs (t = n, $\overline{MR}$ = H)	Outputs (t = n+1) Note 1	
D	Q	$\overline{Q}$
L	L	H
H	H	L

Note 1: t = n + 1 indicates conditions after next clock.

GUARANTEED OPERATING RANGES

Symbol	Parameter		Min	Typ	Max	Unit
V_{CC}	Supply Voltage	54 74	4.5 4.75	5.0 5.0	5.5 5.25	V
T_A	Operating Ambient Temperature Range	54 74	−55 0	25 25	125 70	°C
I_{OH}	Output Current — High	54, 74			−0.4	mA
I_{OL}	Output Current — Low	54 74			4.0 8.0	mA

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol	Parameter		Limits Min	Limits Typ	Limits Max	Unit	Test Conditions	
V_{IH}	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V_{IL}	Input LOW Voltage	54			0.7	V	Guaranteed Input LOW Voltage for All Inputs	
		74			0.8			
V_{IK}	Input Clamp Diode Voltage			−0.65	−1.5	V	V_{CC} = MIN, I_{IN} = −18 mA	
V_{OH}	Output HIGH Voltage	54	2.5	3.5		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table	
		74	2.7	3.5		V		
V_{OL}	Output LOW Voltage	54, 74		0.25	0.4	V	I_{OL} = 4.0 mA	V_{CC} = V_{CC} MIN, V_{IN} = V_{IL} or V_{IH} per Truth Table
		74		0.35	0.5	V	I_{OL} = 8.0 mA	
I_{IH}	Input HIGH Current				20	μA	V_{CC} = MAX, V_{IN} = 2.7 V	
					0.1	mA	V_{CC} = MAX, V_{IN} = 7.0 V	
I_{IL}	Input LOW Current				−0.4	mA	V_{CC} = MAX, V_{IN} = 0.4 V	
I_{OS}	Short Circuit Current (Note 1)		−20		−100	mA	V_{CC} = MAX	
I_{CC}	Power Supply Current				18	mA	V_{CC} = MAX	

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

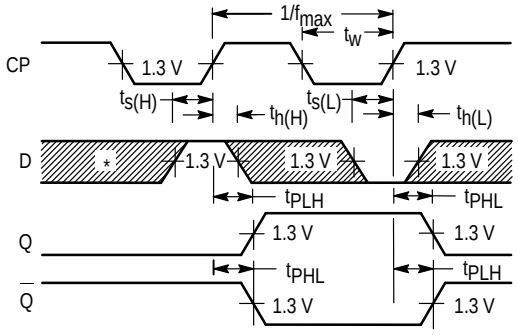
AC CHARACTERISTICS (T_A = 25°C)

Symbol	Parameter	Limits			Unit	Test Conditions
		Min	Typ	Max		
f_{MAX}	Maximum Input Clock Frequency	30	40		MHz	V_{CC} = 5.0 V C_L = 15 pF
t_{PLH} t_{PHL}	Propagation Delay, $\overline{MR}$ to Output		20 20	30 30	ns	
t_{PLH} t_{PHL}	Propagation Delay, Clock to Output		13 16	25 25	ns	

AC SETUP REQUIREMENTS (T_A = 25°C)

Symbol	Parameter	Limits			Unit	Test Conditions
		Min	Typ	Max		
t_W	Clock or $\overline{MR}$ Pulse Width	20			ns	V_{CC} = 5.0 V
t_s	Data Setup Time	20			ns	
t_h	Data Hold Time	5.0			ns	
t_{rec}	Recovery Time	25			ns	

AC WAVEFORMS



*The shaded areas indicate when the input is permitted to change for predictable output performance.

Figure 1. Clock to Output Delays, Clock Pulse Width, Frequency, Setup and Hold Times Data to Clock

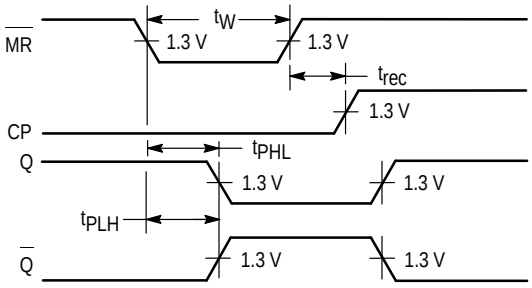


Figure 2. Master Reset to Output Delay, Master Reset Pulse Width, and Master Reset Recovery Time

DEFINITIONS OF TERMS

SETUP TIME (t_s) — is defined as the minimum time required for the correct logic level to be present at the logic input prior to the clock transition from LOW to HIGH in order to be recognized and transferred to the outputs.

HOLD TIME (t_h) — is defined as the minimum time following the clock transition from LOW to HIGH that the logic level must be maintained at the input in order to ensure continued recognition. A negative HOLD TIME indicates that the correct logic level may be released prior to the clock transition from LOW to HIGH and still be recognized.

RECOVERY TIME (t_{rec}) — is defined as the minimum time required between the end of the reset pulse and the clock transition from LOW to HIGH in order to recognize and transfer HIGH Data to the Q outputs.

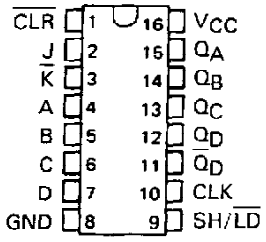
SDLS076

SN54195, SN54LS195A, SN54S195, SN74195, SN74LS195A, SN74S195
4-BIT PARALLEL-ACCESS SHIFT REGISTERS

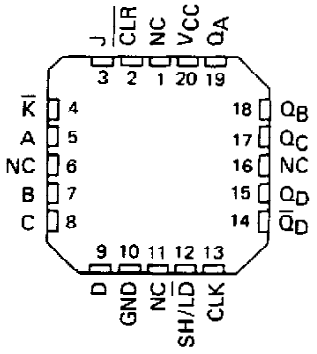
MARCH 1974—REVISED MARCH 1988

- Synchronous Parallel Load
- Positive-Edge-Triggered Clocking
- Parallel Inputs and Outputs from Each Flip-Flop
- Direct Overriding Clear
- J and $\overline{K}$ Inputs to First Stage
- Complementary Outputs from Last Stage
- For Use in High Performance: Accumulators/Processors Serial-to-Parallel, Parallel-to-Serial Converters

SN54195, SN54LS195A, SN54S195 . . . J OR W PACKAGE
SN74195 . . . N PACKAGE
SN74LS195A, SN74S195 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS195, SN54S195 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

These 4-bit registers feature parallel inputs, parallel outputs, J-$\overline{K}$ serial inputs, shift/load (SH/$\overline{LD}$) control input, and a direct overriding clear. All inputs are buffered to lower the input drive requirements. The register has two modes of operation:

Parallel (broadside) load
Shift (in the direction Q_A toward Q_D)

Parallel loading is accomplished by applying the four bits of data and taking SH/$\overline{LD}$ low. The data is loaded into the associated flip-flop and appears at the outputs after the positive transition of the clock input. During loading, serial data flow is inhibited.

Shifting is accomplished synchronously when SH/$\overline{LD}$ is high. Serial data for this mode is entered at the J-$\overline{K}$ inputs. These inputs permit the first stage to perform as a J-$\overline{K}$, D-, or T-type flip-flop as shown in the function table.

The high-performance 'S195, with a 105-megahertz typical maximum shift-frequency, is particularly attractive for very-high-speed data processing systems. In most cases existing systems can be upgraded merely by using this Schottky-clamped shift register.

TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
'195	39 MHz	195 mW
'LS195A	39 MHz	70 mW
'S195	105 MHz	350 mW

FUNCTION TABLE

INPUTS									OUTPUTS				
CLEAR	SHIFT/$\overline{LOAD}$	CLOCK	SERIAL		PARALLEL				Q_A	Q_B	Q_C	Q_D	$\overline{Q}_D$
			J	$\overline{K}$	A	B	C	D					
L	X	X	X	X	X	X	X	X	L	L	L	L	H
H	L	↑	X	X	a	b	c	d	a	b	c	d	$\overline{d}$
H	H	L	X	X	X	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}	$\overline{Q}_{D0}$
H	H	↑	L	H	X	X	X	X	Q_{A0}	Q_{A0}	Q_{Bn}	Q_{Cn}	$\overline{Q}_{Cn}$
H	H	↑	L	L	X	X	X	X	L	Q_{An}	Q_{Bn}	Q_{Cn}	$\overline{Q}_{Cn}$
H	H	↑	H	H	X	X	X	X	H	Q_{An}	Q_{Bn}	Q_{Cn}	$\overline{Q}_{Cn}$
H	H	↑	H	L	X	X	X	X	$\overline{Q}_{An}$	Q_{An}	Q_{Bn}	Q_{Cn}	$\overline{Q}_{Cn}$

H = high level (steady state)
L = low level (steady state)
X = irrelevant (any input, including transitions)
↑ = transition from low to high level
a, b, c, d = the level of steady-state input at A, B, C, or D, respectively
Q_{A0}, Q_{B0}, Q_{C0}, Q_{D0} = the level of Q_A, Q_B, Q_C, or Q_D, respectively, before the indicated steady-state input conditions were established
Q_{An}, Q_{Bn}, Q_{Cn} = the level of Q_A, Q_B, or Q_C, respectively, before the most-recent transition of the clock

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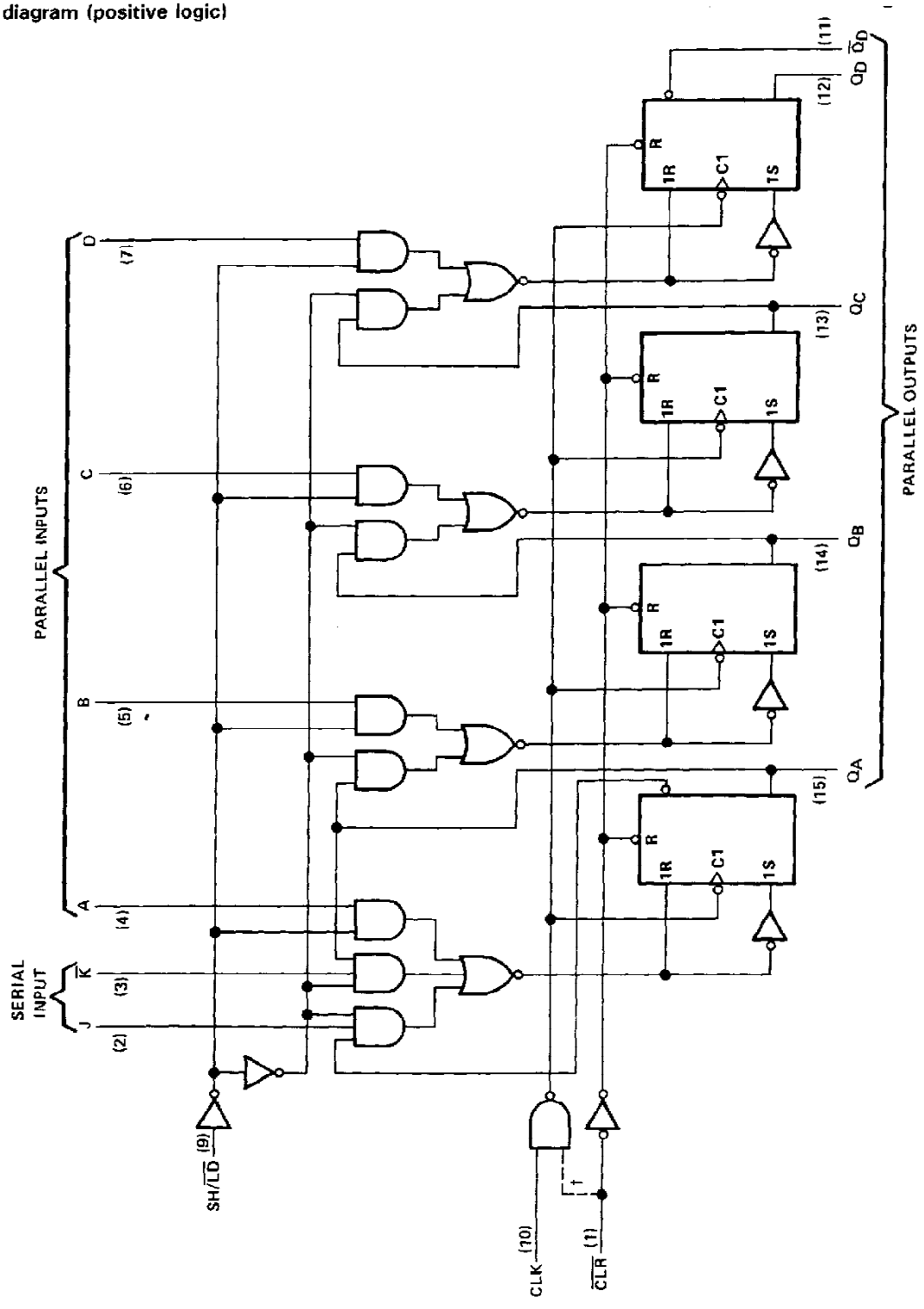
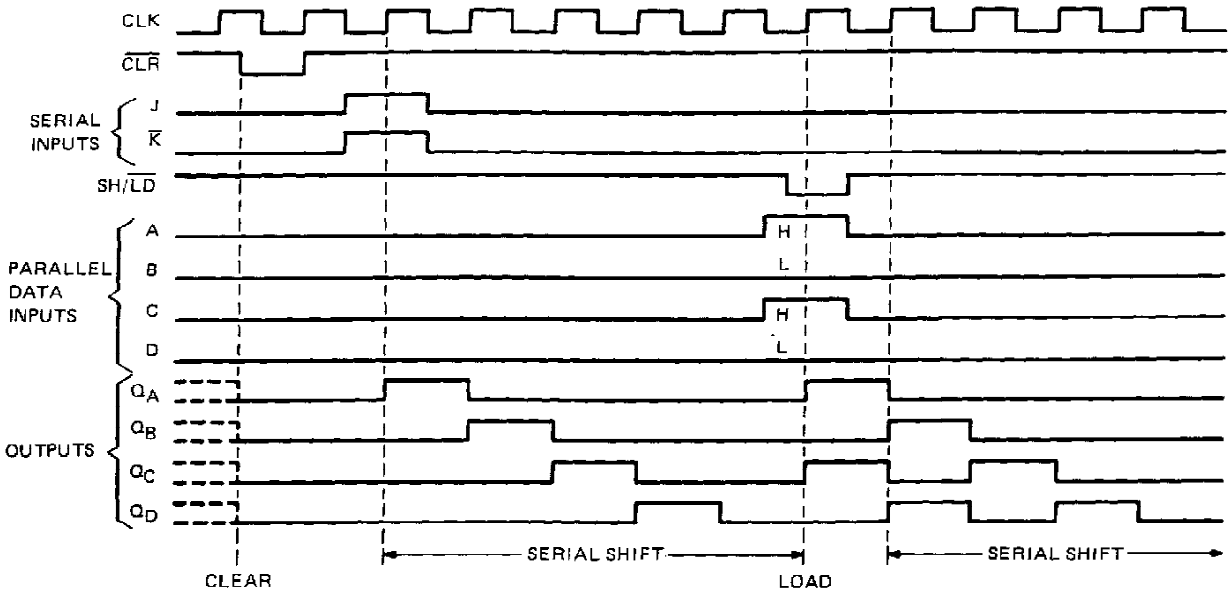
logic diagram (positive logic)

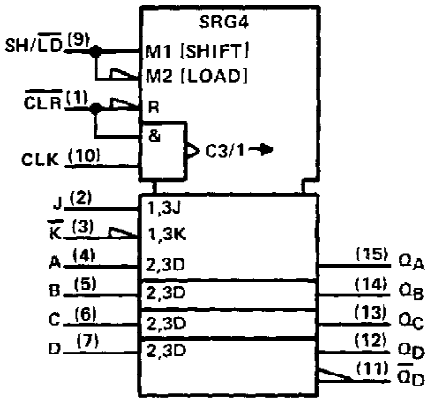


typical clear, shift, and load sequences

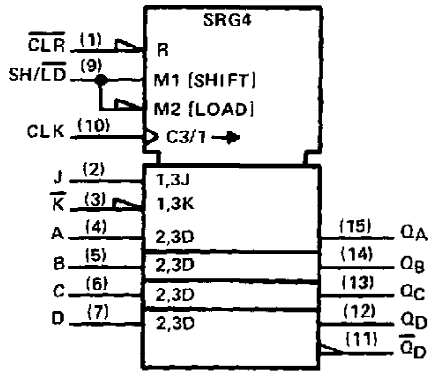


logic symbols†

'195



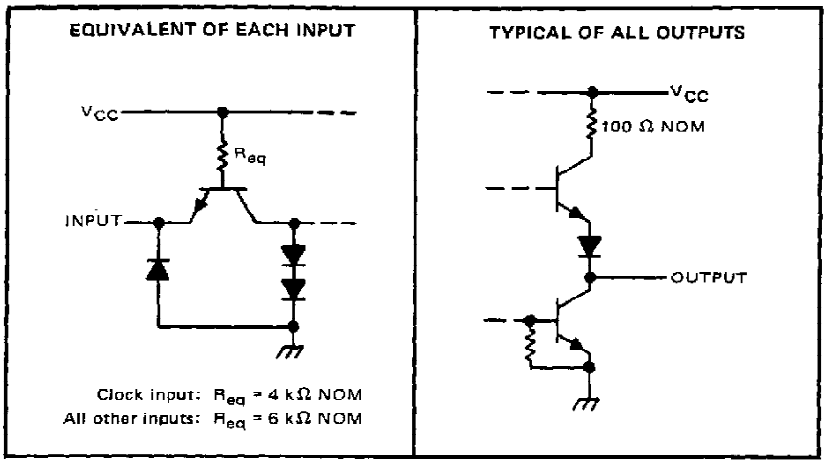
'LS195, 'S195



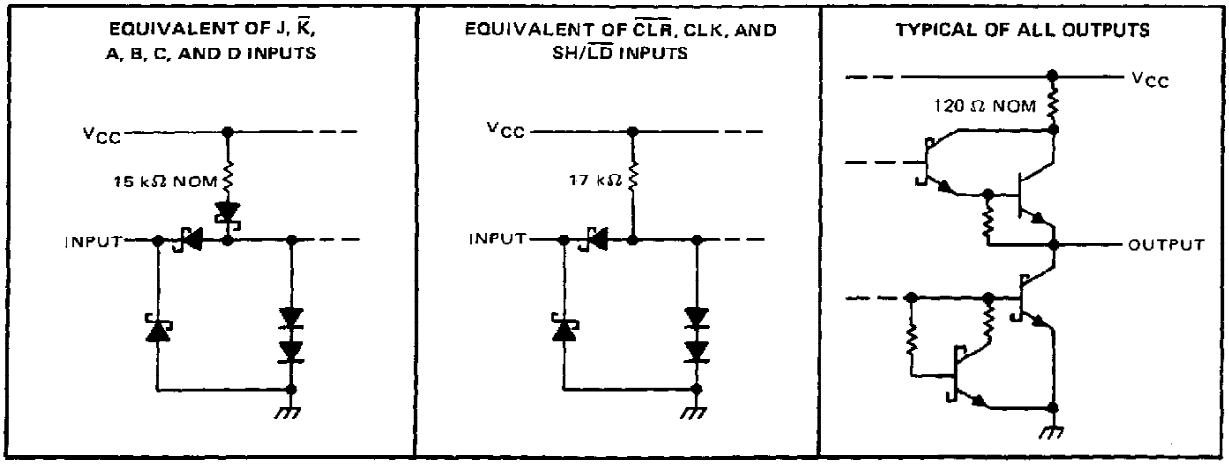
†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers are for D, J, N, and W packages.

schematics of inputs and outputs

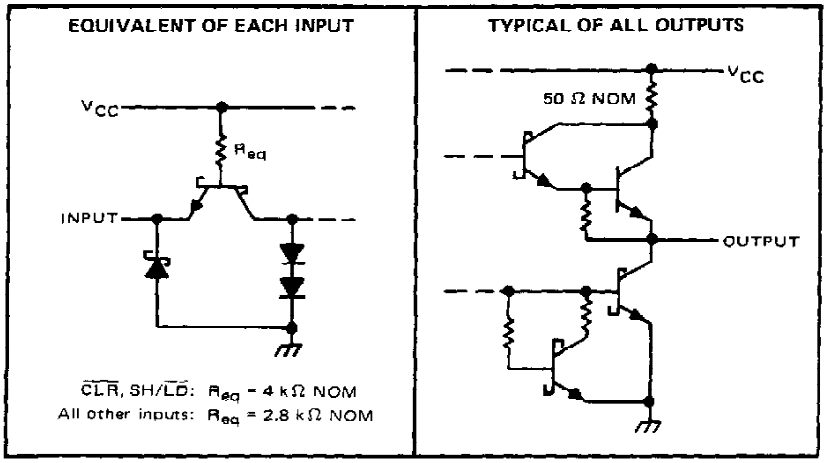
'195



'LS195A



'S195



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Operating free-air temperature range: SN54195 . . . . . −55°C to 125°C
SN74195 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54195			SN74195			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−800			−800	μA
Low-level output current, I_{OL}				16			16	mA
Clock frequency, f_{clock}		0		30	0		30	MHz
Width of clock input pulse, $t_{w(clock)}$		16			16			ns
Width of clear input pulse, $t_{w(clear)}$		12			12			ns
Setup time, t_{su} (see Figure 1)	Shift/load	25			25			ns
	Serial and parallel data	20			20			
	Clear inactive-state	25			25			
Shift/load release time, $t_{release}$ (see Figure 1)				10			10	ns
Serial and parallel data hold time, t_h (see Figure 1)		0			0			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
V_{IH}	High-level input voltage			2			V
V_{IL}	Low-level input voltage					0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −12 mA				−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA		2.4	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA			0.2	0.4	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V				1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.4 V				40	μA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4 V				−1.6	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX	SN54195	−20		−57	mA
			SN74195	−18		−57	
I_{CC}	Supply current	V_{CC} = MAX, See Note 2			39	63	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time.

NOTE 2: With all outputs open, shift/load grounded, and 4.5 V applied to the J, $\overline{K}$, and data inputs, I_{CC} is measured by applying a momentary ground, followed by 4.5 V, to clear and then applying a momentary ground, followed by 4.5 V, to clock.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}	Maximum clock frequency	C_L = 15 pF, R_L = 400 Ω, See Figure 1	30	39		MHz
t_{PHL}	Propagation delay time, high-to-low-level output from clear			19	30	ns
t_{PLH}	Propagation delay time, low-to-high-level output from clock			14	22	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clock			17	26	ns

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Operating free-air temperature range: SN54LS195A . . . . . −55°C to 125°C
SN74LS195A . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS195A			SN74LS195A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−400			−400	μA
Low-level output current, I_{OL}				4			8	mA
Clock frequency, f_{clock}		0		30	0		30	MHz
Width of clock or clear pulse, $t_{w(clock)}$		16			16			ns
Width of clear input pulse, $t_{w(clear)}$		12			12			ns
Setup time, t_{su} (see Figure 1)	Shift/load	25			25			ns
	Serial and parallel data	15			15			
	Clear inactive-state	25			25			
Shift/load release time, $t_{release}$ (see Figure 1)				10			20	ns
Serial and parallel data hold time, t_h (see Figure 1)		0			0			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS195A			SN74LS195A			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.7			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 8 mA					0.35	0.5	
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 7 V				0.1			0.1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7 V				20			20	μA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4 V				−0.4			−0.4	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CC}	Supply current	V_{CC} = MAX, See Note 2			14	21		14	21	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
NOTE 2: With all outputs open, shift/load grounded, and 4.5 V applied to the J, K, and data inputs, I_{CC} is measured by applying a momentary ground, followed by 4.5 V, to clear and then applying a momentary ground, followed by 4.5 V, to clock.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}	Maximum clock frequency	C_L = 15 pF, R_L = 2 kΩ, See Figure 1	30	39		MHz
t_{PHL}	Propagation delay time, high-to-low-level output from clear			19	30	ns
t_{PLH}	Propagation delay time, low-to-high-level output from clock			14	22	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clock			17	26	ns

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Operating free-air temperature range: SN54S195 . . . . . −55°C to 125°C
SN74S195 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54S195			SN74S195			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−1			−1	mA
Low-level output current, I_{OL}				20			20	mA
Clock frequency, f_{clock}		0		70	0		70	MHz
Width of clock input pulse, $t_{w(clock)}$		7			7			ns
Width of clear input pulse, $t_{w(clear)}$		12			12			ns
Setup time, t_{su} (see Figure 1)	Shift/load	11			11			ns
	Serial and parallel data	5			5			
	Clear inactive-state	9			9			
Shift/load release time, $t_{release}$ (see Figure 1)				2			6	ns
Serial and parallel data hold time, t_h (see Figure 1)		3			3			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

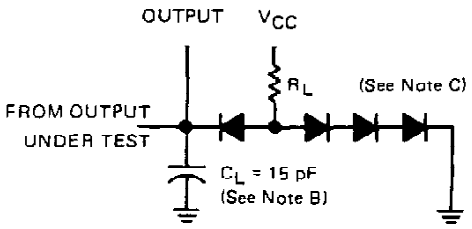
PARAMETER		TEST CONDITIONS†			MIN	TYP‡	MAX	UNIT
V_{IH}	High-level input voltage				2			V
V_{IL}	Low-level input voltage						0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN,	I_I = −18 mA				−1.2	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IL} = 0.8 V,	V_{IH} = 2 V, I_{OH} = −1 mA	SN54S195	2.5	3.4		V
				SN74S195	2.7	3.4		
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IL} = 0.8 V,	V_{IH} = 2 V, I_{OL} = 20 mA				0.5	V
I_I	Input current at maximum input voltage	V_{CC} = MAX,	V_I = 5.5 V				1	mA
I_{IH}	High-level input current	V_{CC} = MAX,	V_I = 2.7 V				50	μA
I_{IL}	Low-level input current	V_{CC} = MAX,	V_I = 0.5 V				−2	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX			−40		−100	mA
I_{CC}	Supply current	V_{CC} = MAX,	See Note 2	SN54S195		70	99	mA
				SN74S195		70	109	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
NOTE 2: With all outputs open, shift/load grounded, and 4.5 V applied to the J, $\overline{K}$, and data inputs, I_{CC} is measured by applying a momentary ground, followed by 4.5 V, to clear, and then applying a momentary ground, followed by 4.5 V, to clock.

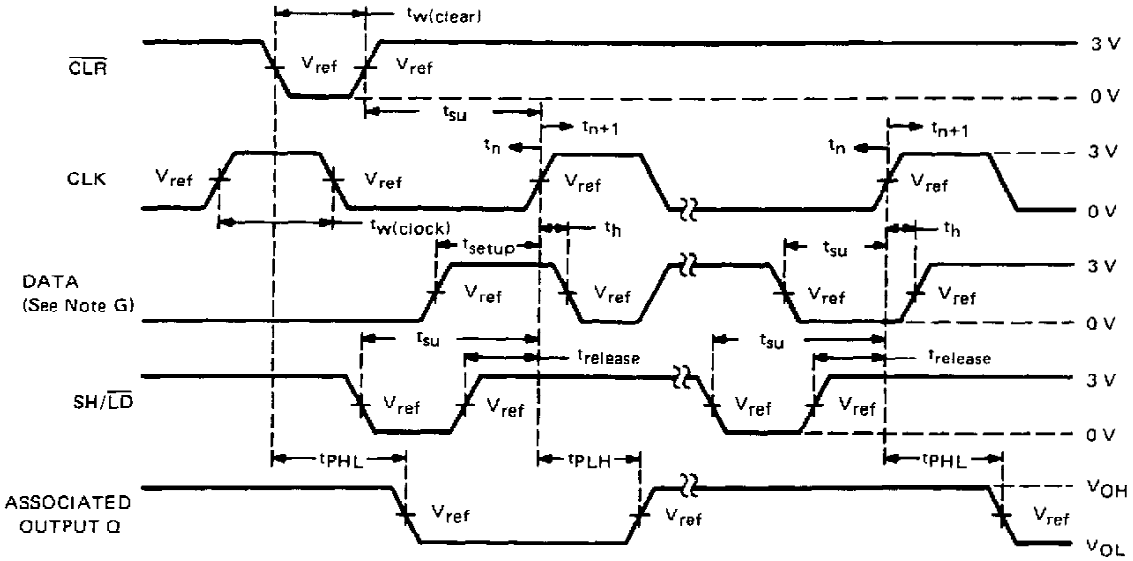
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}	Maximum clock frequency	C_L = 15 pF, R_L = 280 Ω, See Figure 1	70	105		MHz
t_{PHL}	Propagation delay time, high-to-low-level output from clear			12.5	18.5	ns
t_{PLH}	Propagation delay time, low-to-high-level output from clock			8	12	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clock			11	16.5	ns

PARAMETER MEASUREMENT INFORMATION



LOAD FOR OUTPUT UNDER TEST



VOLTAGE WAVEFORMS

NOTES: A. The clock pulse generator has the following characteristics: $Z_{out} \approx 50\ \Omega$ and PRR ≤ 1 MHz. For '195, $t_r \leq 7$ ns and $t_f \leq 7$ ns. For 'LS195A, $t_r \leq 15$ ns and $t_f \leq 6$ ns. For 'S195, $t_r = 2.5$ ns and $t_f = 2.5$ ns. When testing f_{max}, vary the clock PRR.

B. C_L includes probe and jig capacitance.

C. All diodes are 1N3064 or equivalent.

D. A clear pulse is applied prior to each test.

E. For '195 and 'S195, $V_{ref} = 1.5$ V; for 'LS195A, $V_{ref} = 1.3$ V.

F. Propagation delay times (t_{PLH} and t_{PHL}) are measured at t_{n+1}. Proper shifting of data is verified at t_{n+4} with a functional test.

G. J and $\overline{K}$ inputs are tested the same as data A, B, C, and D inputs except that shift/load input remains high.

H. t_n = bit time before clocking transition.
t_{n+1} = bit time after one clocking transition.
t_{n+4} = bit time after four clocking transitions.

FIGURE 1–SWITCHING TIMES

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The SN54165 and SN74165 devices are obsolete and are no longer supplied.

SDLS062D – OCTOBER 1976 – REVISED FEBRUARY 2002

- **Complementary Outputs**
- **Direct Overriding Load (Data) Inputs**
- **Gated Clock Inputs**
- **Parallel-to-Serial Data Conversion**

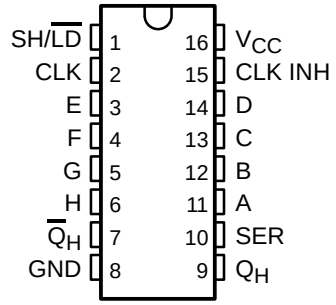
TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
’165	26 MHz	210 mW
’LS165A	35 MHz	90 mW

description

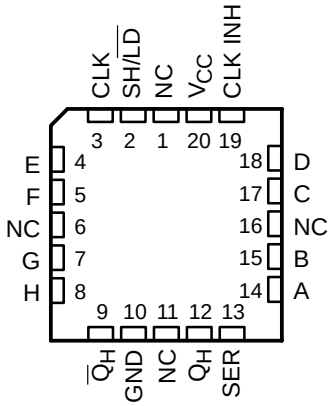
The ’165 and ’LS165A are 8-bit serial shift registers that shift the data in the direction of Q_A toward Q_H when clocked. Parallel-in access to each stage is made available by eight individual, direct data inputs that are enabled by a low level at the shift/load (SH/$\overline{LD}$) input. These registers also feature gated clock (CLK) inputs and complementary outputs from the eighth bit. All inputs are diode-clamped to minimize transmission-line effects, thereby simplifying system design.

Clocking is accomplished through a two-input positive-NOR gate, permitting one input to be used as a clock-inhibit function. Holding either of the clock inputs high inhibits clocking, and holding either clock input low with SH/$\overline{LD}$ high enables the other clock input. Clock inhibit (CLK INH) should be changed to the high level only while CLK is high. Parallel loading is inhibited as long as SH/$\overline{LD}$ is high. Data at the parallel inputs are loaded directly into the register while SH/$\overline{LD}$ is low, independently of the levels of CLK, CLK INH, or serial (SER) inputs.

SN54165, SN54LS165A . . . J OR W PACKAGE
SN74165 . . . N PACKAGE
SN74LS165A . . . D, N, OR NS PACKAGE
(TOP VIEW)



SN54LS165A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

The SN54165 and SN74165 devices are obsolete and are no longer supplied.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP – N	Tube	SN74LS165AN	SN74LS165AN
	SOIC – D	Tube	SN74LS165AD	LS165A
		Tape and reel	SN74LS165ADR	
	SOP – NS	Tape and reel	SN74LS165ANSR	74LS165A
–55°C to 125°C	CDIP – J	Tube	SN54LS165AJ	SN54LS165AJ
		Tube	SNJ54LS165AJ	SNJ54LS165AJ
	CFP – W	Tube	SNJ54LS165AW	SNJ54LS165AW
	LCCC – FK	Tube	SNJ54LS165AFK	SNJ54LS165AFK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

INPUTS					INTERNAL OUTPUTS		OUTPUT Q_H
SH/$\overline{LD}$	CLK INH	CLK	SER	PARALLEL A . . . H	$\overline{Q}_A$	$\overline{Q}_B$	
L	X	X	X	a . . . h	a	b	h
H	L	L	X	X	Q_{A0}	Q_{B0}	Q_{H0}
H	L	↑	H	X	H	Q_{An}	Q_{Gn}
H	L	↑	L	X	L	Q_{An}	Q_{Gn}
H	H	X	X	X	Q_{A0}	Q_{B0}	Q_{H0}

The SN54165 and SN74165 devices are obsolete and are no longer supplied.

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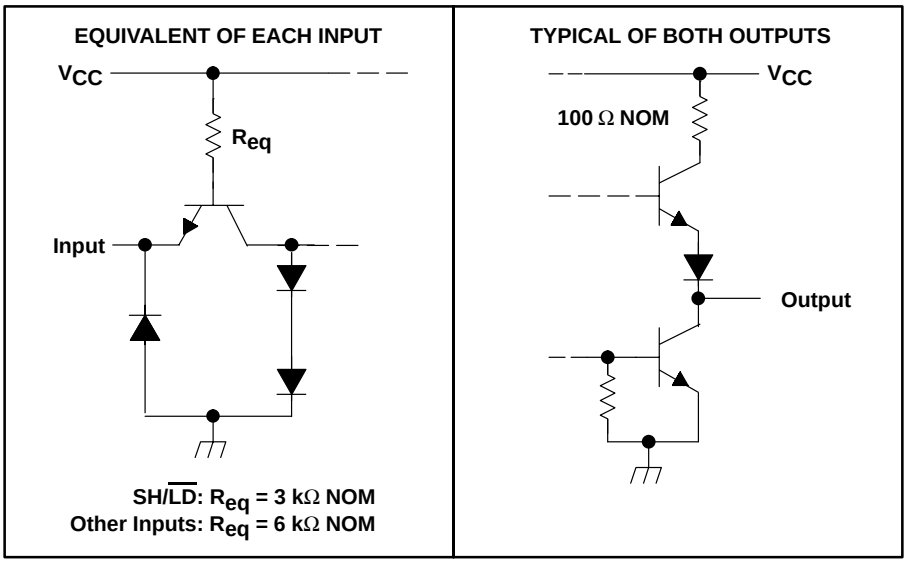
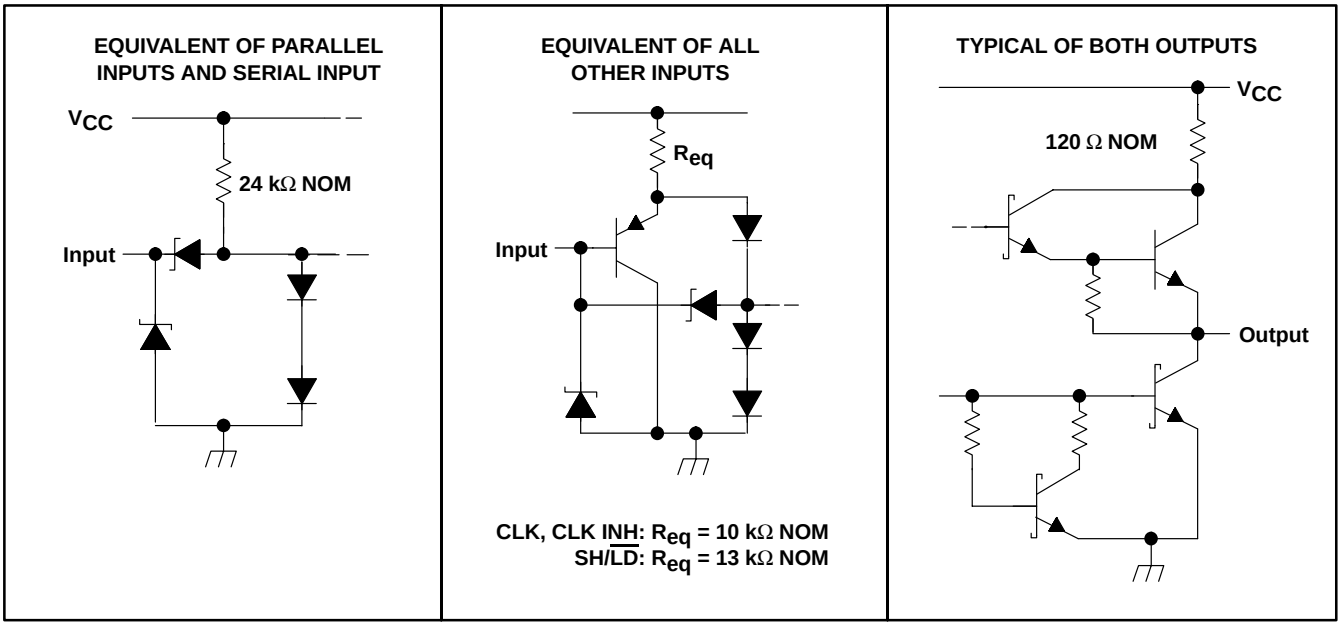
schematics of inputs and outputs

'165

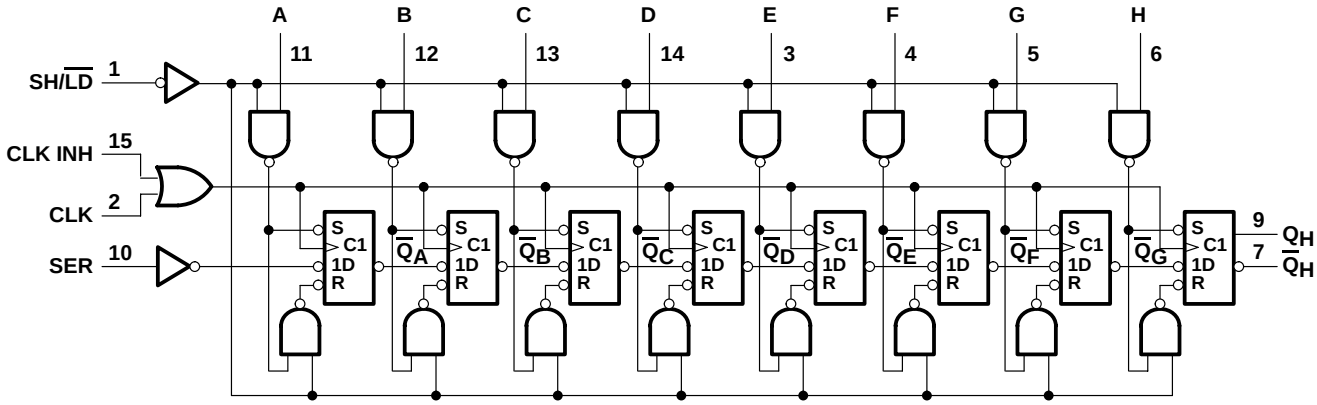


'LS165A



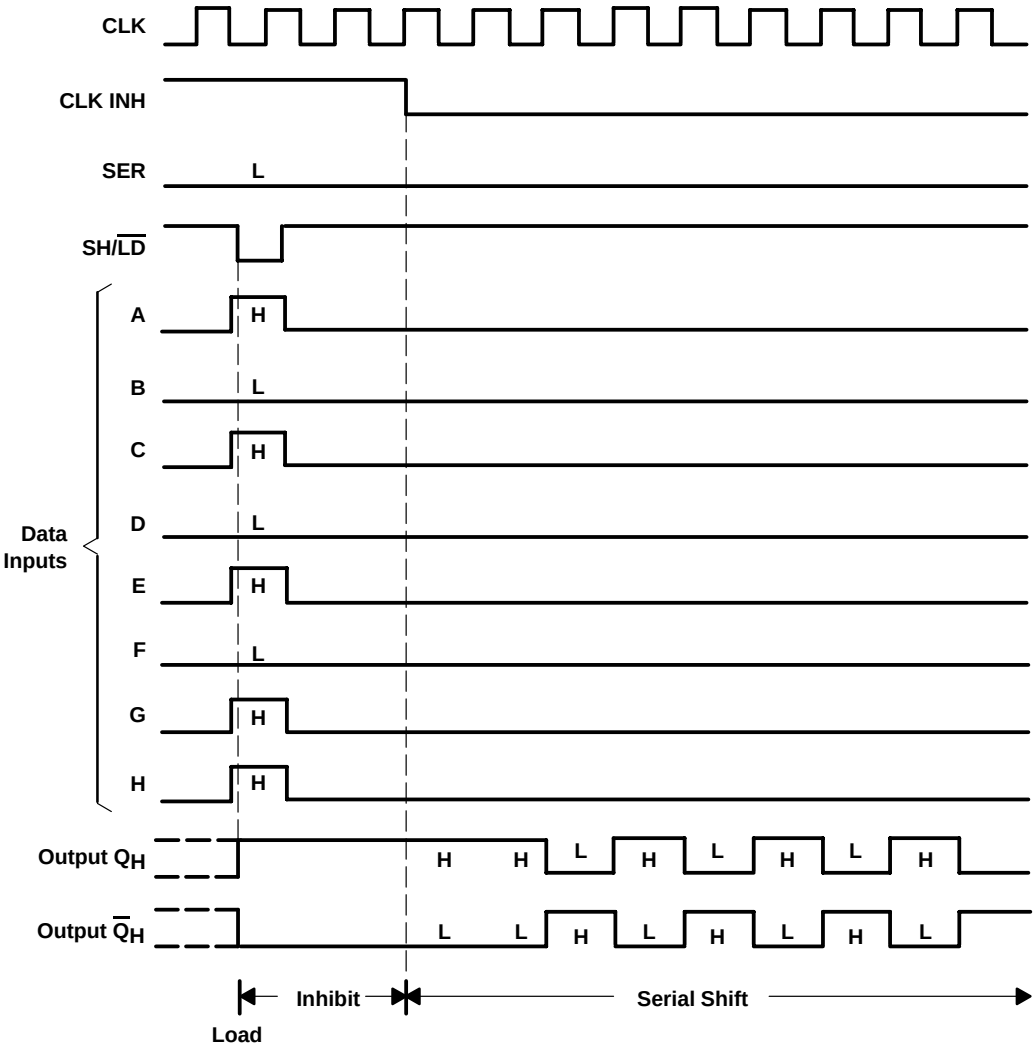
The SN54165 and SN74165 devices are obsolete and are no longer supplied.

logic diagram (positive logic)



Pin numbers shown are for D, J, N, NS, and W packages.

typical shift, load, and inhibit sequences



absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage, V_I: SN54165, SN74165 . . . . . 5.5 V
SN54LS165A, SN74LS165A . . . . . 7 V
Interemitter voltage (see Note 2) . . . . . 5.5 V
Package thermal impedance θ_{JA} (see Note 3): D package . . . . . 73°C/W
N package . . . . . 67°C/W
NS package . . . . . 64°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.
2. This is the voltage between two emitters of a multiple-emitter transistor. This rating applies for the '165 to the SH/$\overline{LD}$ input in conjunction with the CLK INH input.
3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		SN54165			SN74165			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current			–800			–800	μA
I_{OL}	Low-level output current			16			16	mA
f_{clock}	Clock frequency	0		20	0		20	MHz
$t_{w(clock)}$	Width of clock input pulse	25			25			ns
$t_{w(load)}$	Width of load input pulse	15			15			ns
t_{su}	Clock-enable setup time (see Figure 1)	30			30			ns
t_{su}	Parallel input setup time (see Figure 1)	10			10			ns
t_{su}	Serial input setup time (see Figure 1)	20			20			ns
t_{su}	Shift setup time (see Figure 1)	45			45			ns
t_h	Hold time at any input	0			0			ns
T_A	Operating free-air temperature	–55		125	0		70	°C

The SN54165 and SN74165 devices are obsolete and are no longer supplied.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	SN54165			SN74165			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.8			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = –12 mA			–1.5			–1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = –800 μA	2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage		V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current	SH/$\overline{LD}$	V_{CC} = MAX, V_I = 2.4 V			80			80	μA
		Other inputs				40			40	
I_{IL}	Low-level input current	SH/$\overline{LD}$	V_{CC} = MAX, V_I = 0.4 V			–3.2			–3.2	mA
		Other inputs				–1.6			–1.6	
I_{OS}	Short-circuit output current§		V_{CC} = MAX	–20		–55	–18		–55	mA
I_{CC}	Supply current		V_{CC} = MAX, See Note 4		42	63		42	63	mA

NOTE 4: With the outputs open, CLK INH and CLK at 4.5 V, and a clock pulse applied to SH/$\overline{LD}$, I_{CC} is measured first with the parallel inputs at 4.5 V, then with the parallel inputs grounded.

† For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time.

SN54165 and SN74165 switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}				20	26		MHz
t_{PLH}	$\overline{LD}$	Any	C_L = 15 pF, R_L = 400 Ω		21	31	ns
t_{PHL}					27	40	
t_{PLH}	CLK	Any	C_L = 15 pF, R_L = 400 Ω		16	24	ns
t_{PHL}					21	31	
t_{PLH}	H	Q_H	C_L = 15 pF, R_L = 400 Ω		11	17	ns
t_{PHL}					24	36	
t_{PLH}	H	$\overline{Q}_H$	C_L = 15 pF, R_L = 400 Ω		18	27	ns
t_{PHL}					18	27	

¶ f_{max} = maximum clock frequency, t_{PLH} = propagation delay time, low-to-high-level output, t_{PHL} = propagation delay time, high-to-low-level output

The SN54165 and SN74165 devices are obsolete and are no longer supplied.

recommended operating conditions

			SN54LS165A			SN74LS165A			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
I_{OH}	High-level output current				–0.4			–0.4	mA
I_{OL}	Low-level output current				4			8	mA
f_{clock}	Clock frequency		0		25	0		25	MHz
$t_{w(clock)}$	Width of clock input pulse (see Figure 2)	Clock high	15			15			ns
		Clock low	25			25			
$t_{w(load)}$	Width of load input pulse	Clock high	25			25			ns
		Clock low	17			17			
t_{su}	Clock-enable setup time (see Figure 2)		30			30			ns
t_{su}	Parallel input setup time (see Figure 2)		10			10			ns
t_{su}	Serial input setup time (see Figure 2)		20			20			ns
t_{su}	Shift setup time (see Figure 2)		45			45			ns
t_h	Hold time at any input		0			0			ns
T_A	Operating free-air temperature		–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†			SN54LS165A			SN74LS165A			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = –18 mA					–1.5			–1.5	V
V_{OH}	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX,		I_{OH} = –0.4 mA	2.5	3.5		2.7	3.5		V
V_{OL}	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = MAX		I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = MAX, V_I = 7 V					0.1			0.1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.7 V					20			20	µA
I_{IL}	V_{CC} = MAX, V_I = 0.4 V					–0.4			–0.4	mA
I_{OS}§	V_{CC} = MAX			–20		–100	–20		–100	mA
I_{CC}	V_{CC} = MAX, See Note 4				18	30		18	30	mA

NOTE 4. With the outputs open, CLK INH and CLK at 4.5 V, and a clock pulse applied to SH/$\overline{LD}$, I_{CC} is measured first with the parallel inputs at 4.5 V, then with the parallel inputs grounded.

† For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

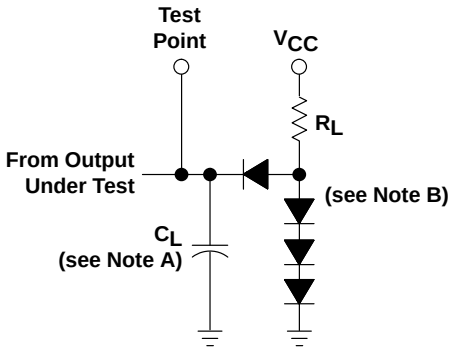
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

SN54LS165A and SN74LS165A switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

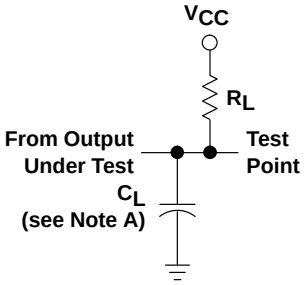
PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}				25	35		MHz
t_{PLH}	$\overline{LD}$	Any	R_L = 2 kΩ, C_L = 15 pF		21	35	ns
t_{PHL}					26	35	
t_{PLH}	CLK	Any	R_L = 2 kΩ, C_L = 15 pF		14	25	ns
t_{PHL}					16	25	
t_{PLH}	H	Q_H	R_L = 2 kΩ, C_L = 15 pF		13	25	ns
t_{PHL}					24	30	
t_{PLH}	H	$\overline{Q}_H$	R_L = 2 kΩ, C_L = 15 pF		19	30	ns
t_{PHL}					17	25	

† f_{max} = maximum clock frequency, t_{PLH} = propagation delay time, low-to-high-level output, t_{PHL} = propagation delay time, high-to-low-level output

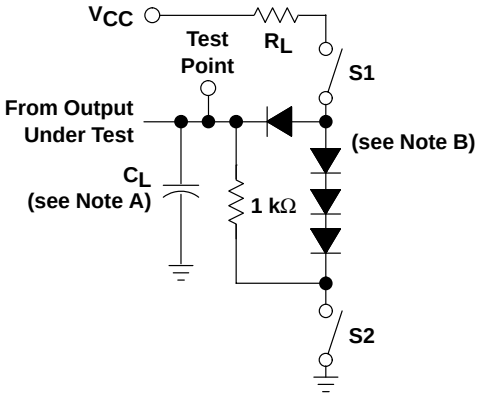
PARAMETER MEASUREMENT INFORMATION
SERIES 54/74 DEVICES



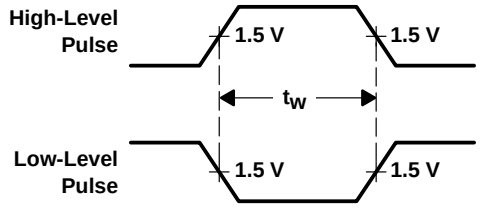
LOAD CIRCUIT FOR 2-STATE TOTEM-POLE OUTPUTS



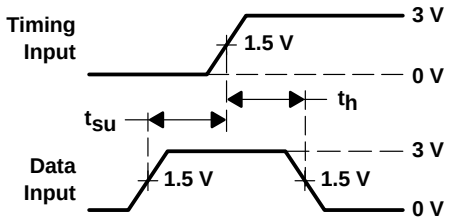
LOAD CIRCUIT FOR OPEN-COLLECTOR OUTPUTS



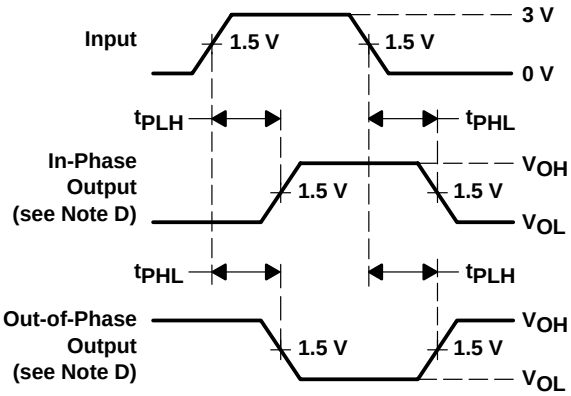
LOAD CIRCUIT FOR 3-STATE OUTPUTS



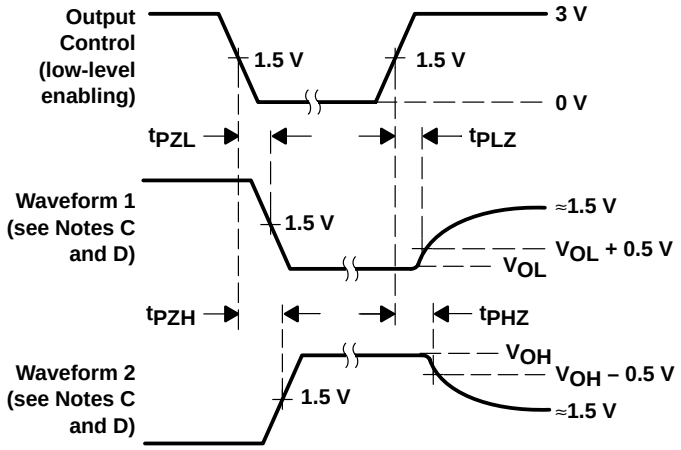
VOLTAGE WAVEFORMS PULSE DURATIONS



VOLTAGE WAVEFORMS SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES

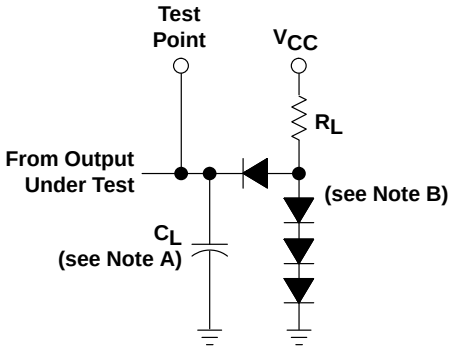


VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

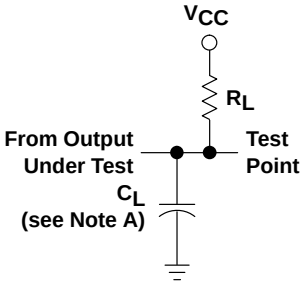
NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open and S2 is closed for t_{PZH}; S1 is closed and S2 is open for t_{PZL}.
E. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O \approx 50\ \Omega$; t_r and $t_f \leq 7$ ns for Series 54/74 devices and t_r and $t_f \leq 2.5$ ns for Series 54S/74S devices.
F. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

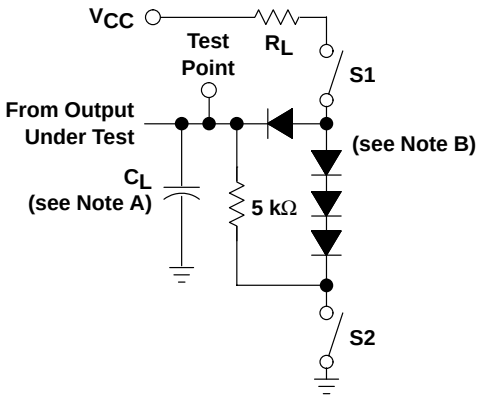
PARAMETER MEASUREMENT INFORMATION
SERIES 54LS/74LS DEVICES



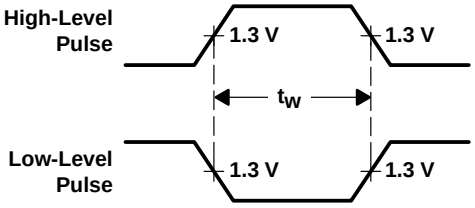
LOAD CIRCUIT FOR 2-STATE TOTEM-POLE OUTPUTS



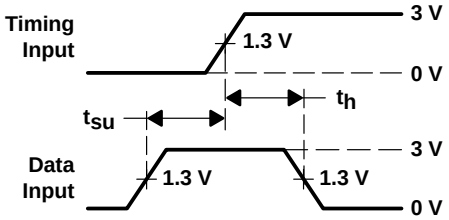
LOAD CIRCUIT FOR OPEN-COLLECTOR OUTPUTS



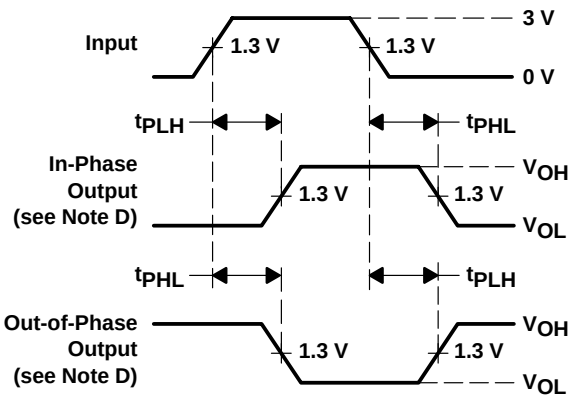
LOAD CIRCUIT FOR 3-STATE OUTPUTS



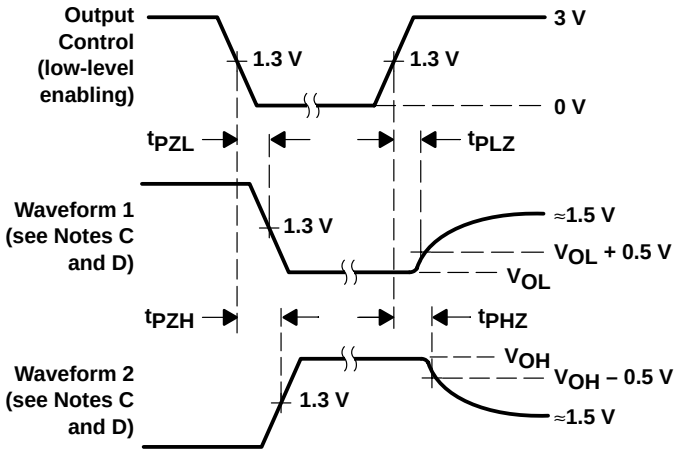
VOLTAGE WAVEFORMS PULSE DURATIONS



VOLTAGE WAVEFORMS SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open and S2 is closed for t_{PZH}; S1 is closed and S2 is open for t_{PZL}.
E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
F. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O \approx 50\ \Omega$, $t_r \le 1.5$ ns, $t_f \le 2.6$ ns.
G. The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms

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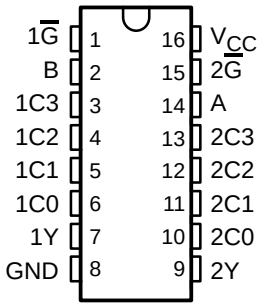
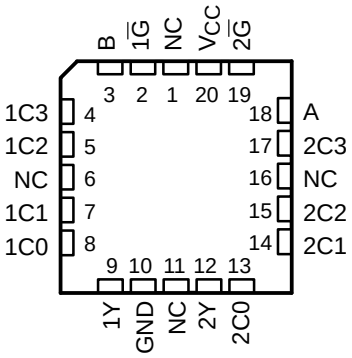
- **Permit Multiplexing from n Lines to One Line**
- **Perform Parallel-to-Serial Conversion**
- **Strobe (Enable) Line Provided for Cascading (N Lines to n Lines)**
- **Package Options Include Plastic Small-Outline (D), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**

SN54HC153 . . . J OR W PACKAGE
SN74HC153 . . . D, N, OR PW PACKAGE
(TOP VIEW)



SN54HC153 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

Each of these data selectors/multiplexers contains inverters and drivers to supply full binary decoding data selection to the AND-OR gates. Separate strobe ($\overline{G}$) inputs are provided for each of the two 4-line sections.

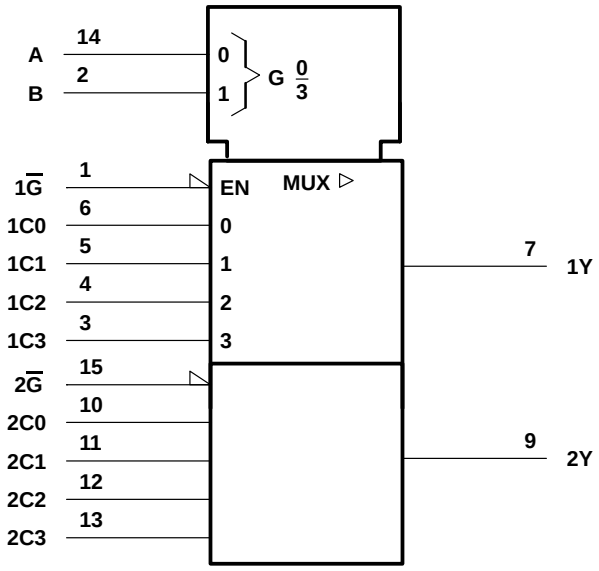
The SN54HC153 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74HC153 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE

INPUTS							OUTPUT
SELECT†		DATA				$\overline{G}$	Y
B	A	C0	C1	C2	C3		
X	X	X	X	X	X	H	L
L	L	L	X	X	X	L	L
L	L	H	X	X	X	L	H
L	H	X	L	X	X	L	L
L	H	X	H	X	X	L	H
H	L	X	X	L	X	L	L
H	L	X	X	H	X	L	H
H	H	X	X	X	L	L	L
H	H	X	X	X	H	L	H

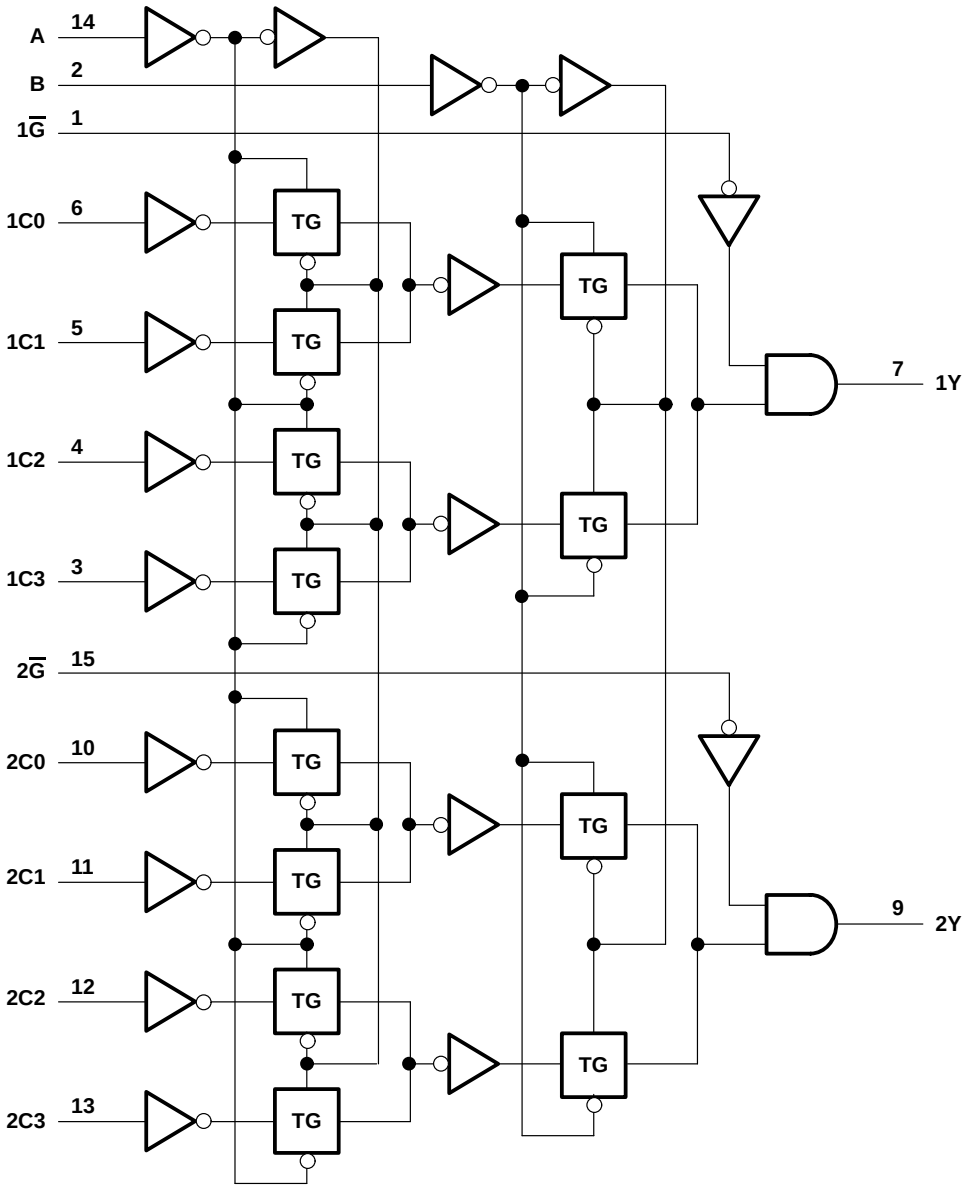
† Select inputs A and B are common to both sections.

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, N, PW, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the D, J, N, PW, and W packages.

absolute maximum ratings over operating free-air temperature range†

Supply voltage range, V_{CC} . . . . . –0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) . . . . . ±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) . . . . . ±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC}) . . . . . ±35 mA
Continuous current through V_{CC} or GND . . . . . ±70 mA
Package thermal impedance, θ_{JA} (see Note 2): D package . . . . . 113°C/W
N package . . . . . 78°C/W
PW package . . . . . 149°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

			SN54HC153			SN74HC153			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		2	5	6	2	5	6	V
V_{IH}	High-level input voltage	V_{CC} = 2 V	1.5			1.5			V
		V_{CC} = 4.5 V	3.15			3.15			
		V_{CC} = 6 V	4.2			4.2			
V_{IL}	Low-level input voltage	V_{CC} = 2 V	0		0.5	0		0.5	V
		V_{CC} = 4.5 V	0		1.35	0		1.35	
		V_{CC} = 6 V	0		1.8	0		1.8	
V_I	Input voltage		0		V_{CC}	0		V_{CC}	V
V_O	Output voltage		0		V_{CC}	0		V_{CC}	V
t_t	Input transition (rise and fall) time	V_{CC} = 2 V	0		1000	0		1000	ns
		V_{CC} = 4.5 V	0		500	0		500	
		V_{CC} = 6 V	0		400	0		400	
T_A	Operating free-air temperature		–55		125	–40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V_{CC}	T_A = 25°C			SN54HC153		SN74HC153		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	V_I = V_{IH} or V_{IL}	I_{OH} = –20 μA	2 V	1.9	1.998		1.9		1.9		V
			4.5 V	4.4	4.499		4.4		4.4		
			6 V	5.9	5.999		5.9		5.9		
		I_{OH} = –6 mA	4.5 V	3.98	4.3		3.7		3.84		
		I_{OH} = –7.8 mA	6 V	5.48	5.8		5.2		5.34		
V_{OL}	V_I = V_{IH} or V_{IL}	I_{OL} = 20 μA	2 V		0.002	0.1		0.1		0.1	V
			4.5 V		0.001	0.1		0.1		0.1	
			6 V		0.001	0.1		0.1		0.1	
		I_{OL} = 6 mA	4.5 V		0.17	0.26		0.4		0.33	
		I_{OL} = 7.8 mA	6 V		0.15	0.26		0.4		0.33	
I_I	V_I = V_{CC} or 0		6 V			±0.1	±100		±1000		±1000	nA
I_{CC}	V_I = V_{CC} or 0,	I_O = 0	6 V			8		160		80	μA
C_i			2 V to 6 V		3	10		10		10	pF

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	T_A = 25°C			SN54HC153		SN74HC153		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A or B	Y	2 V		90	150		225		190	ns
			4.5 V		21	30		45		38	
			6 V		17	26		38		32	
	Data (Any C)	Y	2 V		73	126		189		158	
			4.5 V		17	28		42		35	
			6 V		14	23		35		29	
	$\overline{G}$	Y	2 V		38	95		150		125	
			4.5 V		11	19		28		24	
			6 V		9	16		24		20	
t_t		Y	2 V		20	60		90		75	ns
			4.5 V		8	12		18		15	
			6 V		6	10		15		13	

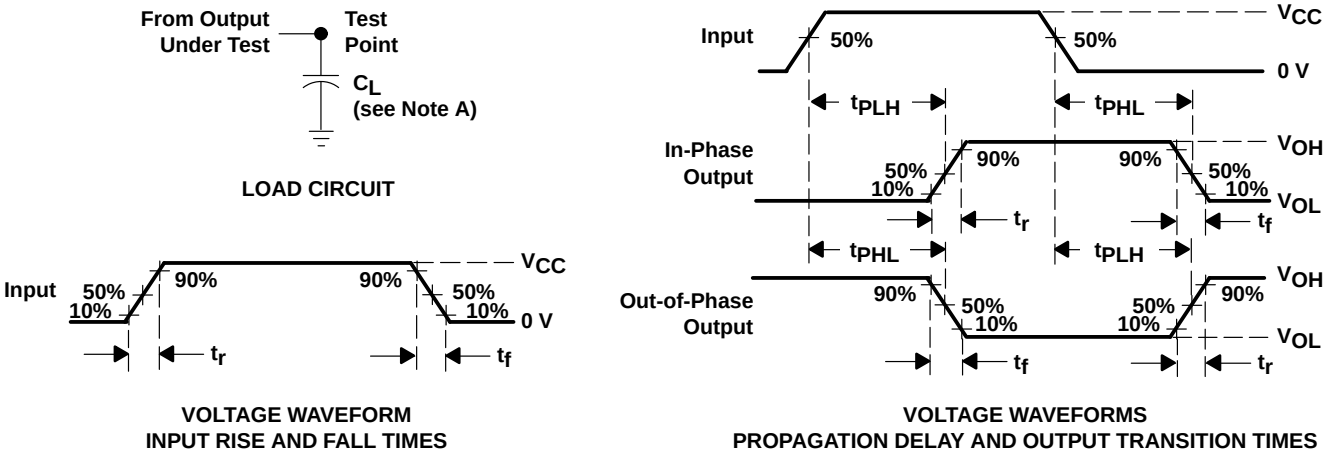
switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	T_A = 25°C			SN54HC153		SN74HC153		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A or B	Y	2 V		105	235		355		295	ns
			4.5 V		27	47		71		59	
			6 V		21	41		60		51	
	Data (Any C)	Y	2 V		93	220		335		274	
			4.5 V		23	44		67		55	
			6 V		19	38		57		48	
	$\overline{G}$	Y	2 V		60	185		280		230	
			4.5 V		17	37		56		46	
			6 V		14	32		48		40	
t_t		Y	2 V		45	210		315		265	ns
			4.5 V		17	42		63		53	
			6 V		13	36		53		45	

operating characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance per multiplexer	No load	40	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and test-fixture capacitance.
B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r = 6 ns, t_f = 6 ns.
C. The outputs are measured one at a time with one input transition per measurement.
D. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms

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